

# MPC862/857T/857DSL PowerQUICC™ Family Hardware Specifications

This document contains detailed information on power considerations, DC/AC electrical characteristics, and AC timing specifications for the MPC862/857T/857DSL family (refer to [Table 1](#) for a list of devices). The MPC862P, which contains a PowerPC™ core processor, is the superset device of the MPC862/857T/857DSL family. For functional characteristics of the processor, refer to the *MPC862 PowerQUICC™ Family Users Manual* (MPC862UM/D).

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# 1 Overview

The MPC862/857T/857DSL is a derivative of Freescale's MPC860 PowerQUICC™ family of devices. It is a versatile single-chip integrated microprocessor and peripheral combination that can be used in a variety of controller applications and communications and networking systems. The MPC862/857T/857DSL provides enhanced ATM functionality over that of other ATM-enabled members of the MPC860 family.

Table 1 shows the functionality supported by the members of the MPC862/857T/857DSL family.

**Table 1. MPC862 Family Functionality**

| Part      | Cache             |            | Ethernet |        | SCC            | SMC            |
|-----------|-------------------|------------|----------|--------|----------------|----------------|
|           | Instruction Cache | Data Cache | 10T      | 10/100 |                |                |
| MPC862P   | 16 Kbyte          | 8 Kbyte    | Up to 4  | 1      | 4              | 2              |
| MPC862T   | 4 Kbyte           | 4 Kbyte    | Up to 4  | 1      | 4              | 2              |
| MPC857T   | 4 Kbyte           | 4 Kbyte    | 1        | 1      | 1              | 2              |
| MPC857DSL | 4 Kbyte           | 4 Kbyte    | 1        | 1      | 1 <sup>1</sup> | 1 <sup>2</sup> |

<sup>1</sup> On the MPC857DSL, the SCC (SCC1) is for ethernet only. Also, the MPC857DSL does not support the Time Slot Assigner (TSA).

<sup>2</sup> On the MPC857DSL, the SMC (SMC1) is for UART only.

## 2 Features

The following list summarizes the key MPC862/857T/857DSL features:

- Embedded single-issue, 32-bit MPC8xx core (implementing the PowerPC architecture) with thirty-two 32-bit general-purpose registers (GPRs)
  - The core performs branch prediction with conditional prefetch, without conditional execution
  - 4- or 8-Kbyte data cache and 4- or 16-Kbyte instruction cache (see Table 1).
    - 16-Kbyte instruction cache (MPC862P) is four-way, set-associative with 256 sets; 4-Kbyte instruction cache (MPC862T, MPC857T, and MPC857DSL) is two-way, set-associative with 128 sets.
    - 8-Kbyte data cache (MPC862P) is two-way, set-associative with 256 sets; 4-Kbyte data cache (MPC862T, MPC857T, and MPC857DSL) is two-way, set-associative with 128 sets.
    - Cache coherency for both instruction and data caches is maintained on 128-bit (4-word) cache blocks.
    - Caches are physically addressed, implement a least recently used (LRU) replacement algorithm, and are lockable on a cache block basis.
  - MMUs with 32-entry TLB, fully associative instruction and data TLBs
  - MMUs support multiple page sizes of 4, 16, and 512 Kbytes, and 8 Mbytes; 16 virtual address spaces and 16 protection groups
  - Advanced on-chip-emulation debug mode

- The MPC862/857T/857DSL provides enhanced ATM functionality over that of the MPC860SAR. The MPC862/857T/857DSL adds major new features available in “enhanced SAR” (ESAR) mode, including the following:
  - Improved operation, administration and maintenance (OAM) support
  - OAM performance monitoring (PM) support
  - Multiple APC priority levels available to support a range of traffic pace requirements
  - ATM port-to-port switching capability without the need for RAM-based microcode
  - Simultaneous MII (10/100Base-T) and UTOPIA (half-duplex) capability
  - Optional statistical cell counters per PHY
  - UTOPIA level 2 compliant interface with added FIFO buffering to reduce the total cell transmission time. (The earlier UTOPIA level 1 specification is also supported.)
  - Multi-PHY support on the MPC857T
  - Four PHY support on the MPC857DSL
  - Parameter RAM for both SPI and I<sup>2</sup>C can be relocated without RAM-based microcode
  - Supports full-duplex UTOPIA both master (ATM side) and slave (PHY side) operation using a “split” bus
  - AAL2/VBR functionality is ROM-resident
- Up to 32-bit data bus (dynamic bus sizing for 8, 16, and 32 bits)
- 32 address lines
- Memory controller (eight banks)
  - Contains complete dynamic RAM (DRAM) controller
  - Each bank can be a chip select or  $\overline{\text{RAS}}$  to support a DRAM bank
  - Up to 30 wait states programmable per memory bank
  - Glueless interface to Page mode/EDO/SDRAM, SRAM, EPROMs, flash EPROMs, and other memory devices.
  - DRAM controller programmable to support most size and speed memory interfaces
  - Four  $\overline{\text{CAS}}$  lines, four  $\overline{\text{WE}}$  lines, one  $\overline{\text{OE}}$  line
  - Boot chip-select available at reset (options for 8-, 16-, or 32-bit memory)
  - Variable block sizes (32 Kbyte–256 Mbyte)
  - Selectable write protection
  - On-chip bus arbitration logic
- General-purpose timers
  - Four 16-bit timers cascadable to be two 32-bit timers
  - Gate mode can enable/disable counting
  - Interrupt can be masked on reference match and event capture
- Fast Ethernet controller (FEC)
  - Simultaneous MII (10/100Base-T) and UTOPIA operation when using the UTOPIA multiplexed bus.

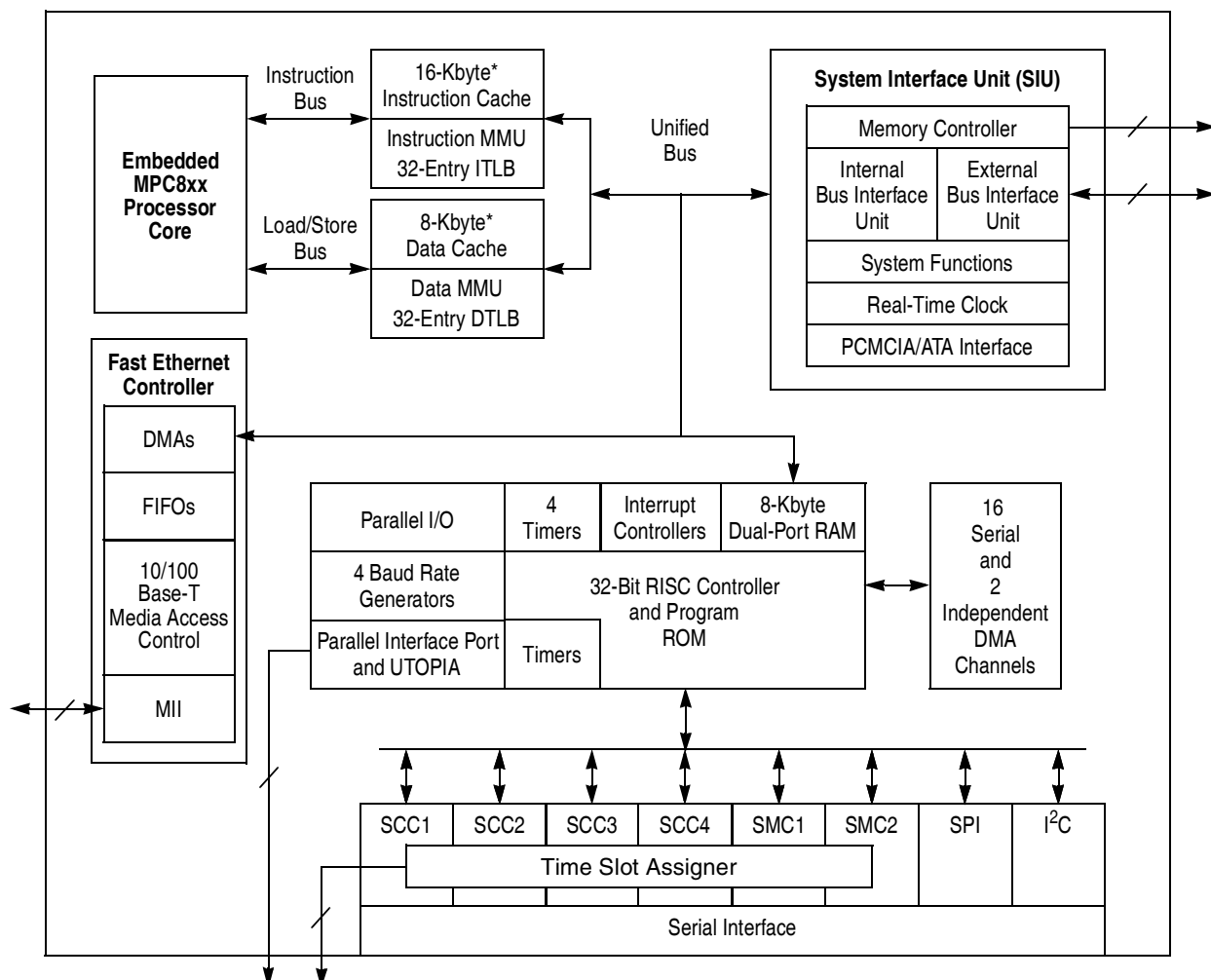
- System integration unit (SIU)
  - Bus monitor
  - Software watchdog
  - Periodic interrupt timer (PIT)
  - Low-power stop mode
  - Clock synthesizer
  - Decrementer, time base, and real-time clock (RTC) from the PowerPC architecture
  - Reset controller
  - IEEE 1149.1 test access port (JTAG)
- Interrupts
  - Seven external interrupt request (IRQ) lines
  - 12 port pins with interrupt capability
  - The MPC862P and MPC862T have 23 internal interrupt sources; the MPC857T and MPC857DSL have 20 internal interrupt sources
  - Programmable priority between SCCs (MPC862P and MPC862T)
  - Programmable highest priority request
- Communications processor module (CPM)
  - RISC controller
  - Communication-specific commands (for example, GRACEFUL STOP TRANSMIT, ENTER HUNT MODE, and RESTART TRANSMIT)
  - Supports continuous mode transmission and reception on all serial channels
  - Up to 8-Kbytes of dual-port RAM
  - The MPC862P and MPC862T have 16 serial DMA (SDMA) channels; the MPC857T and MPC857DSL have 10 serial DMA (SDMA) channels
  - Three parallel I/O registers with open-drain capability
- Four baud rate generators
  - Independent (can be connected to any SCC or SMC)
  - Allow changes during operation
  - Autobaud support option
- The MPC862P and MPC862T have four SCCs (serial communication controller) The MPC857T and MPC857DSL have one SCC, SCC1; the MPC857DSL supports ethernet only
  - Serial ATM capability on all SCCs
  - Optional UTOPIA port on SCC4
  - Ethernet/IEEE 802.3 optional on SCC1–4, supporting full 10-Mbps operation
  - HDLC/SDLC
  - HDLC bus (implements an HDLC-based local area network (LAN))
  - Asynchronous HDLC to support PPP (point-to-point protocol)
  - AppleTalk

- Universal asynchronous receiver transmitter (UART)
- Synchronous UART
- Serial infrared (IrDA)
- Binary synchronous communication (BISYNC)
- Totally transparent (bit streams)
- Totally transparent (frame based with optional cyclic redundancy check (CRC))
- Two SMCs (serial management channels) (The MPC857DSL has one SMC, SMC1 for UART)
  - UART
  - Transparent
  - General circuit interface (GCI) controller
  - Can be connected to the time-division multiplexed (TDM) channels
- One serial peripheral interface (SPI)
  - Supports master and slave modes
  - Supports multiple-master operation on the same bus
- One inter-integrated circuit (I<sup>2</sup>C) port
  - Supports master and slave modes
  - Multiple-master environment support
- Time-slot assigner (TSA) (The MPC857DSL does not have the TSA)
  - Allows SCCs and SMCs to run in multiplexed and/or non-multiplexed operation
  - Supports T1, CEPT, PCM highway, ISDN basic rate, ISDN primary rate, user defined
  - 1- or 8-bit resolution
  - Allows independent transmit and receive routing, frame synchronization, clocking
  - Allows dynamic changes
  - On the MPC862P and MPC862T, can be internally connected to six serial channels (four SCCs and two SMCs); on the MPC857T, can be connected to three serial channels (one SCC and two SMCs)
- Parallel interface port (PIP)
  - Centronics interface support
  - Supports fast connection between compatible ports on MPC862/857T/857DSL or MC68360
- PCMCIA interface
  - Master (socket) interface, release 2.1 compliant
  - Supports one or two PCMCIA sockets dependent upon whether ESAR functionality is enabled
  - 8 memory or I/O windows supported
- Low power support
  - Full on—All units fully powered
  - Doze—Core functional units disabled except time base decremter, PLL, memory controller, RTC, and CPM in low-power standby

## Features

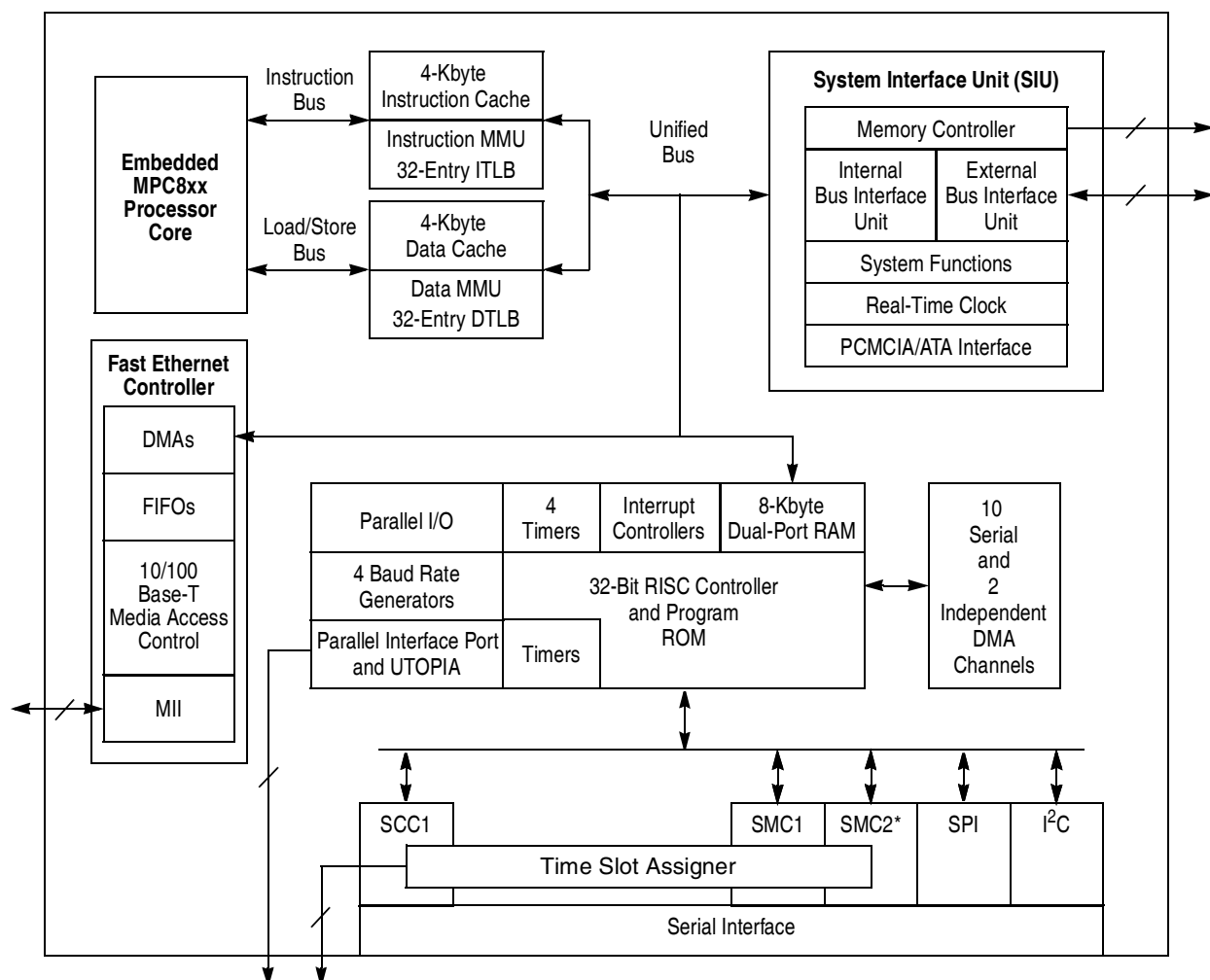
- Sleep—All units disabled except RTC, PIT, time base, and decrementer with PLL active for fast wake up
- Deep sleep—All units disabled including PLL except RTC, PIT, time base, and decrementer.
- Power down mode— All units powered down except PLL, RTC, PIT, time base and decrementer
- Debug interface
  - Eight comparators: four operate on instruction address, two operate on data address, and two operate on data
  - Supports conditions: =  $\neq$  < >
  - Each watchpoint can generate a break point internally
- 3.3 V operation with 5-V TTL compatibility except EXTAL and EXTCLK
- 357-pin plastic ball grid array (PBGA) package
- Operation up to 100MHz

The MPC862/857T/857DSL is comprised of three modules that each use the 32-bit internal bus: the MPC8xx core, the system integration unit (SIU), and the communication processor module (CPM). The MPC862P/862T block diagram is shown in [Figure 1](#). The MPC857T/857DSL block diagram is shown in [Figure 2](#).



\*The MPC862T contains 4-Kbyte instruction cache and 4-Kbyte data cache.

**Figure 1. MPC862P/862T Block Diagram**



\*The MPC857DSL does not contain SMC2 nor the Time Slot Assigner, and provides eight SDMA controllers.

**Figure 2. MPC857T/MPC857DSL Block Diagram**

### 3 Maximum Tolerated Ratings

This section provides the maximum tolerated voltage and temperature ranges for the MPC862/857T/857DSL. [Table 2](#) provides the maximum ratings.

**Table 2. Maximum Tolerated Ratings**

(GND = 0 V)

| Rating                      | Symbol | Value       | Unit | Max Freq (MHz) |
|-----------------------------|--------|-------------|------|----------------|
| Supply voltage <sup>1</sup> | VDDH   | -0.3 to 4.0 | V    | -              |
|                             | VDDL   | -0.3 to 4.0 | V    | -              |
|                             | KAPWR  | -0.3 to 4.0 | V    | -              |
|                             | VDDSYN | -0.3 to 4.0 | V    | -              |



**Table 2. Maximum Tolerated Ratings (continued)**

(GND = 0 V)

| Rating                                           | Symbol              | Value           | Unit | Max Freq (MHz) |
|--------------------------------------------------|---------------------|-----------------|------|----------------|
| Input voltage <sup>2</sup>                       | V <sub>in</sub>     | GND-0.3 to VDDH | V    | -              |
| Temperature <sup>3</sup> (standard) <sup>4</sup> | T <sub>A(min)</sub> | 0               | °C   | 100            |
|                                                  | T <sub>j(max)</sub> | 105             | °C   | 100            |
| Temperature <sup>3</sup> (extended)              | T <sub>A(min)</sub> | -40             | °C   | 80             |
|                                                  | T <sub>j(max)</sub> | 115             | °C   | 80             |
| Storage temperature range                        | T <sub>stg</sub>    | -55 to +150     | °C   | -              |

<sup>1</sup> The power supply of the device must start its ramp from 0.0 V.

<sup>2</sup> Functional operating conditions are provided with the DC electrical specifications in [Table 5](#). Absolute maximum ratings are stress ratings only; functional operation at the maxima is not guaranteed. Stress beyond those listed may affect device reliability or cause permanent damage to the device.

**Caution:** All inputs that tolerate 5 V cannot be more than 2.5 V greater than the supply voltage. This restriction applies to power-up and normal operation (that is, if the MPC862/857T/857DSL is unpowered, voltage greater than 2.5 V must not be applied to its inputs).

<sup>3</sup> Minimum temperatures are guaranteed as ambient temperature, T<sub>A</sub>. Maximum temperatures are guaranteed as junction temperature, T<sub>j</sub>.

<sup>4</sup> JTAG is tested only at ambient, not at standard maximum or extended maximum.

This device contains circuitry protecting against damage due to high-static voltage or electrical fields; however, it is advised that normal precautions be taken to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (for example, either GND or V<sub>CC</sub>).

## 4 Thermal Characteristics

Table 3 shows the thermal characteristics for the MPC862/857T/857DSL.

**Table 3. MPC862/857T/857DSL Thermal Resistance Data**

| Rating                               | Environment           |                         | Symbol                        | Value | Unit |
|--------------------------------------|-----------------------|-------------------------|-------------------------------|-------|------|
| Junction to ambient <sup>1</sup>     | Natural Convection    | Single layer board (1s) | $R_{\theta JA}$ <sup>2</sup>  | 37    | °C/W |
|                                      |                       | Four layer board (2s2p) | $R_{\theta JMA}$ <sup>3</sup> | 23    |      |
|                                      | Air flow (200 ft/min) | Single layer board (1s) | $R_{\theta JMA}$ <sup>3</sup> | 30    |      |
|                                      |                       | Four layer board (2s2p) | $R_{\theta JMA}$ <sup>3</sup> | 19    |      |
| Junction to board <sup>4</sup>       |                       |                         | $R_{\theta JB}$               | 13    |      |
| Junction to case <sup>5</sup>        |                       |                         | $R_{\theta JC}$               | 6     |      |
| Junction to package top <sup>6</sup> | Natural Convection    |                         | $\Psi_{JT}$                   | 2     |      |
|                                      | Air flow (200 ft/min) |                         | $\Psi_{JT}$                   | 2     |      |

<sup>1</sup> Junction temperature is a function of on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.

<sup>2</sup> Per SEMI G38-87 and JEDEC JESD51-2 with the single layer board horizontal.

<sup>3</sup> Per JEDEC JESD51-6 with the board horizontal.

<sup>4</sup> Thermal resistance between the die and the printed circuit board per JEDEC JESD51-8. Board temperature is measured on the top surface of the board near the package.

<sup>5</sup> Indicates the average thermal resistance between the die and the case top surface as measured by the cold plate method (MIL SPEC-883 Method 1012.1) with the cold plate temperature used for the case temperature. For exposed pad packages where the pad would be expected to be soldered, junction to case thermal resistance is a simulated value from the junction to the exposed pad without contact resistance.

<sup>6</sup> Thermal characterization parameter indicating the temperature difference between package top and the junction temperature per JEDEC JESD51-2.

## 5 Power Dissipation

Table 4 provides power dissipation information. The modes are 1:1, where CPU and bus speeds are equal, and 2:1 mode, where CPU frequency is twice bus speed.

**Table 4. Power Dissipation ( $P_D$ )**

| Die Revision           | Frequency | Typical <sup>1</sup> | Maximum <sup>2</sup> | Unit |
|------------------------|-----------|----------------------|----------------------|------|
| 0<br>(1:1 Mode)        | 50 MHz    | 656                  | 735                  | mW   |
|                        | 66 MHz    | TBD                  | TBD                  | mW   |
| A.1, B.0<br>(1:1 Mode) | 50 MHz    | 630                  | 760                  | mW   |
|                        | 66 MHz    | 890                  | 1000                 | mW   |

**Table 4. Power Dissipation ( $P_D$ ) (continued)**

| Die Revision           | Frequency | Typical <sup>1</sup> | Maximum <sup>2</sup> | Unit |
|------------------------|-----------|----------------------|----------------------|------|
| A.1, B.0<br>(2:1 Mode) | 66 MHz    | 910                  | 1060                 | mW   |
|                        | 80 MHz    | 1.06                 | 1.20                 | W    |
| B.0<br>(2:1 Mode)      | 100 MHz   | 1.35                 | 1.54                 | W    |

<sup>1</sup> Typical power dissipation is measured at 3.3 V.

<sup>2</sup> Maximum power dissipation is measured at 3.5 V.

**NOTE**

Values in [Table 4](#) represent VDDL based power dissipation and do not include I/O power dissipation over VDDH. I/O power dissipation varies widely by application due to buffer current, depending on external circuitry.

## 6 DC Characteristics

[Table 5](#) provides the DC electrical characteristics for the MPC862/857T/857DSL.

**Table 5. DC Electrical Specifications**

| Characteristic                                                                                 | Symbol                            | Min        | Max     | Unit |
|------------------------------------------------------------------------------------------------|-----------------------------------|------------|---------|------|
| Operating voltage                                                                              | VDDH, VDDL, KAPWR, VDDSYN         | 3.135      | 3.465   | V    |
|                                                                                                | KAPWR (power-down mode)           | 2.0        | 3.6     | V    |
|                                                                                                | KAPWR (all other operating modes) | VDDH – 0.4 | VDDH    | V    |
| Input High Voltage (all inputs except EXTAL and EXTCLK)                                        | VIH                               | 2.0        | 5.5     | V    |
| Input Low Voltage <sup>1</sup>                                                                 | VIL                               | GND        | 0.8     | V    |
| EXTAL, EXTCLK Input High Voltage                                                               | VIHC                              | 0.7*(VCC)  | VCC+0.3 | V    |
| Input Leakage Current, Vin = 5.5 V (Except TMS, $\overline{\text{TRST}}$ , DSCK and DSDI pins) | I <sub>in</sub>                   | —          | 100     | μA   |
| Input Leakage Current, Vin = 3.6 V (Except TMS, $\overline{\text{TRST}}$ , DSCK, and DSDI)     | I <sub>in</sub>                   | —          | 10      | μA   |
| Input Leakage Current, Vin = 0 V (Except TMS, $\overline{\text{TRST}}$ , DSCK, and DSDI pins)  | I <sub>in</sub>                   | —          | 10      | μA   |
| Input Capacitance <sup>2</sup>                                                                 | C <sub>in</sub>                   | —          | 20      | pF   |
| Output High Voltage, IOH = -2.0 mA, VDDH = 3.0 V (Except XTAL, XFC, and Open drain pins)       | VOH                               | 2.4        | —       | V    |

Table 5. DC Electrical Specifications (continued)

| Characteristic                                                                                                                                                                                                                                                                                        | Symbol | Min | Max | Unit |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|-----|------|
| Output Low Voltage<br>IOL = 2.0 mA (CLKOUT)<br>IOL = 3.2 mA <sup>3</sup><br>IOL = 5.3 mA <sup>4</sup><br>IOL = 7.0 mA (TXD1/PA14, TXD2/PA12)<br>IOL = 8.9 mA ( $\overline{TS}$ , $\overline{TA}$ , $\overline{TEA}$ , $\overline{BI}$ , $\overline{BB}$ , $\overline{HRESET}$ , $\overline{SRESET}$ ) | VOL    | —   | 0.5 | V    |

<sup>1</sup>  $V_{IL}(\text{max})$  for the I<sup>2</sup>C interface is 0.8 V rather than the 1.5 V as specified in the I<sup>2</sup>C standard.

<sup>2</sup> Input capacitance is periodically sampled.

<sup>3</sup> A(0:31),  $\overline{TSI0}/\overline{REG}$ ,  $\overline{TSI1}$ , D(0:31), DP(0:3)/ $\overline{IRQ}$ (3:6),  $\overline{RD}/\overline{WR}$ ,  $\overline{BURST}$ ,  $\overline{RSV}/\overline{IRQ2}$ ,  
IP\_B(0:1)/IWP(0:1)/VFLS(0:1), IP\_B2/IOIS16\_B/AT2, IP\_B3/IWP2/VF2, IP\_B4/LWP0/VF0, IP\_B5/LWP1/VF1,  
IP\_B6/DSDI/AT0, IP\_B7/PTR/AT3, RXD1/PA15, RXD2/PA13, L1TXDB/PA11, L1RXDB/PA10, L1TXDA/PA9,  
L1RXDA/PA8, TIN1/L1RCLKA/BRGO1/CLK1/PA7, BRGCLK1/ $\overline{TOUT1}$ /CLK2/PA6,  
TIN2/L1TCLKA/BRGO2/CLK3/PA5,  $\overline{TOUT2}$ /CLK4/PA4, TIN3/BRGO3/CLK5/PA3,  
BRGCLK2/L1RCLKB/ $\overline{TOUT3}$ /CLK6/PA2, TIN4/BRGO4/CLK7/PA1, L1TCLKB/ $\overline{TOUT4}$ /CLK8/PA0,  
 $\overline{REJECT1}/\overline{SPISEL}$ /PB31,  $\overline{SPICLK}$ /PB30,  $\overline{SPIMOSI}$ /PB29, BRGO4/ $\overline{SPIMISO}$ /PB28, BRGO1/I2CSDA/PB27,  
BRGO2/I2CSCL/PB26, SMTXD1/PB25, SMRXD1/PB24,  $\overline{SMSYN1}/\overline{SDACK1}$ /PB23,  $\overline{SMSYN2}/\overline{SDACK2}$ /PB22,  
SMTXD2/L1CLKOB/PB21, SMRXD2/L1CLKOA/PB20, L1ST1/ $\overline{RTS1}$ /PB19, L1ST2/ $\overline{RTS2}$ /PB18,  
L1ST3/ $\overline{L1RQB}$ /PB17, L1ST4/ $\overline{L1RQA}$ /PB16, BRGO3/PB15,  $\overline{RSTR1}$ /PB14, L1ST1/ $\overline{RTS1}$ / $\overline{DREQ0}$ /PC15,  
L1ST2/ $\overline{RTS2}$ / $\overline{DREQ1}$ /PC14, L1ST3/ $\overline{L1RQB}$ /PC13, L1ST4/ $\overline{L1RQA}$ /PC12,  $\overline{CTS1}$ /PC11,  $\overline{TGATE1}/\overline{CD1}$ /PC10,  
 $\overline{CTS2}$ /PC9,  $\overline{TGATE2}/\overline{CD2}$ /PC8,  $\overline{CTS3}/\overline{SDACK2}$ /L1TSYNCB/PC7,  $\overline{CD3}$ /L1RSYNCB/PC6,  
 $\overline{CTS4}/\overline{SDACK1}$ /L1TSYNCA/PC5,  $\overline{CD4}$ /L1RSYNCA/PC4, PD15/L1TSYNCA, PD14/L1RSYNCA, PD13/L1TSYNCB,  
PD12/L1RSYNCB, PD11/RXD3, PD10/TXD3, PD9/RXD4, PD8/TXD4, PD5/REJECT2, PD6/ $\overline{RTS4}$ , PD7/ $\overline{RTS3}$ ,  
PD4/REJECT3, PD3, MII\_MDC, MII\_TX\_ER, MII\_EN, MII\_MDIO, MII\_TXD[0:3].

<sup>4</sup>  $\overline{BDIP}/\overline{GPL}_B(5)$ ,  $\overline{BR}$ ,  $\overline{BG}$ , FRZ/ $\overline{IRQ6}$ ,  $\overline{CS}(0:5)$ ,  $\overline{CS}(6)/\overline{CE}(1)_B$ ,  $\overline{CS}(7)/\overline{CE}(2)_B$ ,  $\overline{WE0}/\overline{BS}_B(0)/\overline{IORD}$ ,  
 $\overline{WE1}/\overline{BS}_B(1)/\overline{IOWR}$ ,  $\overline{WE2}/\overline{BS}_B(2)/\overline{PCOE}$ ,  $\overline{WE3}/\overline{BS}_B(3)/\overline{PCWE}$ ,  $\overline{BS}_A(0:3)$ ,  $\overline{GPL}_A0/\overline{GPL}_B0$ ,  $\overline{OE}/\overline{GPL}_A1/\overline{GPL}_B1$ ,  
 $\overline{GPL}_A(2:3)/\overline{GPL}_B(2:3)/\overline{CS}(2:3)$ , UPWAITA/ $\overline{GPL}_A4$ , UPWAITB/ $\overline{GPL}_B4$ ,  $\overline{GPL}_A5$ , ALE\_A,  $\overline{CE1}_A$ ,  $\overline{CE2}_A$ ,  
ALE\_B/ $\overline{DSCK}$ /AT1, OP(0:1), OP2/MODCK1/STS, OP3/MODCK2/SDSO, BADDR(28:30).

## 7 Thermal Calculation and Measurement

For the following discussions,  $P_D = (V_{DD} \times I_{DD}) + P_{I/O}$ , where  $P_{I/O}$  is the power dissipation of the I/O drivers.

### 7.1 Estimation with Junction-to-Ambient Thermal Resistance

An estimation of the chip junction temperature,  $T_J$ , in °C can be obtained from the equation:

$$T_J = T_A + (R_{\theta JA} \times P_D)$$

where:

$T_A$  = ambient temperature (°C)

$R_{\theta JA}$  = package junction-to-ambient thermal resistance (°C/W)

$P_D$  = power dissipation in package

The junction-to-ambient thermal resistance is an industry standard value which provides a quick and easy estimation of thermal performance. However, the answer is only an estimate; test cases have demonstrated that errors of a factor of two (in the quantity  $T_J - T_A$ ) are possible.

## 7.2 Estimation with Junction-to-Case Thermal Resistance

Historically, the thermal resistance has frequently been expressed as the sum of a junction-to-case thermal resistance and a case-to-ambient thermal resistance:

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CA}$$

where:

$R_{\theta JA}$  = junction-to-ambient thermal resistance ( $^{\circ}\text{C}/\text{W}$ )

$R_{\theta JC}$  = junction-to-case thermal resistance ( $^{\circ}\text{C}/\text{W}$ )

$R_{\theta CA}$  = case-to-ambient thermal resistance ( $^{\circ}\text{C}/\text{W}$ )

$R_{\theta JC}$  is device related and cannot be influenced by the user. The user adjusts the thermal environment to affect the case-to-ambient thermal resistance,  $R_{\theta CA}$ . For instance, the user can change the air flow around the device, add a heat sink, change the mounting arrangement on the printed circuit board, or change the thermal dissipation on the printed circuit board surrounding the device. This thermal model is most useful for ceramic packages with heat sinks where some 90% of the heat flows through the case and the heat sink to the ambient environment. For most packages, a better model is required.

## 7.3 Estimation with Junction-to-Board Thermal Resistance

A simple package thermal model which has demonstrated reasonable accuracy (about 20%) is a two resistor model consisting of a junction-to-board and a junction-to-case thermal resistance. The junction-to-case covers the situation where a heat sink is used or where a substantial amount of heat is dissipated from the top of the package. The junction-to-board thermal resistance describes the thermal performance when most of the heat is conducted to the printed circuit board. It has been observed that the thermal performance of most plastic packages and especially PBGA packages is strongly dependent on the board temperature; see [Figure 3](#).

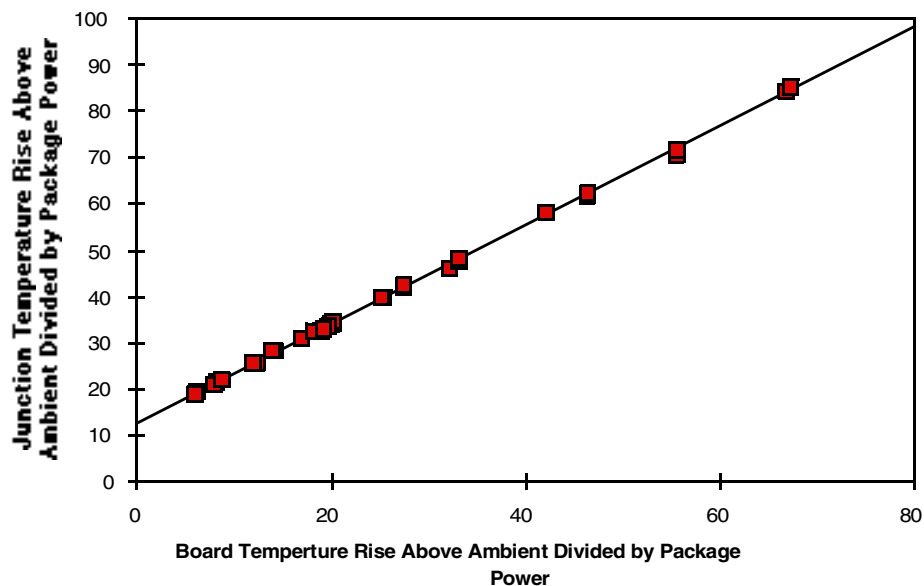


Figure 3. Effect of Board Temperature Rise on Thermal Behavior

If the board temperature is known, an estimate of the junction temperature in the environment can be made using the following equation:

$$T_J = T_B + (R_{\theta JB} \times P_D)$$

where:

$R_{\theta JB}$  = junction-to-board thermal resistance ( $^{\circ}\text{C}/\text{W}$ )

$T_B$  = board temperature ( $^{\circ}\text{C}$ )

$P_D$  = power dissipation in package

If the board temperature is known and the heat loss from the package case to the air can be ignored, acceptable predictions of junction temperature can be made. For this method to work, the board and board mounting must be similar to the test board used to determine the junction-to-board thermal resistance, namely a 2s2p (board with a power and a ground plane) and vias attaching the thermal balls to the ground plane.

## 7.4 Estimation Using Simulation

When the board temperature is not known, a thermal simulation of the application is needed. The simple two resistor model can be used with the thermal simulation of the application [2], or a more accurate and complex model of the package can be used in the thermal simulation.

## 7.5 Experimental Determination

To determine the junction temperature of the device in the application after prototypes are available, the thermal characterization parameter ( $\Psi_{JT}$ ) can be used to determine the junction temperature with a measurement of the temperature at the top center of the package case using the following equation:

$$T_J = T_T + (\Psi_{JT} \times P_D)$$

where:

$\Psi_{JT}$  = thermal characterization parameter

$T_T$  = thermocouple temperature on top of package

$P_D$  = power dissipation in package

The thermal characterization parameter is measured per JESD51-2 specification published by JEDEC using a 40-gauge type T thermocouple epoxied to the top center of the package case. The thermocouple should be positioned so that the thermocouple junction rests on the package. A small amount of epoxy is placed over the thermocouple junction and over about 1 mm of wire extending from the junction. The thermocouple wire is placed flat against the package case to avoid measurement errors caused by cooling effects of the thermocouple wire.

## 7.6 References

Semiconductor Equipment and Materials International  
805 East Middlefield Rd.  
Mountain View, CA 94043

(415) 964-5111

MIL-SPEC and EIA/JESD (JEDEC) Specifications  
(Available from Global Engineering Documents)

800-854-7179 or  
303-397-7956

JEDEC Specifications

<http://www.jedec.org>

1. C.E. Triplett and B. Joiner, "An Experimental Characterization of a 272 PBGA Within an Automotive Engine Controller Module," Proceedings of SemiTherm, San Diego, 1998, pp. 47-54.
2. B. Joiner and V. Adams, "Measurement and Simulation of Junction to Board Thermal Resistance and Its Application in Thermal Modeling," Proceedings of SemiTherm, San Diego, 1999, pp. 212-220.

## 8 Layout Practices

Each  $V_{CC}$  pin on the MPC862/857T/857DSL should be provided with a low-impedance path to the board's supply. Each GND pin should likewise be provided with a low-impedance path to ground. The power supply pins drive distinct groups of logic on chip. The  $V_{CC}$  power supply should be bypassed to ground using at least four 0.1  $\mu$ F by-pass capacitors located as close as possible to the four sides of the package. The capacitor leads and associated printed circuit traces connecting to chip  $V_{CC}$  and GND should be kept to less than half an inch per capacitor lead. A four-layer board is recommended, employing two inner layers as  $V_{CC}$  and GND planes.

All output pins on the MPC862/857T/857DSL have fast rise and fall times. Printed circuit (PC) trace interconnection length should be minimized in order to minimize undershoot and reflections caused by these fast output switching times. This recommendation particularly applies to the address and data busses. Maximum PC trace lengths of six inches are recommended. Capacitance calculations should consider all device loads as well as parasitic capacitances due to the PC traces. Attention to proper PCB layout and bypassing becomes especially critical in systems with higher capacitive loads because these loads create higher transient currents in the  $V_{CC}$  and GND circuits. Pull up all unused inputs or signals that will be inputs during reset. Special care should be taken to minimize the noise levels on the PLL supply pins.

## 9 Bus Signal Timing

The maximum bus speed supported by the MPC862/857T/857DSL is 66 MHz. Higher-speed parts must be operated in half-speed bus mode (for example, an MPC862/857T/857DSL used at 80MHz must be configured for a 40 MHz bus). Table 6 shows the period ranges for standard part frequencies.

**Table 6. Period Range for Standard Part Frequencies**

| Freq   | 50 MHz |       | 66 MHz |       | 80 MHz |       | 100 MHz |       |
|--------|--------|-------|--------|-------|--------|-------|---------|-------|
|        | Min    | Max   | Min    | Max   | Min    | Max   | Min     | Max   |
| Period | 20.00  | 30.30 | 15.15  | 30.30 | 25.00  | 30.30 | 20.00   | 30.30 |

Table 7 provides the bus operation timing for the MPC862/857T/857DSL at 33 MHz, 40 Mhz, 50 MHz and 66 Mhz.

The timing for the MPC862/857T/857DSL bus shown assumes a 50-pF load for maximum delays and a 0-pF load for minimum delays.

**Table 7. Bus Operation Timings**

| Num              | Characteristic                                                                                           | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|------------------|----------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|                  |                                                                                                          | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| B1               | CLKOUT period                                                                                            | 30.30  | 30.30 | 25.00  | 30.30 | 20.00  | 30.30 | 15.15  | 30.30 | ns   |
| B1a              | EXTCLK to CLKOUT phase skew (EXTCLK > 15 MHz and MF <= 2)                                                | -0.90  | 0.90  | -0.90  | 0.90  | -0.90  | 0.90  | -0.90  | 0.90  | ns   |
| B1b              | EXTCLK to CLKOUT phase skew (EXTCLK > 10 MHz and MF < 10)                                                | -2.30  | 2.30  | -2.30  | 2.30  | -2.30  | 2.30  | -2.30  | 2.30  | ns   |
| B1c              | CLKOUT phase jitter (EXTCLK > 15 MHz and MF <= 2) <sup>1</sup>                                           | -0.60  | 0.60  | -0.60  | 0.60  | -0.60  | 0.60  | -0.60  | 0.60  | ns   |
| B1d              | CLKOUT phase jitter <sup>1</sup>                                                                         | -2.00  | 2.00  | -2.00  | 2.00  | -2.00  | 2.00  | -2.00  | 2.00  | ns   |
| B1e              | CLKOUT frequency jitter (MF < 10) <sup>1</sup>                                                           | —      | 0.50  | —      | 0.50  | —      | 0.50  | —      | 0.50  | %    |
| B1f              | CLKOUT frequency jitter (10 < MF < 500) <sup>1</sup>                                                     | —      | 2.00  | —      | 2.00  | —      | 2.00  | —      | 2.00  | %    |
| B1g              | CLKOUT frequency jitter (MF > 500) <sup>1</sup>                                                          | —      | 3.00  | —      | 3.00  | —      | 3.00  | —      | 3.00  | %    |
| B1h              | Frequency jitter on EXTCLK <sup>2</sup>                                                                  | —      | 0.50  | —      | 0.50  | —      | 0.50  | —      | 0.50  | %    |
| B2               | CLKOUT pulse width low (MIN = 0.040 x B1)                                                                | 12.10  | —     | 10.00  | —     | 8.00   | —     | 6.10   | —     | ns   |
| B3               | CLKOUT width high (MIN = 0.040 x B1)                                                                     | 12.10  | —     | 10.00  | —     | 8.00   | —     | 6.10   | —     | ns   |
| B4               | CLKOUT rise time <sup>3</sup> (MAX = 0.00 x B1 + 4.00)                                                   | —      | 4.00  | —      | 4.00  | —      | 4.00  | —      | 4.00  | ns   |
| B5 <sup>33</sup> | CLKOUT fall time <sup>3</sup> (MAX = 0.00 x B1 + 4.00)                                                   | —      | 4.00  | —      | 4.00  | —      | 4.00  | —      | 4.00  | ns   |
| B7               | CLKOUT to A(0:31), BADDR(28:30), RD/WR, BURST, D(0:31), DP(0:3) invalid (MIN = 0.25 x B1)                | 7.60   | —     | 6.30   | —     | 5.00   | —     | 3.80   | —     | ns   |
| B7a              | CLKOUT to TSIZ(0:1), REG, RSV, AT(0:3), BDIP, PTR invalid (MIN = 0.25 x B1)                              | 7.60   | —     | 6.30   | —     | 5.00   | —     | 3.80   | —     | ns   |
| B7b              | CLKOUT to BR, BG, FRZ, VFLS(0:1), VF(0:2) IWP(0:2), LWP(0:1), STS invalid <sup>4</sup> (MIN = 0.25 x B1) | 7.60   | —     | 6.30   | —     | 5.00   | —     | 3.80   | —     | ns   |
| B8               | CLKOUT to A(0:31), BADDR(28:30) RD/WR, BURST, D(0:31), DP(0:3) valid (MAX = 0.25 x B1 + 6.3)             | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |



Table 7. Bus Operation Timings (continued)

| Num  | Characteristic                                                                                                                                                                                                                 | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|      |                                                                                                                                                                                                                                | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| B8a  | CLKOUT to TSIZ(0:1), $\overline{\text{REG}}$ , $\overline{\text{RSV}}$ , AT(0:3) $\overline{\text{BDIP}}$ , PTR valid (MAX = $0.25 \times B1 + 6.3$ )                                                                          | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |
| B8b  | CLKOUT to $\overline{\text{BR}}$ , $\overline{\text{BG}}$ , VFSL(0:1), VF(0:2), IWP(0:2), FRZ, LWP(0:1), STS Valid <sup>4</sup> (MAX = $0.25 \times B1 + 6.3$ )                                                                | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |
| B9   | CLKOUT to A(0:31), BADDR(28:30), RD/ $\overline{\text{WR}}$ , BURST, D(0:31), DP(0:3), TSIZ(0:1), $\overline{\text{REG}}$ , $\overline{\text{RSV}}$ , AT(0:3), PTR High-Z (MAX = $0.25 \times B1 + 6.3$ )                      | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |
| B11  | CLKOUT to $\overline{\text{TS}}$ , $\overline{\text{BB}}$ assertion (MAX = $0.25 \times B1 + 6.0$ )                                                                                                                            | 7.60   | 13.60 | 6.30   | 12.30 | 5.00   | 11.00 | 3.80   | 11.30 | ns   |
| B11a | CLKOUT to $\overline{\text{TA}}$ , $\overline{\text{BI}}$ assertion (when driven by the memory controller or PCMCIA interface) (MAX = $0.00 \times B1 + 9.30$ <sup>5</sup> )                                                   | 2.50   | 9.30  | 2.50   | 9.30  | 2.50   | 9.30  | 2.50   | 9.80  | ns   |
| B12  | CLKOUT to $\overline{\text{TS}}$ , $\overline{\text{BB}}$ negation (MAX = $0.25 \times B1 + 4.8$ )                                                                                                                             | 7.60   | 12.30 | 6.30   | 11.00 | 5.00   | 9.80  | 3.80   | 8.50  | ns   |
| B12a | CLKOUT to $\overline{\text{TA}}$ , $\overline{\text{BI}}$ negation (when driven by the memory controller or PCMCIA interface) (MAX = $0.00 \times B1 + 9.00$ )                                                                 | 2.50   | 9.00  | 2.50   | 9.00  | 2.50   | 9.00  | 2.50   | 9.00  | ns   |
| B13  | CLKOUT to $\overline{\text{TS}}$ , $\overline{\text{BB}}$ High-Z (MIN = $0.25 \times B1$ )                                                                                                                                     | 7.60   | 21.60 | 6.30   | 20.30 | 5.00   | 19.00 | 3.80   | 14.00 | ns   |
| B13a | CLKOUT to $\overline{\text{TA}}$ , $\overline{\text{BI}}$ High-Z (when driven by the memory controller or PCMCIA interface) (MIN = $0.00 \times B1 + 2.5$ )                                                                    | 2.50   | 15.00 | 2.50   | 15.00 | 2.50   | 15.00 | 2.50   | 15.00 | ns   |
| B14  | CLKOUT to $\overline{\text{TEA}}$ assertion (MAX = $0.00 \times B1 + 9.00$ )                                                                                                                                                   | 2.50   | 9.00  | 2.50   | 9.00  | 2.50   | 9.00  | 2.50   | 9.00  | ns   |
| B15  | CLKOUT to $\overline{\text{TEA}}$ High-Z (MIN = $0.00 \times B1 + 2.50$ )                                                                                                                                                      | 2.50   | 15.00 | 2.50   | 15.00 | 2.50   | 15.00 | 2.50   | 15.00 | ns   |
| B16  | $\overline{\text{TA}}$ , $\overline{\text{BI}}$ valid to CLKOUT (setup time) (MIN = $0.00 \times B1 + 6.00$ )                                                                                                                  | 6.00   | —     | 6.00   | —     | 6.00   | —     | 6.00   | —     | ns   |
| B16a | $\overline{\text{TEA}}$ , $\overline{\text{KR}}$ , $\overline{\text{RETRY}}$ , $\overline{\text{CR}}$ valid to CLKOUT (setup time) (MIN = $0.00 \times B1 + 4.5$ )                                                             | 4.50   | —     | 4.50   | —     | 4.50   | —     | 4.50   | —     | ns   |
| B16b | $\overline{\text{BB}}$ , $\overline{\text{BG}}$ , $\overline{\text{BR}}$ , valid to CLKOUT (setup time) <sup>6</sup> (4MIN = $0.00 \times B1 + 0.00$ )                                                                         | 4.00   | —     | 4.00   | —     | 4.00   | —     | 4.00   | —     | ns   |
| B17  | CLKOUT to $\overline{\text{TA}}$ , $\overline{\text{TEA}}$ , $\overline{\text{BI}}$ , $\overline{\text{BB}}$ , $\overline{\text{BG}}$ , $\overline{\text{BR}}$ valid (hold time) (MIN = $0.00 \times B1 + 1.00$ <sup>7</sup> ) | 1.00   | —     | 1.00   | —     | 1.00   | —     | 2.00   | —     | ns   |

Table 7. Bus Operation Timings (continued)

| Num  | Characteristic                                                                                                                           | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|------|------------------------------------------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|      |                                                                                                                                          | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| B17a | CLKOUT to $\overline{KR}$ , $\overline{RETRY}$ , $\overline{CR}$ valid (hold time) (MIN = 0.00 x B1 + 2.00)                              | 2.00   | —     | 2.00   | —     | 2.00   | —     | 2.00   | —     | ns   |
| B18  | D(0:31), DP(0:3) valid to CLKOUT rising edge (setup time) <sup>8</sup> (MIN = 0.00 x B1 + 6.00)                                          | 6.00   | —     | 6.00   | —     | 6.00   | —     | 6.00   | —     | ns   |
| B19  | CLKOUT rising edge to D(0:31), DP(0:3) valid (hold time) <sup>8</sup> (MIN = 0.00 x B1 + 1.00 <sup>9</sup> )                             | 1.00   | —     | 1.00   | —     | 1.00   | —     | 2.00   | —     | ns   |
| B20  | D(0:31), DP(0:3) valid to CLKOUT falling edge (setup time) <sup>10</sup> (MIN = 0.00 x B1 + 4.00)                                        | 4.00   | —     | 4.00   | —     | 4.00   | —     | 4.00   | —     | ns   |
| B21  | CLKOUT falling edge to D(0:31), DP(0:3) valid (hold Time) <sup>10</sup> (MIN = 0.00 x B1 + 2.00)                                         | 2.00   | —     | 2.00   | —     | 2.00   | —     | 2.00   | —     | ns   |
| B22  | CLKOUT rising edge to $\overline{CS}$ asserted GPCM ACS = 00 (MAX = 0.25 x B1 + 6.3)                                                     | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |
| B22a | CLKOUT falling edge to $\overline{CS}$ asserted GPCM ACS = 10, TRLX = 0 (MAX = 0.00 x B1 + 8.00)                                         | —      | 8.00  | —      | 8.00  | —      | 8.00  | —      | 8.00  | ns   |
| B22b | CLKOUT falling edge to $\overline{CS}$ asserted GPCM ACS = 11, TRLX = 0, EBDF = 0 (MAX = 0.25 x B1 + 6.3)                                | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |
| B22c | CLKOUT falling edge to $\overline{CS}$ asserted GPCM ACS = 11, TRLX = 0, EBDF = 1 (MAX = 0.375 x B1 + 6.6)                               | 10.90  | 18.00 | 10.90  | 18.00 | 7.00   | 14.30 | 5.20   | 12.30 | ns   |
| B23  | CLKOUT rising edge to $\overline{CS}$ negated GPCM read access, GPCM write access ACS = 00, TRLX = 0 & CSNT = 0 (MAX = 0.00 x B1 + 8.00) | 2.00   | 8.00  | 2.00   | 8.00  | 2.00   | 8.00  | 2.00   | 8.00  | ns   |
| B24  | A(0:31) and BADDR(28:30) to $\overline{CS}$ asserted GPCM ACS = 10, TRLX = 0 (MIN = 0.25 x B1 - 2.00)                                    | 5.60   | —     | 4.30   | —     | 3.00   | —     | 1.80   | —     | ns   |
| B24a | A(0:31) and BADDR(28:30) to $\overline{CS}$ asserted GPCM ACS = 11 TRLX = 0 (MIN = 0.50 x B1 - 2.00)                                     | 13.20  | —     | 10.50  | —     | 8.00   | —     | 5.60   | —     | ns   |
| B25  | CLKOUT rising edge to $\overline{OE}$ , $\overline{WE}$ (0:3) asserted (MAX = 0.00 x B1 + 9.00)                                          | —      | 9.00  |        | 9.00  |        | 9.00  |        | 9.00  | ns   |
| B26  | CLKOUT rising edge to $\overline{OE}$ negated (MAX = 0.00 x B1 + 9.00)                                                                   | 2.00   | 9.00  | 2.00   | 9.00  | 2.00   | 9.00  | 2.00   | 9.00  | ns   |

Table 7. Bus Operation Timings (continued)

| Num  | Characteristic                                                                                                                                                | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|      |                                                                                                                                                               | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| B27  | A(0:31) and BADDR(28:30) to $\overline{CS}$ asserted GPCM ACS = 10, TRLX = 1 (MIN = 1.25 x B1 - 2.00)                                                         | 35.90  | —     | 29.30  | —     | 23.00  | —     | 16.90  | —     | ns   |
| B27a | A(0:31) and BADDR(28:30) to $\overline{CS}$ asserted GPCM ACS = 11, TRLX = 1 (MIN = 1.50 x B1 - 2.00)                                                         | 43.50  | —     | 35.50  | —     | 28.00  | —     | 20.70  | —     | ns   |
| B28  | CLKOUT rising edge to $\overline{WE}(0:3)$ negated GPCM write access CSNT = 0 (MAX = 0.00 x B1 + 9.00)                                                        | —      | 9.00  | —      | 9.00  | —      | 9.00  | —      | 9.00  | ns   |
| B28a | CLKOUT falling edge to $\overline{WE}(0:3)$ negated GPCM write access TRLX = 0, 1, CSNT = 1, EBDF = 0 (MAX = 0.25 x B1 + 6.80)                                | 7.60   | 14.30 | 6.30   | 13.00 | 5.00   | 11.80 | 3.80   | 10.50 | ns   |
| B28b | CLKOUT falling edge to $\overline{CS}$ negated GPCM write access TRLX = 0,1, CSNT = 1 ACS = 10 or ACS = 11, EBDF = 0 (MAX = 0.25 x B1 + 6.80)                 | —      | 14.30 | —      | 13.00 | —      | 11.80 | —      | 10.50 | ns   |
| B28c | CLKOUT falling edge to $\overline{WE}(0:3)$ negated GPCM write access TRLX = 0, CSNT = 1 write access TRLX = 0,1, CSNT = 1, EBDF = 1 (MAX = 0.375 x B1 + 6.6) | 10.90  | 18.00 | 10.90  | 18.00 | 7.00   | 14.30 | 5.20   | 12.30 | ns   |
| B28d | CLKOUT falling edge to $\overline{CS}$ negated GPCM write access TRLX = 0,1, CSNT = 1, ACS = 10, or ACS = 11, EBDF = 1 (MAX = 0.375 x B1 + 6.6)               | —      | 18.00 | —      | 18.00 | —      | 14.30 | —      | 12.30 | ns   |
| B29  | $\overline{WE}(0:3)$ negated to D(0:31), DP(0:3) High-Z GPCM write access, CSNT = 0, EBDF = 0 (MIN = 0.25 x B1 - 2.00)                                        | 5.60   | —     | 4.30   | —     | 3.00   | —     | 1.80   | —     | ns   |
| B29a | $\overline{WE}(0:3)$ negated to D(0:31), DP(0:3) High-Z GPCM write access, TRLX = 0, CSNT = 1, EBDF = 0 (MIN = 0.50 x B1 - 2.00)                              | 13.20  | —     | 10.50  | —     | 8.00   | —     | 5.60   | —     | ns   |
| B29b | $\overline{CS}$ negated to D(0:31), DP(0:3), High Z GPCM write access, ACS = 00, TRLX = 0,1 & CSNT = 0 (MIN = 0.25 x B1 - 2.00)                               | 5.60   | —     | 4.30   | —     | 3.00   | —     | 1.80   | —     | ns   |
| B29c | $\overline{CS}$ negated to D(0:31), DP(0:3) High-Z GPCM write access, TRLX = 0, CSNT = 1, ACS = 10, or ACS = 11 EBDF = 0 (MIN = 0.50 x B1 - 2.00)             | 13.20  | —     | 10.50  | —     | 8.00   | —     | 5.60   | —     | ns   |

Table 7. Bus Operation Timings (continued)

| Num  | Characteristic                                                                                                                                                                                                                                             | 33 MHz |     | 40 MHz |     | 50 MHz |     | 66 MHz |     | Unit |
|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|--------|-----|--------|-----|--------|-----|------|
|      |                                                                                                                                                                                                                                                            | Min    | Max | Min    | Max | Min    | Max | Min    | Max |      |
| B29d | $\overline{WE}(0:3)$ negated to D(0:31), DP(0:3) High-Z GPCM write access, TRLX = 1, CSNT = 1, EBDF = 0 (MIN = 1.50 x B1 - 2.00)                                                                                                                           | 43.50  | —   | 35.50  | —   | 28.00  | —   | 20.70  | —   | ns   |
| B29e | $\overline{CS}$ negated to D(0:31), DP(0:3) High-Z GPCM write access, TRLX = 1, CSNT = 1, ACS = 10, or ACS = 11 EBDF = 0 (MIN = 1.50 x B1 - 2.00)                                                                                                          | 43.50  | —   | 35.50  | —   | 28.00  | —   | 20.70  | —   | ns   |
| B29f | $\overline{WE}(0:3)$ negated to D(0:31), DP(0:3) High Z GPCM write access, TRLX = 0, CSNT = 1, EBDF = 1 (MIN = 0.375 x B1 - 6.30)                                                                                                                          | 5.00   | —   | 3.00   | —   | 1.10   | —   | 0.00   | —   | ns   |
| B29g | $\overline{CS}$ negated to D(0:31), DP(0:3) High-Z GPCM write access, TRLX = 0, CSNT = 1 ACS = 10 or ACS = 11, EBDF = 1 (MIN = 0.375 x B1 - 6.30)                                                                                                          | 5.00   | —   | 3.00   | —   | 1.10   | —   | 0.00   | —   | ns   |
| B29h | $\overline{WE}(0:3)$ negated to D(0:31), DP(0:3) High Z GPCM write access, TRLX = 1, CSNT = 1, EBDF = 1 (MIN = 0.375 x B1 - 3.30)                                                                                                                          | 38.40  | —   | 31.10  | —   | 24.20  | —   | 17.50  | —   | ns   |
| B29i | $\overline{CS}$ negated to D(0:31), DP(0:3) High-Z GPCM write access, TRLX = 1, CSNT = 1, ACS = 10 or ACS = 11, EBDF = 1 (MIN = 0.375 x B1 - 3.30)                                                                                                         | 38.40  | —   | 31.10  | —   | 24.20  | —   | 17.50  | —   | ns   |
| B30  | $\overline{CS}$ , $\overline{WE}(0:3)$ negated to A(0:31), BADDR(28:30) Invalid GPCM write access <sup>11</sup> (MIN = 0.25 x B1 - 2.00)                                                                                                                   | 5.60   | —   | 4.30   | —   | 3.00   | —   | 1.80   | —   | ns   |
| B30a | $\overline{WE}(0:3)$ negated to A(0:31), BADDR(28:30) Invalid GPCM, write access, TRLX = 0, CSNT = 1, $\overline{CS}$ negated to A(0:31) invalid GPCM write access TRLX = 0, CSNT = 1 ACS = 10, or ACS == 11, EBDF = 0 (MIN = 0.50 x B1 - 2.00)            | 13.20  | —   | 10.50  | —   | 8.00   | —   | 5.60   | —   | ns   |
| B30b | $\overline{WE}(0:3)$ negated to A(0:31) Invalid GPCM BADDR(28:30) invalid GPCM write access, TRLX = 1, CSNT = 1. $\overline{CS}$ negated to A(0:31) Invalid GPCM write access TRLX = 1, CSNT = 1, ACS = 10, or ACS == 11 EBDF = 0 (MIN = 1.50 x B1 - 2.00) | 43.50  | —   | 35.50  | —   | 28.00  | —   | 20.70  | —   | ns   |

Table 7. Bus Operation Timings (continued)

| Num  | Characteristic                                                                                                                                                                                                                                                  | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|      |                                                                                                                                                                                                                                                                 | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| B30c | $\overline{WE}(0:3)$ negated to A(0:31),<br>BADDR(28:30) invalid GPCM write<br>access, TRLX = 0, CSNT = 1.<br>$\overline{CS}$ negated to A(0:31) invalid GPCM<br>write access, TRLX = 0, CSNT = 1<br>ACS = 10, ACS == 11, EBDF = 1<br>(MIN = 0.375 x B1 - 3.00) | 8.40   | —     | 6.40   | —     | 4.50   | —     | 2.70   | —     | ns   |
| B30d | $\overline{WE}(0:3)$ negated to A(0:31),<br>BADDR(28:30) invalid GPCM write<br>access TRLX = 1, CSNT = 1,<br>$\overline{CS}$ negated to A(0:31) invalid GPCM<br>write access TRLX = 1, CSNT = 1,<br>ACS = 10 or 11, EBDF = 1                                    | 38.67  | —     | 31.38  | —     | 24.50  | —     | 17.83  | —     | ns   |
| B31  | CLKOUT falling edge to $\overline{CS}$ valid - as<br>requested by control bit CST4 in the<br>corresponding word in the UPM<br>(MAX = 0.00 X B1 + 6.00)                                                                                                          | 1.50   | 6.00  | 1.50   | 6.00  | 1.50   | 6.00  | 1.50   | 6.00  | ns   |
| B31a | CLKOUT falling edge to $\overline{CS}$ valid - as<br>requested by control bit CST1 in the<br>corresponding word in the UPM<br>(MAX = 0.25 x B1 + 6.80)                                                                                                          | 7.60   | 14.30 | 6.30   | 13.00 | 5.00   | 11.80 | 3.80   | 10.50 | ns   |
| B31b | CLKOUT rising edge to $\overline{CS}$ valid - as<br>requested by control bit CST2 in the<br>corresponding word in the UPM<br>(MAX = 0.00 x B1 + 8.00)                                                                                                           | 1.50   | 8.00  | 1.50   | 8.00  | 1.50   | 8.00  | 1.50   | 8.00  | ns   |
| B31c | CLKOUT rising edge to $\overline{CS}$ valid- as<br>requested by control bit CST3 in the<br>corresponding word in the UPM<br>(MAX = 0.25 x B1 + 6.30)                                                                                                            | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |
| B31d | CLKOUT falling edge to $\overline{CS}$ valid, as<br>requested by control bit CST1 in the<br>corresponding word in the UPM<br>EBDF = 1 (MAX = 0.375 x B1 + 6.6)                                                                                                  | 9.40   | 18.00 | 7.60   | 16.00 | 13.30  | 14.10 | 11.30  | 12.30 | ns   |
| B32  | CLKOUT falling edge to $\overline{BS}$ valid- as<br>requested by control bit BST4 in the<br>corresponding word in the UPM<br>(MAX = 0.00 x B1 + 6.00)                                                                                                           | 1.50   | 6.00  | 1.50   | 6.00  | 1.50   | 6.00  | 1.50   | 6.00  | ns   |
| B32a | CLKOUT falling edge to $\overline{BS}$ valid - as<br>requested by control bit BST1 in the<br>corresponding word in the UPM,<br>EBDF = 0 (MAX = 0.25 x B1 + 6.80)                                                                                                | 7.60   | 14.30 | 6.30   | 13.00 | 5.00   | 11.80 | 3.80   | 10.50 | ns   |
| B32b | CLKOUT rising edge to $\overline{BS}$ valid - as<br>requested by control bit BST2 in the<br>corresponding word in the UPM<br>(MAX = 0.00 x B1 + 8.00)                                                                                                           | 1.50   | 8.00  | 1.50   | 8.00  | 1.50   | 8.00  | 1.50   | 8.00  | ns   |

Table 7. Bus Operation Timings (continued)

| Num  | Characteristic                                                                                                                                                       | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|      |                                                                                                                                                                      | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| B32c | CLKOUT rising edge to $\overline{BS}$ valid - as requested by control bit BST3 in the corresponding word in the UPM (MAX = $0.25 \times B1 + 6.80$ )                 | 7.60   | 14.30 | 6.30   | 13.00 | 5.00   | 11.80 | 3.80   | 10.50 | ns   |
| B32d | CLKOUT falling edge to $\overline{BS}$ valid- as requested by control bit BST1 in the corresponding word in the UPM, EBDf = 1 (MAX = $0.375 \times B1 + 6.60$ )      | 9.40   | 18.00 | 7.60   | 16.00 | 13.30  | 14.10 | 11.30  | 12.30 | ns   |
| B33  | CLKOUT falling edge to $\overline{GPL}$ valid - as requested by control bit GxT4 in the corresponding word in the UPM (MAX = $0.00 \times B1 + 6.00$ )               | 1.50   | 6.00  | 1.50   | 6.00  | 1.50   | 6.00  | 1.50   | 6.00  | ns   |
| B33a | CLKOUT rising edge to $\overline{GPL}$ Valid - as requested by control bit GxT3 in the corresponding word in the UPM (MAX = $0.25 \times B1 + 6.80$ )                | 7.60   | 14.30 | 6.30   | 13.00 | 5.00   | 11.80 | 3.80   | 10.50 | ns   |
| B34  | A(0:31), BADDR(28:30), and D(0:31) to $\overline{CS}$ valid - as requested by control bit CST4 in the corresponding word in the UPM (MIN = $0.25 \times B1 - 2.00$ ) | 5.60   | —     | 4.30   | —     | 3.00   | —     | 1.80   | —     | ns   |
| B34a | A(0:31), BADDR(28:30), and D(0:31) to $\overline{CS}$ valid - as requested by control bit CST1 in the corresponding word in the UPM (MIN = $0.50 \times B1 - 2.00$ ) | 13.20  | —     | 10.50  | —     | 8.00   | —     | 5.60   | —     | ns   |
| B34b | A(0:31), BADDR(28:30), and D(0:31) to $\overline{CS}$ valid - as requested by CST2 in the corresponding word in UPM (MIN = $0.75 \times B1 - 2.00$ )                 | 20.70  | —     | 16.70  | —     | 13.00  | —     | 9.40   | —     | ns   |
| B35  | A(0:31), BADDR(28:30) to $\overline{CS}$ valid - as requested by control bit BST4 in the corresponding word in the UPM (MIN = $0.25 \times B1 - 2.00$ )              | 5.60   | —     | 4.30   | —     | 3.00   | —     | 1.80   | —     | ns   |
| B35a | A(0:31), BADDR(28:30), and D(0:31) to $\overline{BS}$ valid - As Requested by BST1 in the corresponding word in the UPM (MIN = $0.50 \times B1 - 2.00$ )             | 13.20  | —     | 10.50  | —     | 8.00   | —     | 5.60   | —     | ns   |
| B35b | A(0:31), BADDR(28:30), and D(0:31) to $\overline{BS}$ valid - as requested by control bit BST2 in the corresponding word in the UPM (MIN = $0.75 \times B1 - 2.00$ ) | 20.70  | —     | 16.70  | —     | 13.00  | —     | 9.40   | —     | ns   |
| B36  | A(0:31), BADDR(28:30), and D(0:31) to $\overline{GPL}$ valid as requested by control bit GxT4 in the corresponding word in the UPM (MIN = $0.25 \times B1 - 2.00$ )  | 5.60   | —     | 4.30   | —     | 3.00   | —     | 1.80   | —     | ns   |

Table 7. Bus Operation Timings (continued)

| Num | Characteristic                                                                         | 33 MHz |     | 40 MHz |     | 50 MHz |     | 66 MHz |     | Unit |
|-----|----------------------------------------------------------------------------------------|--------|-----|--------|-----|--------|-----|--------|-----|------|
|     |                                                                                        | Min    | Max | Min    | Max | Min    | Max | Min    | Max |      |
| B37 | UPWAIT valid to CLKOUT falling edge <sup>12</sup> (MIN = 0.00 x B1 + 6.00)             | 6.00   | —   | 6.00   | —   | 6.00   | —   | 6.00   | —   | ns   |
| B38 | CLKOUT falling edge to UPGATE valid <sup>12</sup> (MIN = 0.00 x B1 + 1.00)             | 1.00   | —   | 1.00   | —   | 1.00   | —   | 1.00   | —   | ns   |
| B39 | $\overline{AS}$ valid to CLKOUT rising edge <sup>13</sup> (MIN = 0.00 x B1 + 7.00)     | 7.00   | —   | 7.00   | —   | 7.00   | —   | 7.00   | —   | ns   |
| B40 | A(0:31), TSIZ(0:1), RD/WR, BURST, valid to CLKOUT rising edge (MIN = 0.00 x B1 + 7.00) | 7.00   | —   | 7.00   | —   | 7.00   | —   | 7.00   | —   | ns   |
| B41 | $\overline{TS}$ valid to CLKOUT rising edge (setup time) (MIN = 0.00 x B1 + 7.00)      | 7.00   | —   | 7.00   | —   | 7.00   | —   | 7.00   | —   | ns   |
| B42 | CLKOUT rising edge to $\overline{TS}$ valid (hold time) (MIN = 0.00 x B1 + 2.00)       | 2.00   | —   | 2.00   | —   | 2.00   | —   | 2.00   | —   | ns   |
| B43 | $\overline{AS}$ negation to memory controller signals negation (MAX = TBD)             | —      | TBD | —      | TBD | —      | TBD | —      | TBD | ns   |

<sup>1</sup> Phase and frequency jitter performance results are only valid if the input jitter is less than the prescribed value.

<sup>2</sup> If the rate of change of the frequency of EXTAL is slow (i.e. it does not jump between the minimum and maximum values in one cycle) or the frequency of the jitter is fast (i.e., it does not stay at an extreme value for a long time) then the maximum allowed jitter on EXTAL can be up to 2%.

<sup>3</sup> The timings specified in B4 and B5 are based on full strength clock.

<sup>4</sup> The timing for  $\overline{BR}$  output is relevant when the MPC862/857T/857DSL is selected to work with external bus arbiter. The timing for  $\overline{BG}$  output is relevant when the MPC862/857T/857DSL is selected to work with internal bus arbiter.

<sup>5</sup> For part speeds above 50MHz, use 9.80ns for B11a.

<sup>6</sup> The timing required for  $\overline{BR}$  input is relevant when the MPC862/857T/857DSL is selected to work with internal bus arbiter. The timing for  $\overline{BG}$  input is relevant when the MPC862/857T/857DSL is selected to work with external bus arbiter.

<sup>7</sup> For part speeds above 50MHz, use 2ns for B17.

<sup>8</sup> The D(0:31) and DP(0:3) input timings B18 and B19 refer to the rising edge of the CLKOUT in which the  $\overline{TA}$  input signal is asserted.

<sup>9</sup> For part speeds above 50MHz, use 2ns for B19.

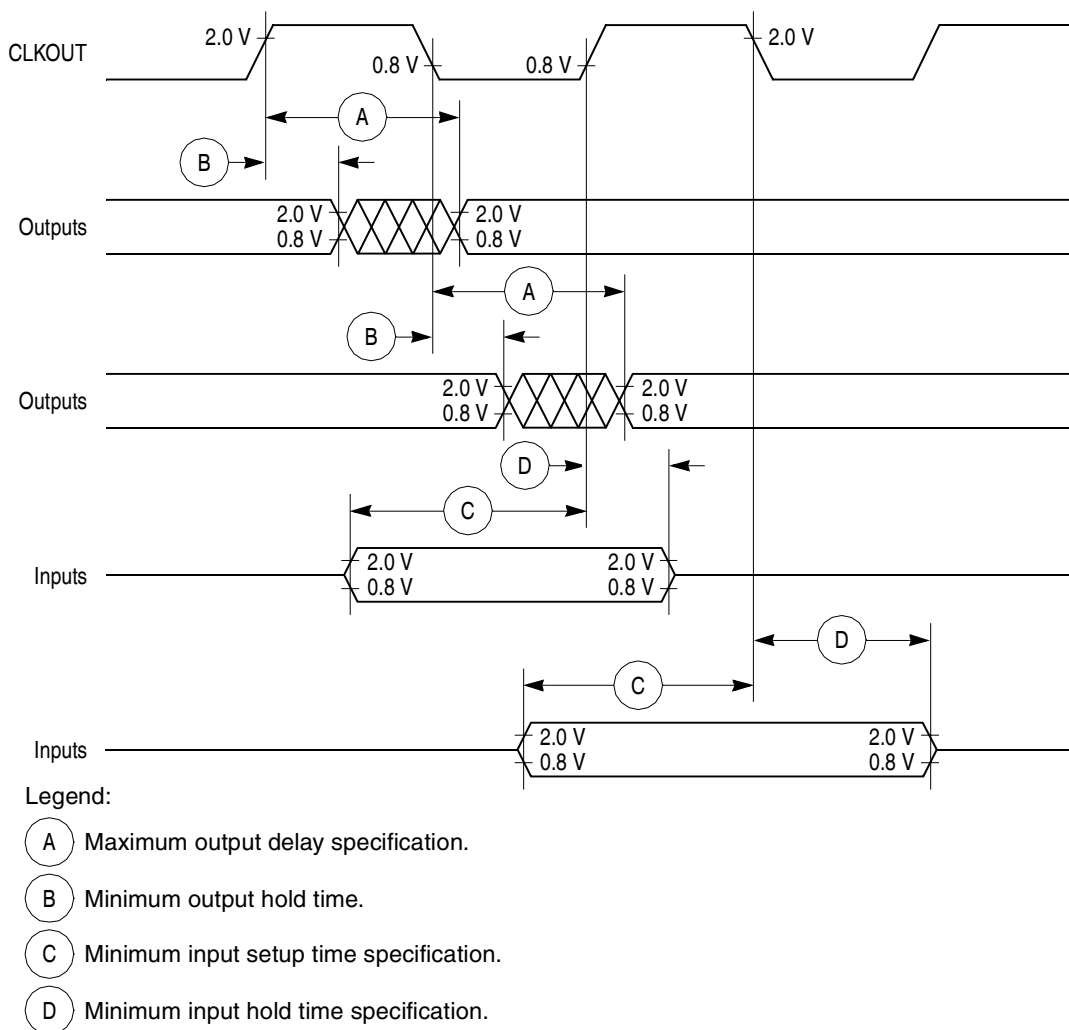
<sup>10</sup> The D(0:31) and DP(0:3) input timings B20 and B21 refer to the falling edge of the CLKOUT. This timing is valid only for read accesses controlled by chip-selects under control of the UPM in the memory controller, for data beats where DLT3 = 1 in the UPM RAM words. (This is only the case where data is latched on the falling edge of CLKOUT.)

<sup>11</sup> The timing B30 refers to  $\overline{CS}$  when ACS = 00 and to  $\overline{WE}(0:3)$  when CSNT = 0.

<sup>12</sup> The signal UPGATE is considered asynchronous to the CLKOUT and synchronized internally. The timings specified in B37 and B38 are specified to enable the freeze of the UPM output signals as described in Figure 19.

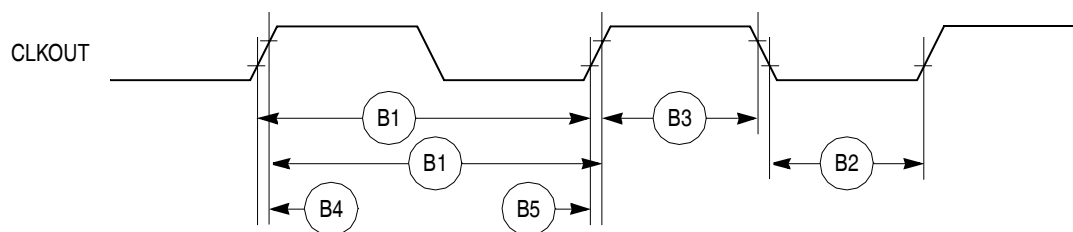
<sup>13</sup> The  $\overline{AS}$  signal is considered asynchronous to the CLKOUT. The timing B39 is specified in order to allow the behavior specified in Figure 22.

Figure 4 is the control timing diagram.



**Figure 4. Control Timing**

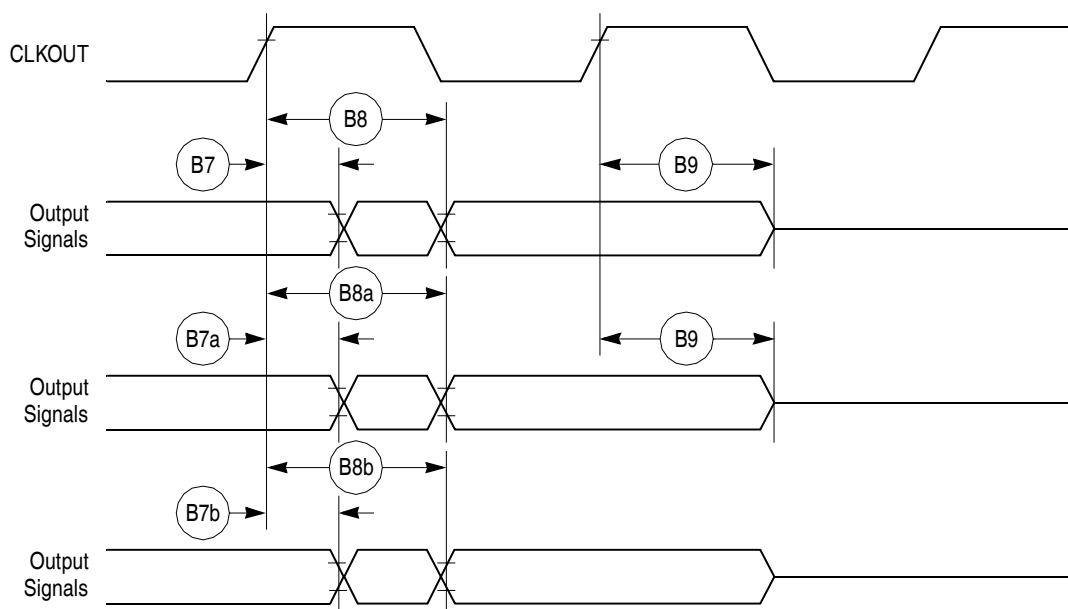
Figure 5 provides the timing for the external clock.



**Figure 5. External Clock Timing**

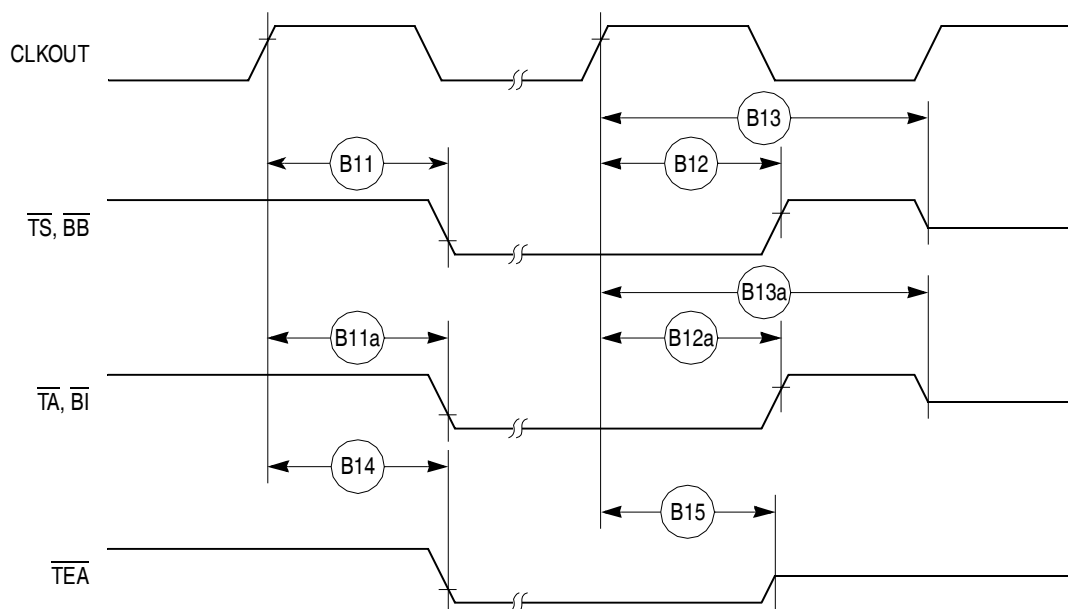


Figure 6 provides the timing for the synchronous output signals.



**Figure 6. Synchronous Output Signals Timing**

Figure 7 provides the timing for the synchronous active pull-up and open-drain output signals.



**Figure 7. Synchronous Active Pull-Up Resistor and Open-Drain Outputs Signals Timing**

Figure 8 provides the timing for the synchronous input signals.

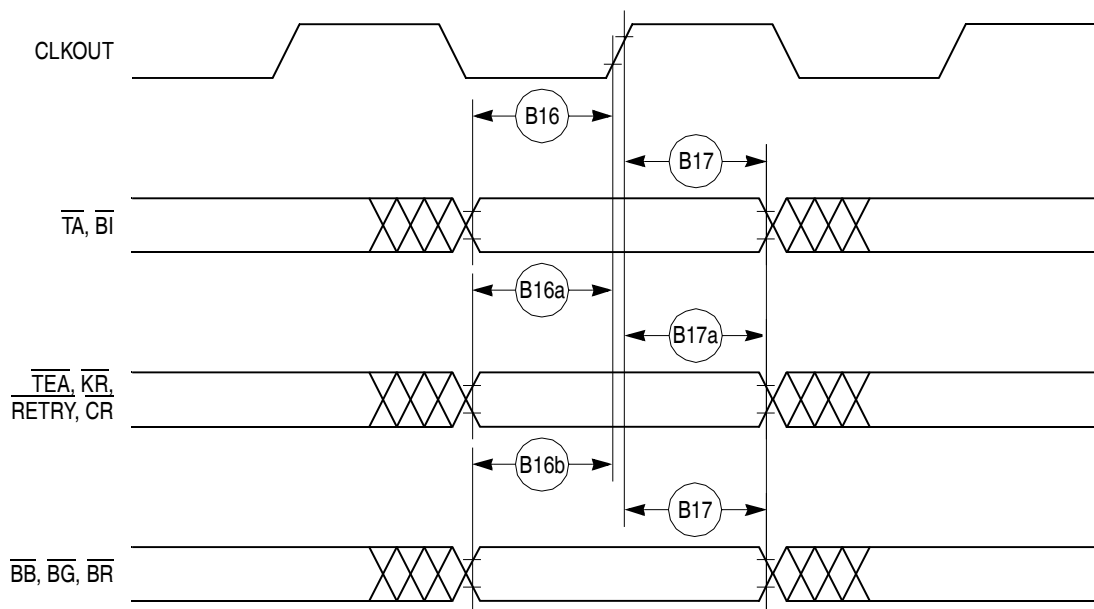


Figure 8. Synchronous Input Signals Timing

Figure 9 provides normal case timing for input data. It also applies to normal read accesses under the control of the UPM in the memory controller.

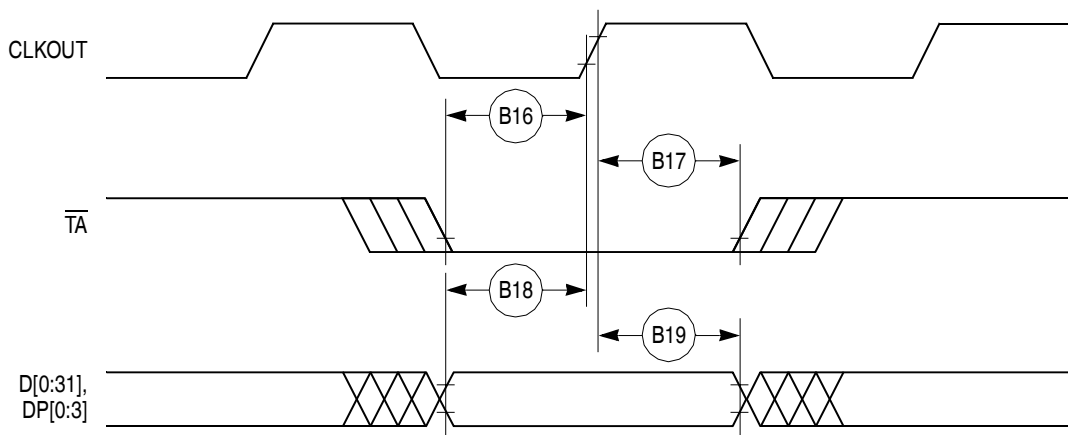
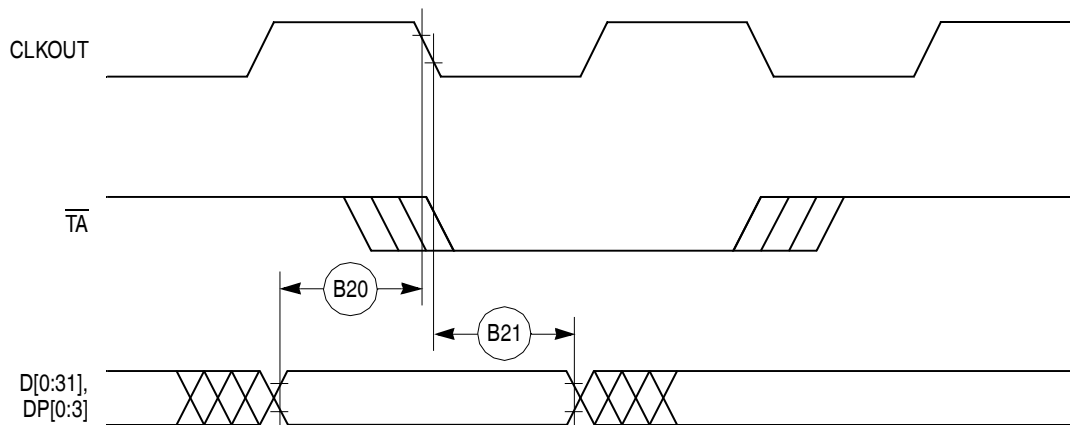


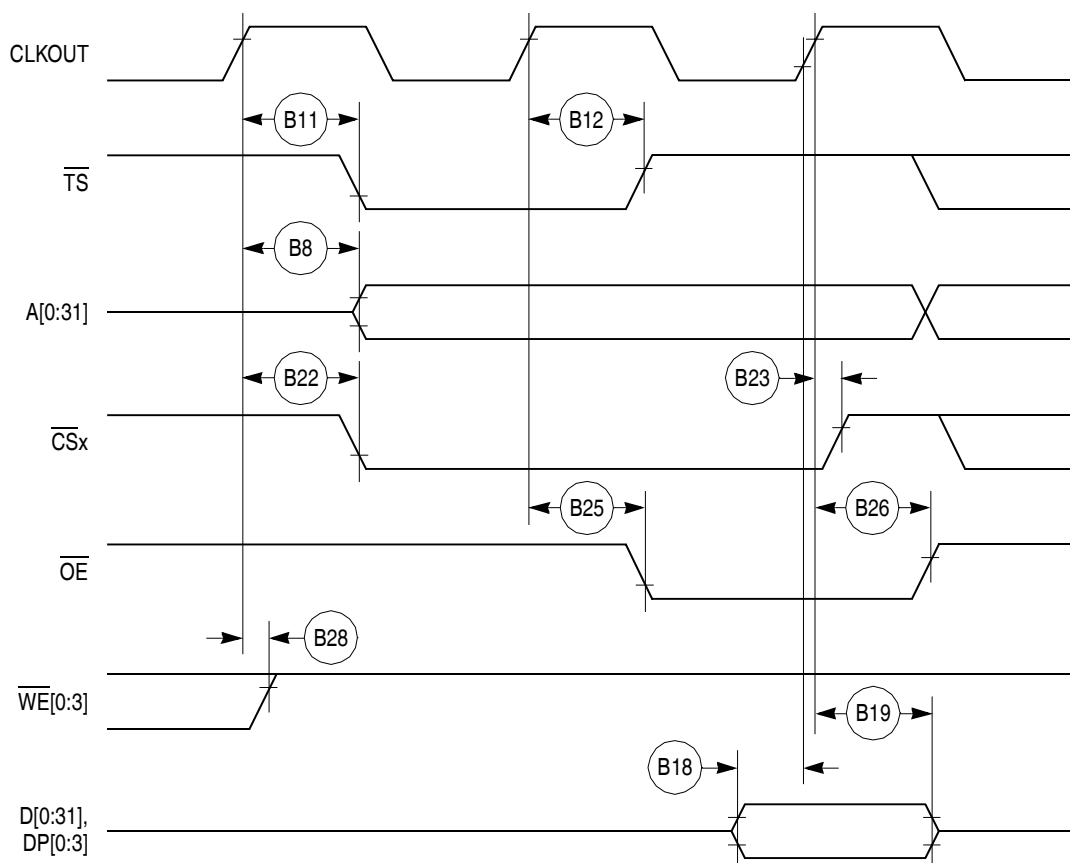
Figure 9. Input Data Timing in Normal Case

Figure 10 provides the timing for the input data controlled by the UPM for data beats where DLT3 = 1 in the UPM RAM words. (This is only the case where data is latched on the falling edge of CLKOUT.)



**Figure 10. Input Data Timing when Controlled by UPM in the Memory Controller and DLT3 = 1**

Figure 11 through Figure 14 provide the timing for the external bus read controlled by various GPCM factors.



**Figure 11. External Bus Read Timing (GPCM Controlled—ACS = 00)**

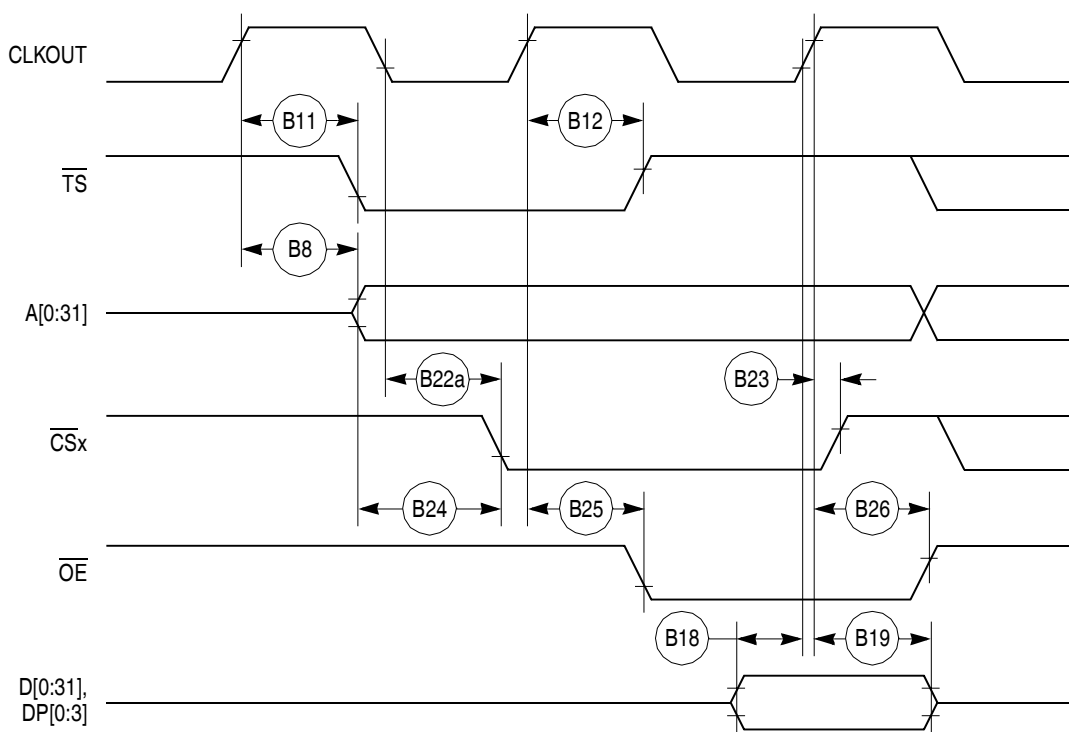


Figure 12. External Bus Read Timing (GPCM Controlled—TRLX = 0, ACS = 10)

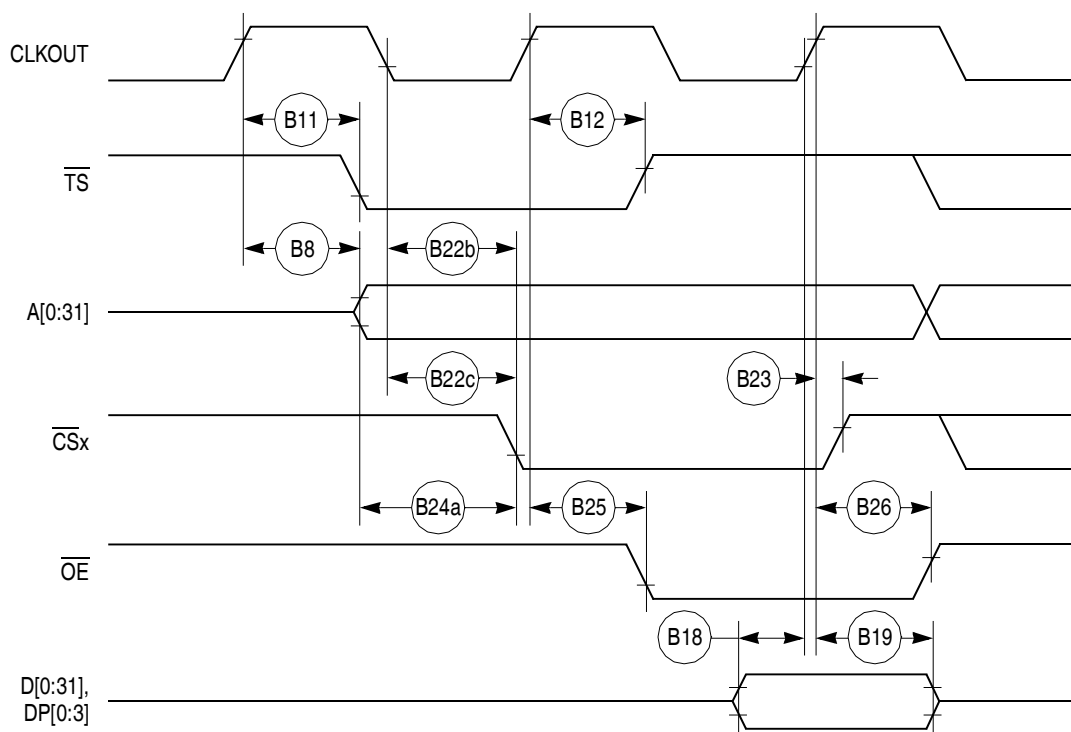
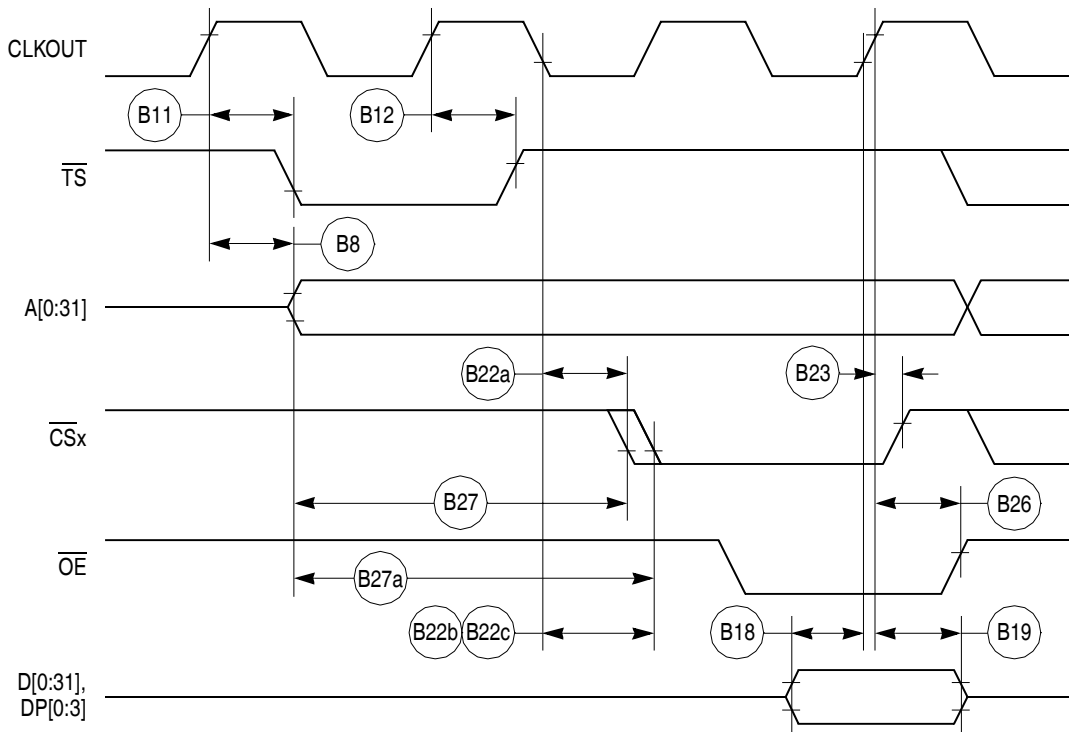


Figure 13. External Bus Read Timing (GPCM Controlled—TRLX = 0, ACS = 11)



**Figure 14. External Bus Read Timing (GPCM Controlled—TRLX = 1, ACS = 10, ACS = 11)**

Figure 15 through Figure 17 provide the timing for the external bus write controlled by various GPCM factors.

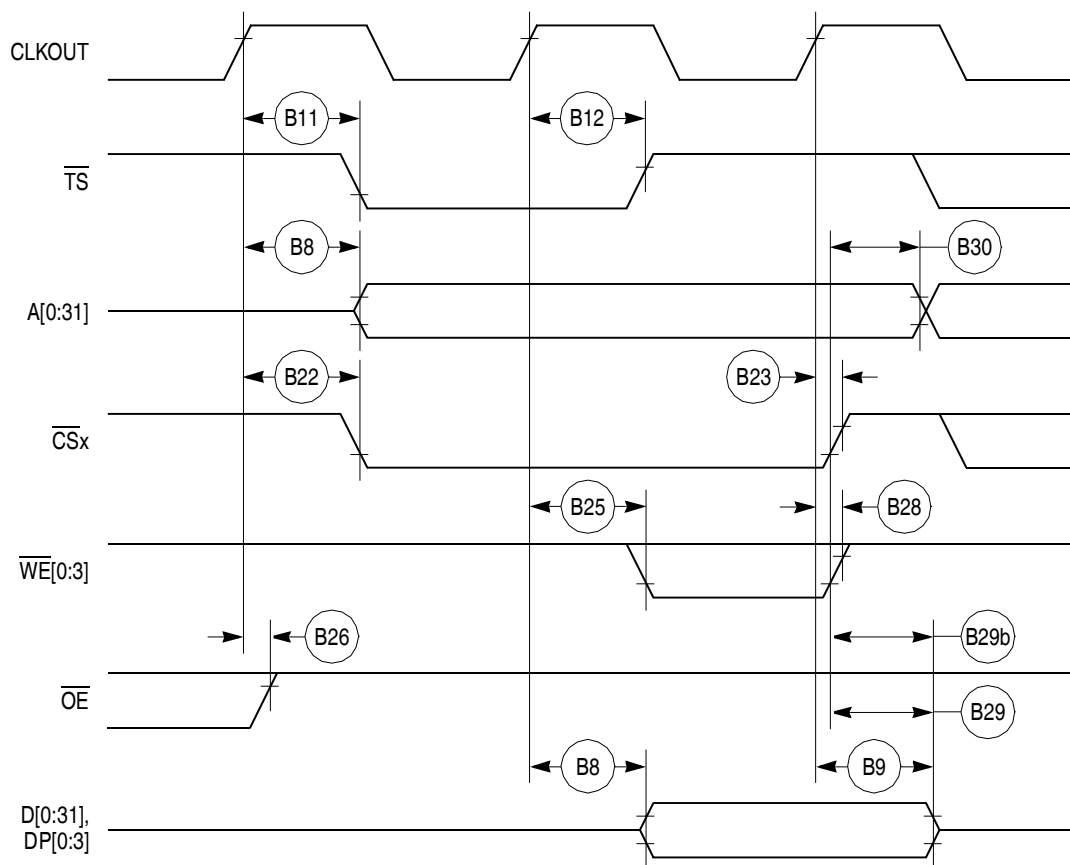
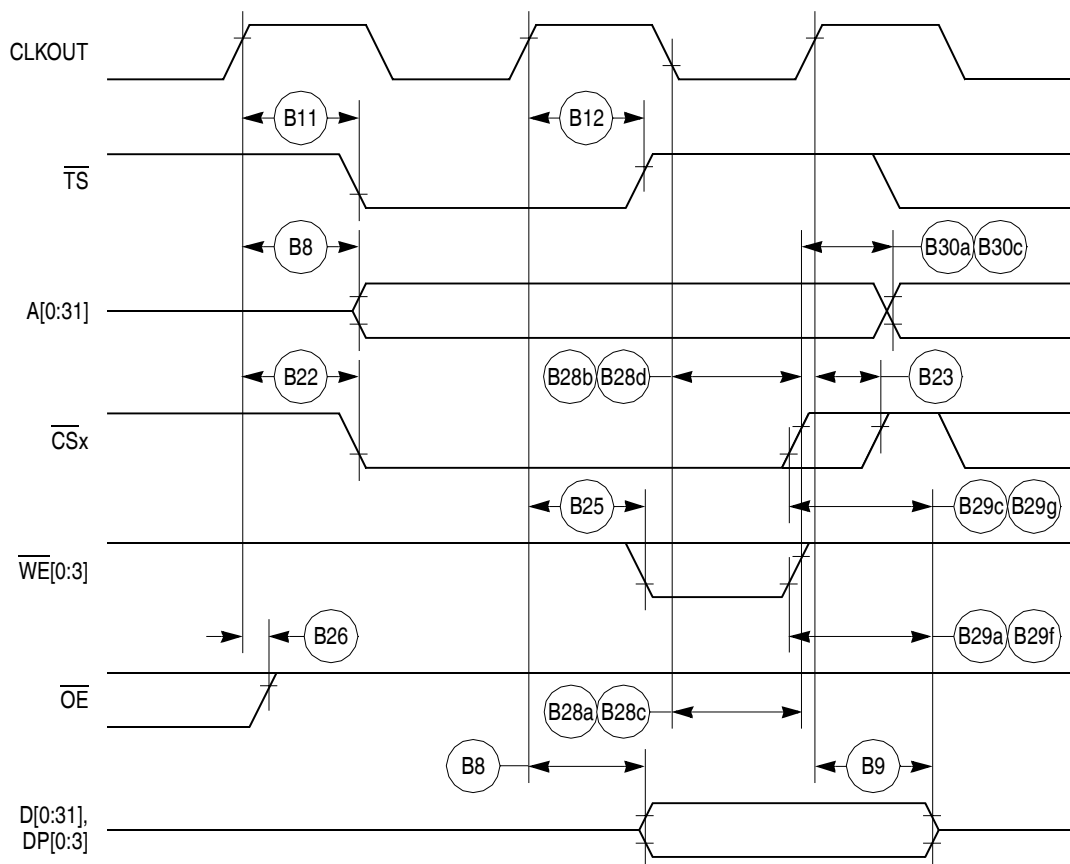


Figure 15. External Bus Write Timing (GPCM Controlled—TRLX = 0,1 CSNT = 0)



**Figure 16. External Bus Write Timing (GPCM Controlled—TRLX = 0,1 CSNT = 1)**

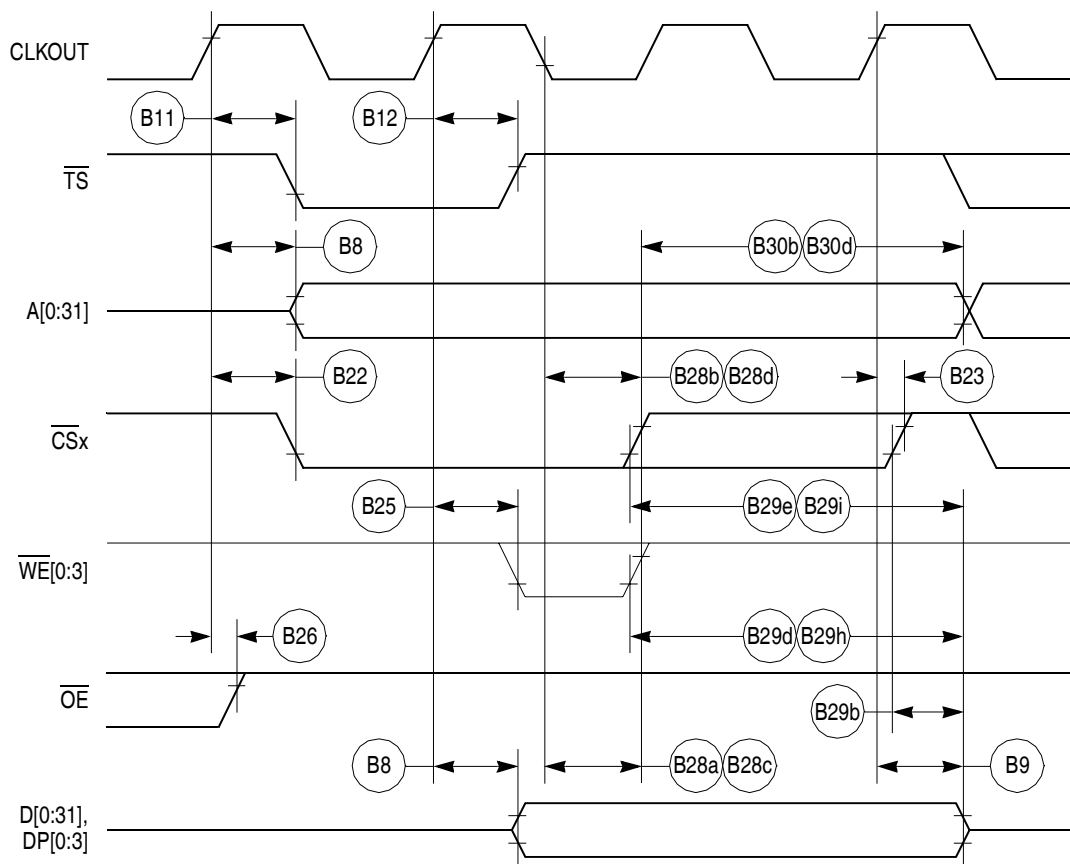


Figure 17. External Bus Write Timing (GPCM Controlled—TRLX = 0,1, CSNT = 1)



Figure 18 provides the timing for the external bus controlled by the UPM.

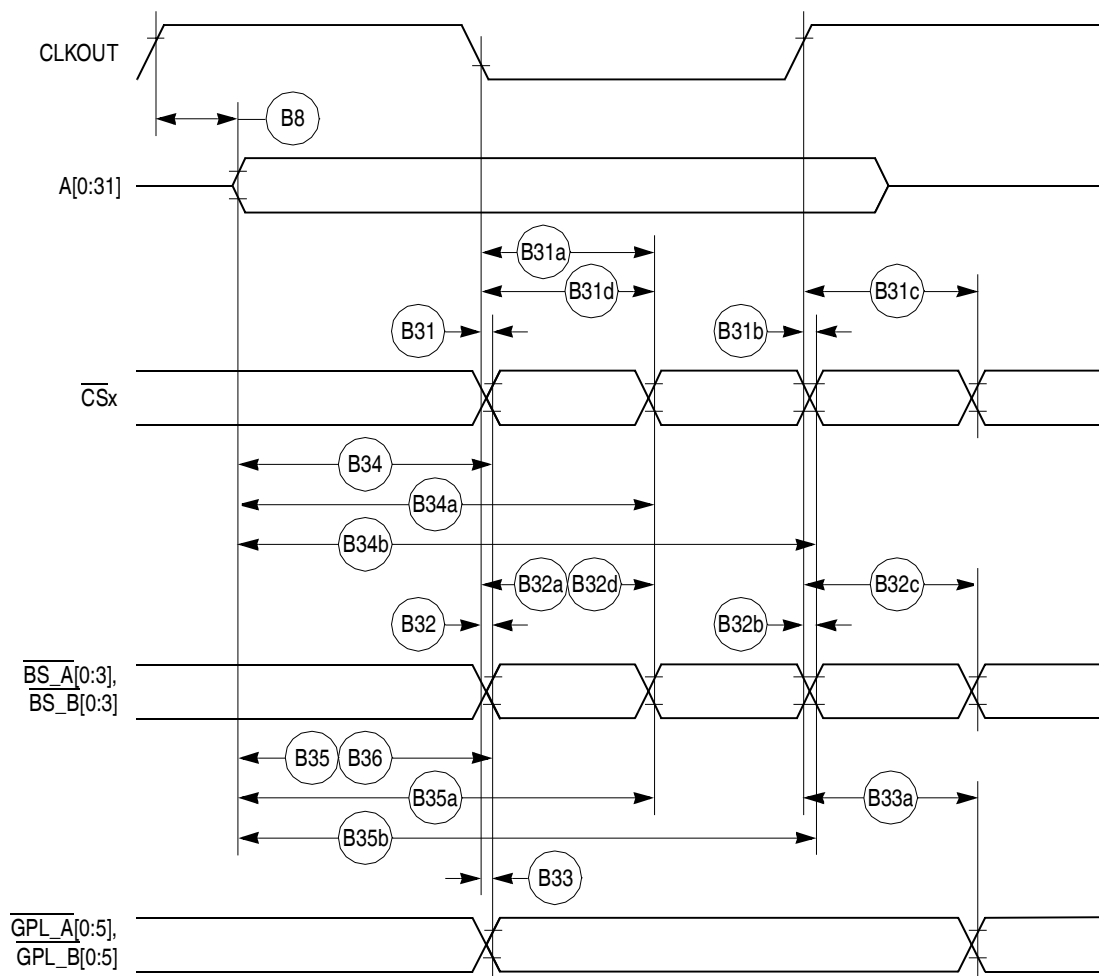
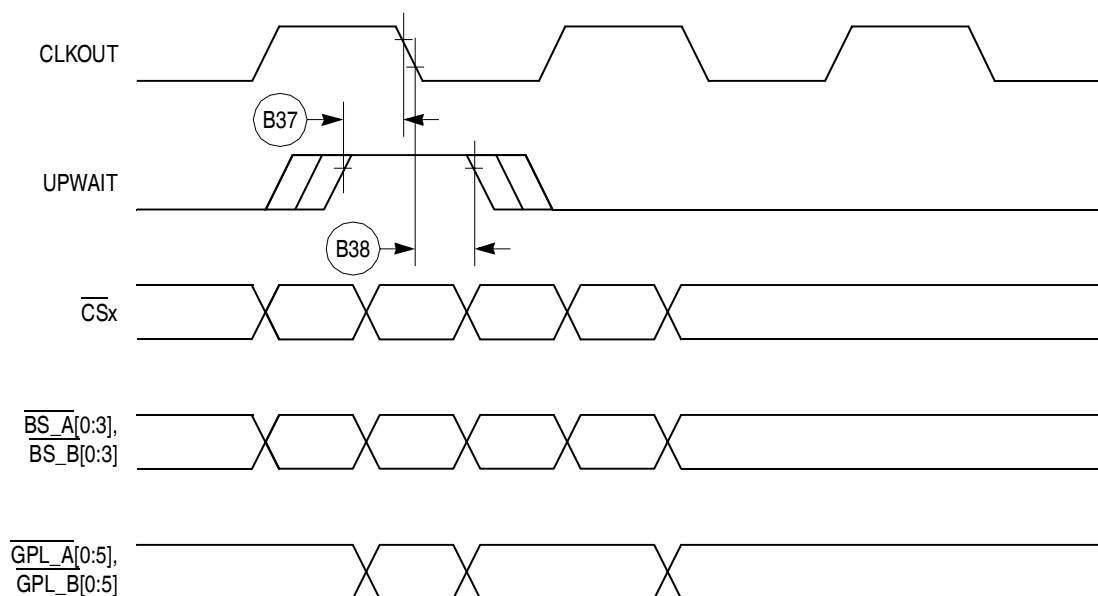


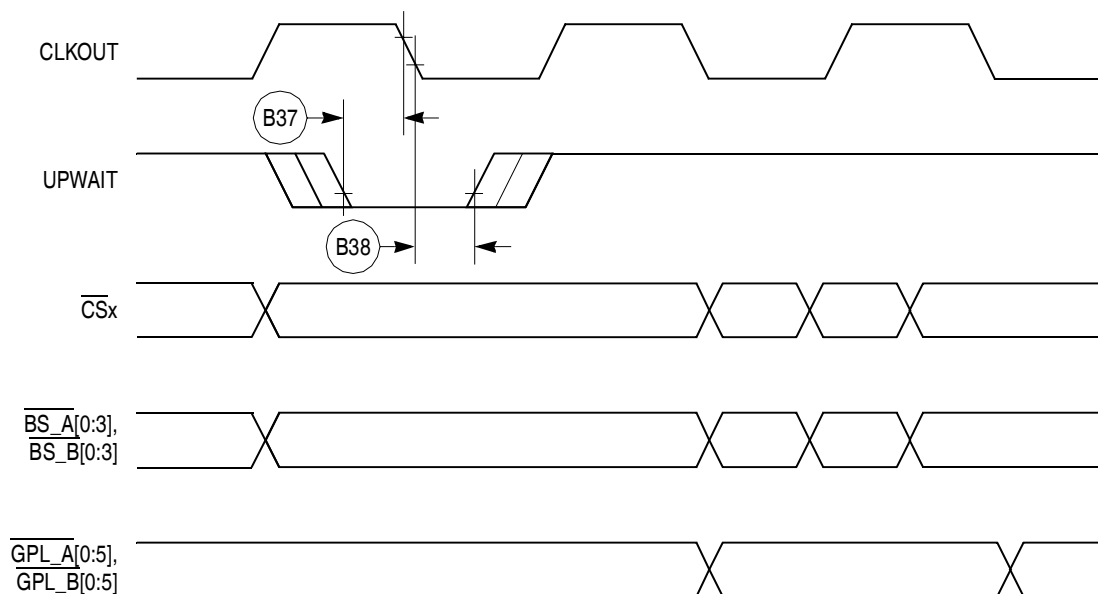
Figure 18. External Bus Timing (UPM Controlled Signals)

Figure 19 provides the timing for the asynchronous asserted UPWAIT signal controlled by the UPM.



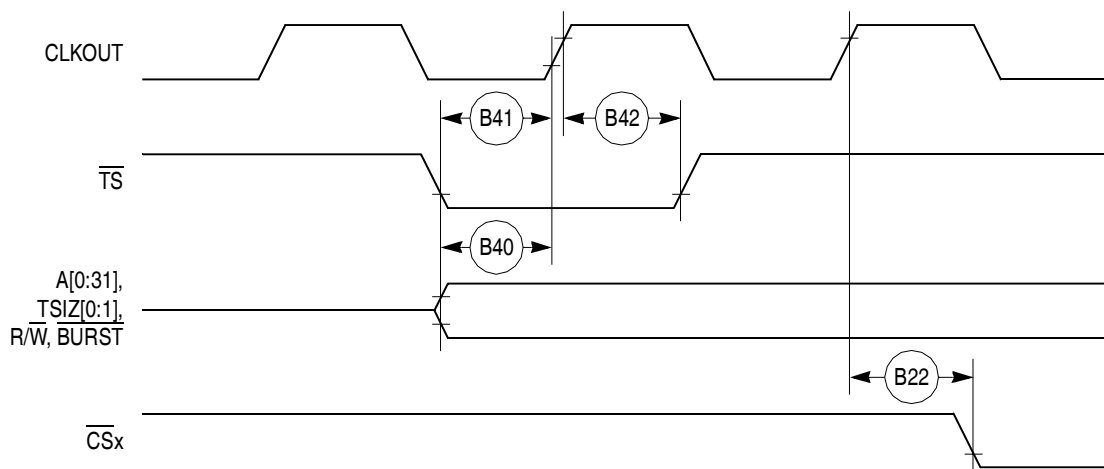
**Figure 19. Asynchronous UPWAIT Asserted Detection in UPM Handled Cycles Timing**

Figure 20 provides the timing for the asynchronous negated UPWAIT signal controlled by the UPM.



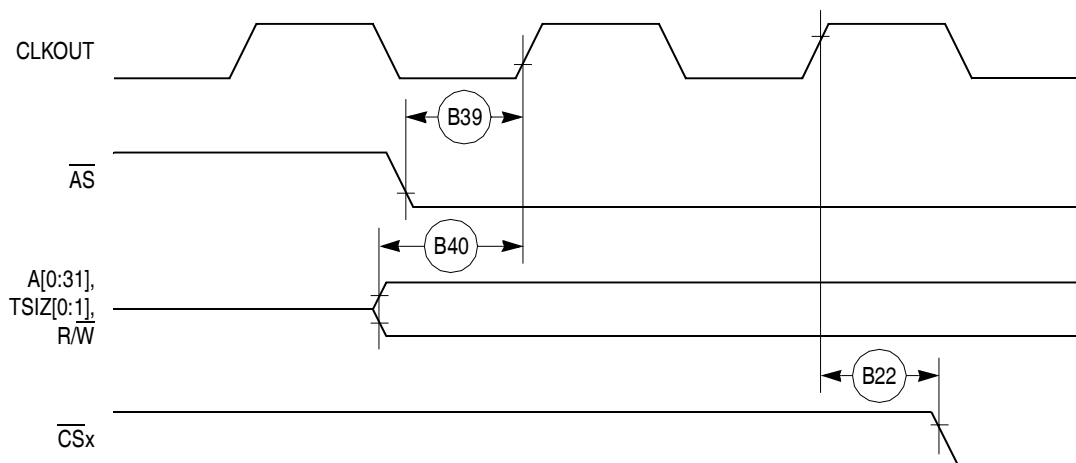
**Figure 20. Asynchronous UPWAIT Negated Detection in UPM Handled Cycles Timing**

Figure 21 provides the timing for the synchronous external master access controlled by the GPCM.



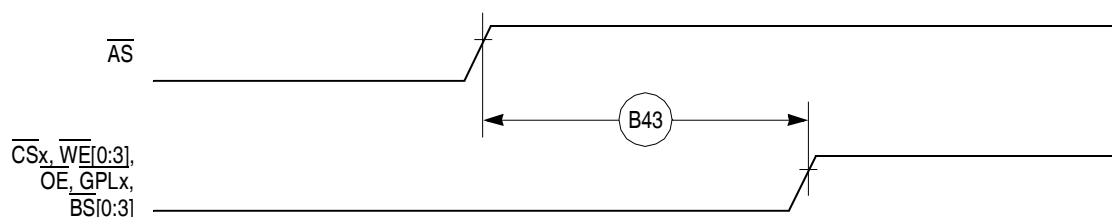
**Figure 21. Synchronous External Master Access Timing  
(GPCM Handled ACS = 00)**

Figure 22 provides the timing for the asynchronous external master memory access controlled by the GPCM.



**Figure 22. Asynchronous External Master Memory Access Timing  
(GPCM Controlled—ACS = 00)**

Figure 23 provides the timing for the asynchronous external master control signals negation.



**Figure 23. Asynchronous External Master—Control Signals Negation Timing**

Table 8 provides interrupt timing for the MPC862/857T/857DSL.

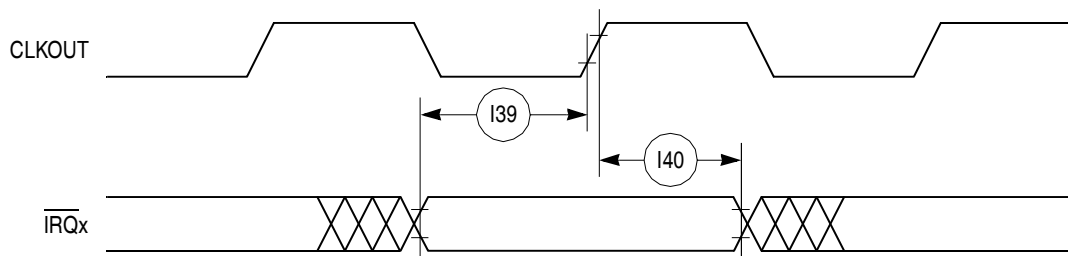
**Table 8. Interrupt Timing**

| Num | Characteristic <sup>1</sup>                                         | All Frequencies              |     | Unit |
|-----|---------------------------------------------------------------------|------------------------------|-----|------|
|     |                                                                     | Min                          | Max |      |
| I39 | $\overline{\text{IRQ}}_x$ valid to CLKOUT rising edge (set up time) | 6.00                         |     | ns   |
| I40 | $\overline{\text{IRQ}}_x$ hold time after CLKOUT                    | 2.00                         |     | ns   |
| I41 | $\overline{\text{IRQ}}_x$ pulse width low                           | 3.00                         |     | ns   |
| I42 | $\overline{\text{IRQ}}_x$ pulse width high                          | 3.00                         |     | ns   |
| I43 | $\overline{\text{IRQ}}_x$ edge-to-edge time                         | $4 \times T_{\text{CLKOUT}}$ |     | —    |

<sup>1</sup> The timings I39 and I40 describe the testing conditions under which the  $\overline{\text{IRQ}}$  lines are tested when being defined as level sensitive. The  $\overline{\text{IRQ}}$  lines are synchronized internally and do not have to be asserted or negated with reference to the CLKOUT.

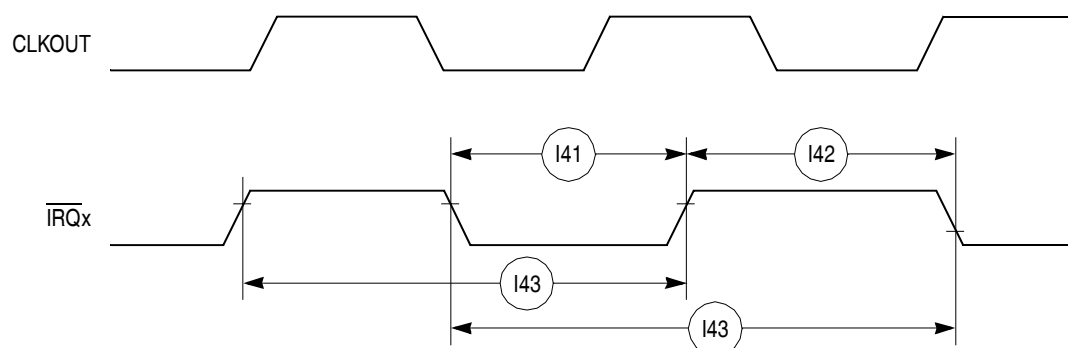
The timings I41, I42, and I43 are specified to allow the correct function of the  $\overline{\text{IRQ}}$  lines detection circuitry, and has no direct relation with the total system interrupt latency that the MPC862/857T/857DSL is able to support.

Figure 24 provides the interrupt detection timing for the external level-sensitive lines.



**Figure 24. Interrupt Detection Timing for External Level Sensitive Lines**

Figure 25 provides the interrupt detection timing for the external edge-sensitive lines.



**Figure 25. Interrupt Detection Timing for External Edge Sensitive Lines**

Table 9 shows the PCMCIA timing for the MPC862/857T/857DSL.

**Table 9. PCMCIA Timing**

| Num | Characteristic                                                                                                                                             | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|     |                                                                                                                                                            | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| P44 | A(0:31), $\overline{\text{REG}}$ valid to PCMCIA Strobe asserted. <sup>1</sup> (MIN = 0.75 x B1 - 2.00)                                                    | 20.70  | —     | 16.70  | —     | 13.00  | —     | 9.40   | —     | ns   |
| P45 | A(0:31), $\overline{\text{REG}}$ valid to ALE negation. <sup>1</sup> (MIN = 1.00 x B1 - 2.00)                                                              | 28.30  | —     | 23.00  | —     | 18.00  | —     | 13.20  | —     | ns   |
| P46 | CLKOUT to $\overline{\text{REG}}$ valid (MAX = 0.25 x B1 + 8.00)                                                                                           | 7.60   | 15.60 | 6.30   | 14.30 | 5.00   | 13.00 | 3.80   | 11.80 | ns   |
| P47 | CLKOUT to $\overline{\text{REG}}$ Invalid. (MIN = 0.25 x B1 + 1.00)                                                                                        | 8.60   | —     | 7.30   | —     | 6.00   | —     | 4.80   | —     | ns   |
| P48 | CLKOUT to $\overline{\text{CE1}}$ , $\overline{\text{CE2}}$ asserted. (MAX = 0.25 x B1 + 8.00)                                                             | 7.60   | 15.60 | 6.30   | 14.30 | 5.00   | 13.00 | 3.80   | 11.80 | ns   |
| P49 | CLKOUT to $\overline{\text{CE1}}$ , $\overline{\text{CE2}}$ negated. (MAX = 0.25 x B1 + 8.00)                                                              | 7.60   | 15.60 | 6.30   | 14.30 | 5.00   | 13.00 | 3.80   | 11.80 | ns   |
| P50 | CLKOUT to $\overline{\text{PCOE}}$ , $\overline{\text{IORD}}$ , $\overline{\text{PCWE}}$ , $\overline{\text{IOWR}}$ assert time. (MAX = 0.00 x B1 + 11.00) | —      | 11.00 | —      | 11.00 | —      | 11.00 | —      | 11.00 | ns   |
| P51 | CLKOUT to $\overline{\text{PCOE}}$ , $\overline{\text{IORD}}$ , $\overline{\text{PCWE}}$ , $\overline{\text{IOWR}}$ negate time. (MAX = 0.00 x B1 + 11.00) | 2.00   | 11.00 | 2.00   | 11.00 | 2.00   | 11.00 | 2.00   | 11.00 | ns   |
| P52 | CLKOUT to ALE assert time (MAX = 0.25 x B1 + 6.30)                                                                                                         | 7.60   | 13.80 | 6.30   | 12.50 | 5.00   | 11.30 | 3.80   | 10.00 | ns   |
| P53 | CLKOUT to ALE negate time (MAX = 0.25 x B1 + 8.00)                                                                                                         | —      | 15.60 | —      | 14.30 | —      | 13.00 | —      | 11.80 | ns   |
| P54 | $\overline{\text{PCWE}}$ , $\overline{\text{IOWR}}$ negated to D(0:31) invalid. <sup>1</sup> (MIN = 0.25 x B1 - 2.00)                                      | 5.60   | —     | 4.30   | —     | 3.00   | —     | 1.80   | —     | ns   |
| P55 | $\overline{\text{WAITA}}$ and $\overline{\text{WAITB}}$ valid to CLKOUT rising edge. <sup>1</sup> (MIN = 0.00 x B1 + 8.00)                                 | 8.00   | —     | 8.00   | —     | 8.00   | —     | 8.00   | —     | ns   |
| P56 | CLKOUT rising edge to $\overline{\text{WAITA}}$ and $\overline{\text{WAITB}}$ invalid. <sup>1</sup> (MIN = 0.00 x B1 + 2.00)                               | 2.00   | —     | 2.00   | —     | 2.00   | —     | 2.00   | —     | ns   |

<sup>1</sup> PSST = 1. Otherwise add PSST times cycle time.  
PSHT = 0. Otherwise add PSHT times cycle time.

These synchronous timings define when the  $\overline{\text{WAITx}}$  signals are detected in order to freeze (or relieve) the PCMCIA current cycle. The  $\overline{\text{WAITx}}$  assertion will be effective only if it is detected 2 cycles before the PSL timer expiration. See PCMCIA Interface in the *MPC862 PowerQUICC User's Manual*.

Figure 26 provides the PCMCIA access cycle timing for the external bus read.

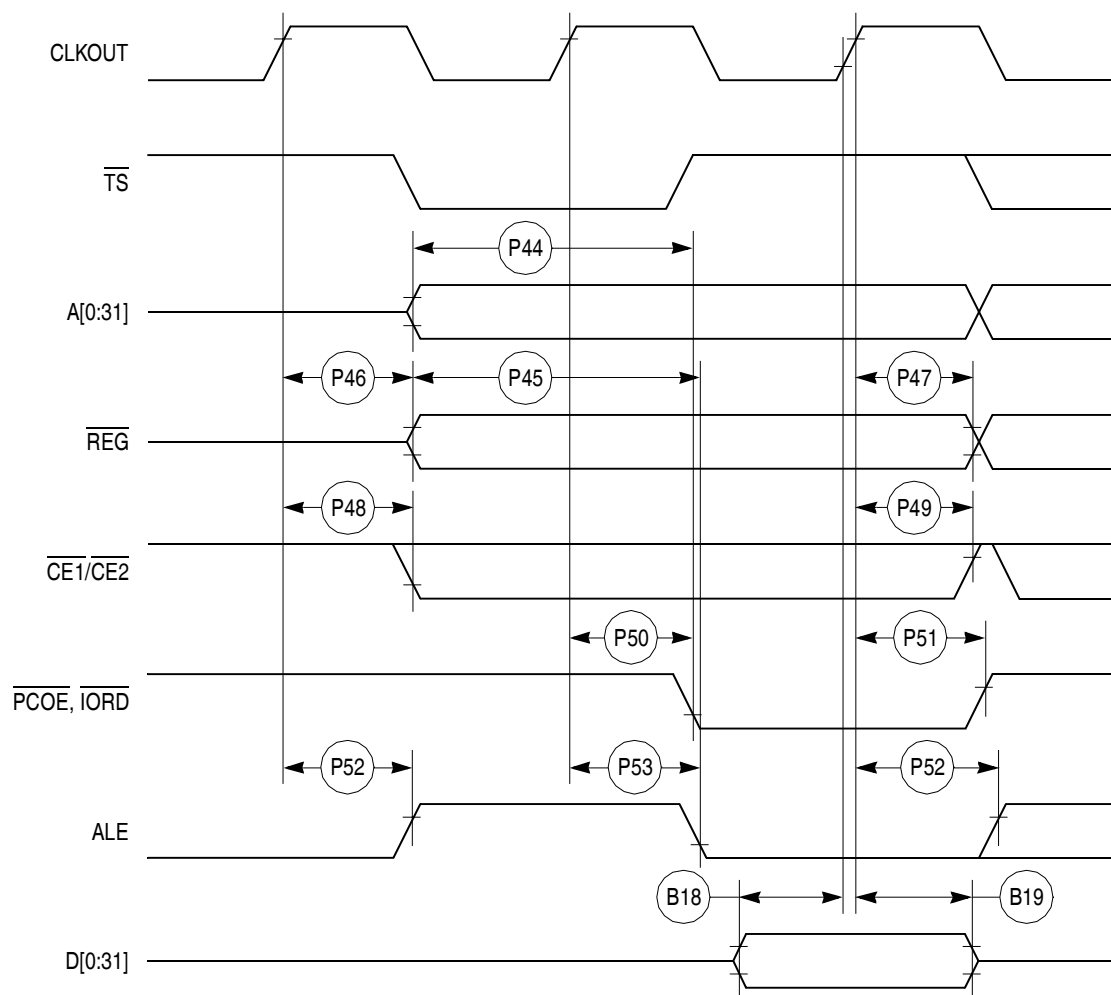


Figure 26. PCMCIA Access Cycles Timing External Bus Read

Figure 27 provides the PCMCIA access cycle timing for the external bus write.

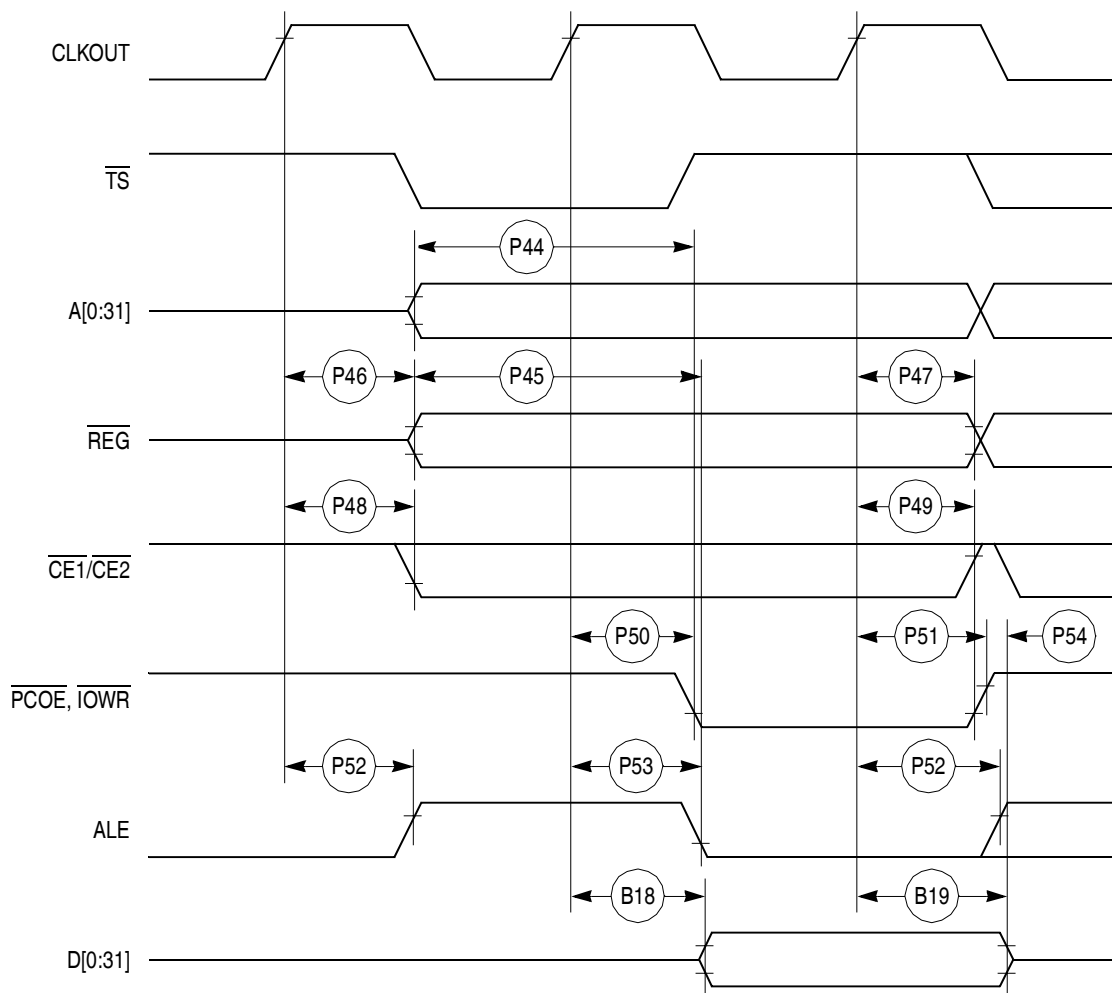


Figure 27. PCMCIA Access Cycles Timing External Bus Write

Figure 28 provides the PCMCIA  $\overline{WAIT}$  signals detection timing.

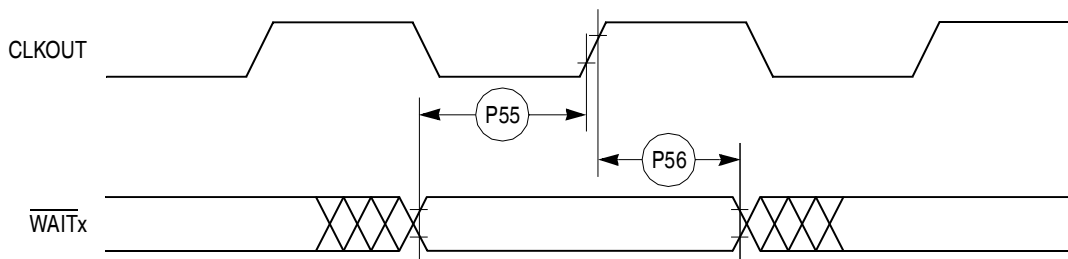


Figure 28. PCMCIA  $\overline{WAIT}$  Signals Detection Timing

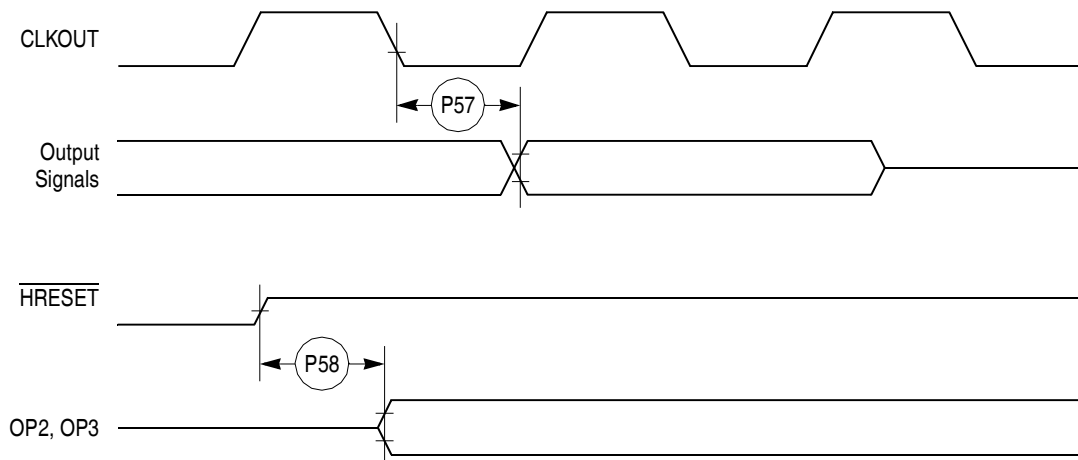
Table 10 shows the PCMCIA port timing for the MPC862/857T/857DSL.

**Table 10. PCMCIA Port Timing**

| Num | Characteristic                                                                                   | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|-----|--------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|     |                                                                                                  | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| P57 | CLKOUT to OPx Valid (MAX = $0.00 \times B1 + 19.00$ )                                            | —      | 19.00 | —      | 19.00 | —      | 19.00 | —      | 19.00 | ns   |
| P58 | $\overline{\text{HRESET}}$ negated to OPx drive <sup>1</sup><br>(MIN = $0.75 \times B1 + 3.00$ ) | 25.70  | —     | 21.70  | —     | 18.00  | —     | 14.40  | —     | ns   |
| P59 | IP_Xx valid to CLKOUT rising edge<br>(MIN = $0.00 \times B1 + 5.00$ )                            | 5.00   | —     | 5.00   | —     | 5.00   | —     | 5.00   | —     | ns   |
| P60 | CLKOUT rising edge to IP_Xx invalid<br>(MIN = $0.00 \times B1 + 1.00$ )                          | 1.00   | —     | 1.00   | —     | 1.00   | —     | 1.00   | —     | ns   |

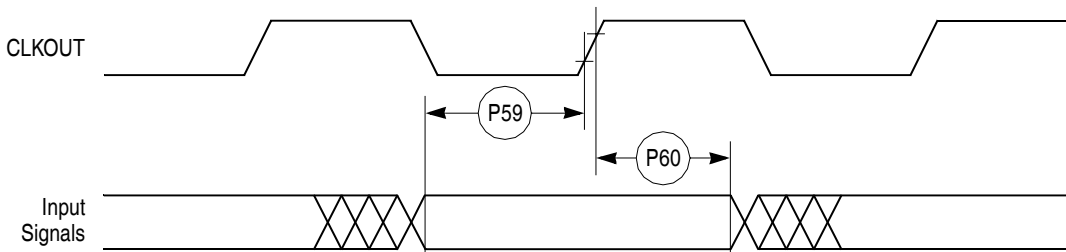
<sup>1</sup> OP2 and OP3 only.

Figure 29 provides the PCMCIA output port timing for the MPC862/857T/857DSL.



**Figure 29. PCMCIA Output Port Timing**

Figure 30 provides the PCMCIA output port timing for the MPC862/857T/857DSL.



**Figure 30. PCMCIA Input Port Timing**

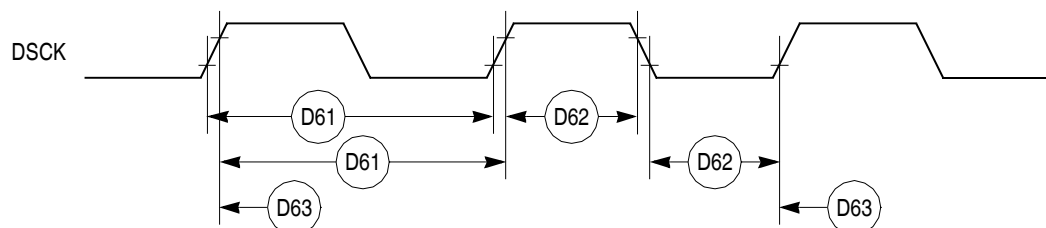


Table 11 shows the debug port timing for the MPC862/857T/857DSL.

**Table 11. Debug Port Timing**

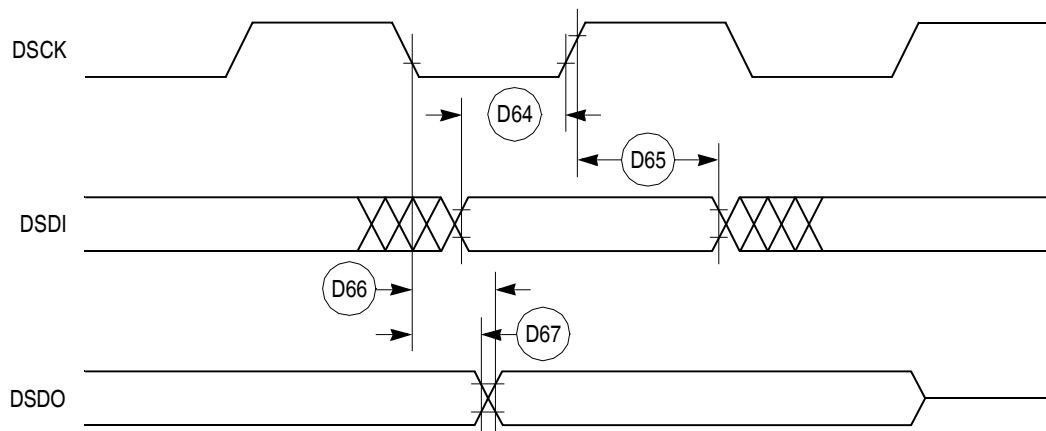
| Num | Characteristic              | All Frequencies                   |       | Unit |
|-----|-----------------------------|-----------------------------------|-------|------|
|     |                             | Min                               | Max   |      |
| D61 | DSCK cycle time             | $3 \times T_{\text{CLOCKOUT}}$    |       | -    |
| D62 | DSCK clock pulse width      | $1.25 \times T_{\text{CLOCKOUT}}$ |       | -    |
| D63 | DSCK rise and fall times    | 0.00                              | 3.00  | ns   |
| D64 | DSDI input data setup time  | 8.00                              |       | ns   |
| D65 | DSDI data hold time         | 5.00                              |       | ns   |
| D66 | DSCK low to DSDO data valid | 0.00                              | 15.00 | ns   |
| D67 | DSCK low to DSDO invalid    | 0.00                              | 2.00  | ns   |

Figure 31 provides the input timing for the debug port clock.



**Figure 31. Debug Port Clock Input Timing**

Figure 32 provides the timing for the debug port.



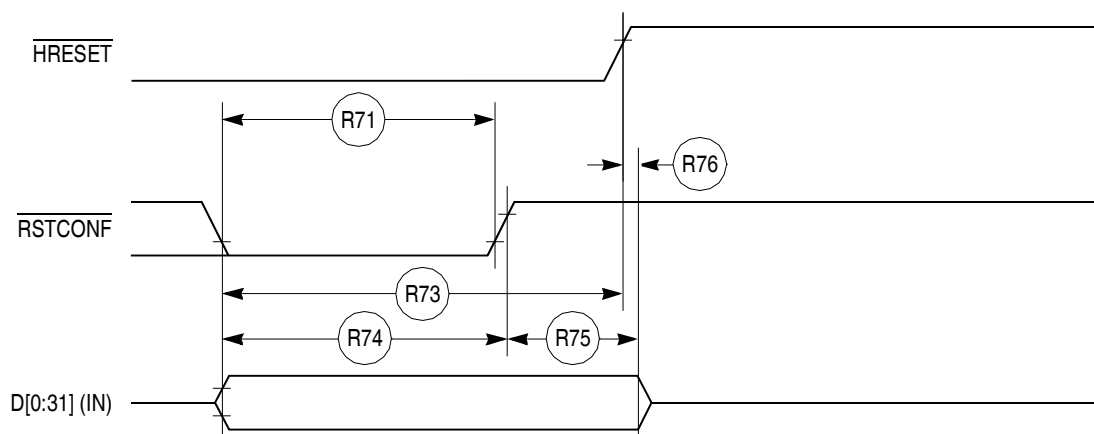
**Figure 32. Debug Port Timings**

Table 12 shows the reset timing for the MPC862/857T/857DSL.

**Table 12. Reset Timing**

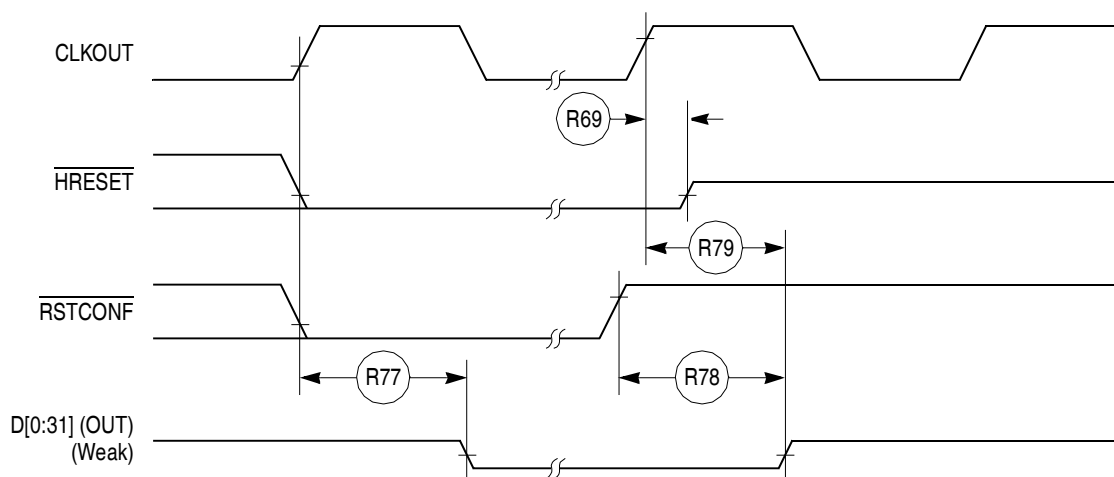
| Num | Characteristic                                                                                                                                     | 33 MHz |       | 40 MHz |       | 50 MHz |       | 66 MHz |       | Unit |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------|--------|-------|--------|-------|--------|-------|--------|-------|------|
|     |                                                                                                                                                    | Min    | Max   | Min    | Max   | Min    | Max   | Min    | Max   |      |
| R69 | CLKOUT to $\overline{\text{HRESET}}$ high impedance<br>(MAX = $0.00 \times B1 + 20.00$ )                                                           | —      | 20.00 | —      | 20.00 | —      | 20.00 | —      | 20.00 | ns   |
| R70 | CLKOUT to $\overline{\text{SRESET}}$ high impedance<br>(MAX = $0.00 \times B1 + 20.00$ )                                                           | —      | 20.00 | —      | 20.00 | —      | 20.00 | —      | 20.00 | ns   |
| R71 | $\overline{\text{RSTCONF}}$ pulse width<br>(MIN = $17.00 \times B1$ )                                                                              | 515.20 | —     | 425.00 | —     | 340.00 | —     | 257.60 | —     | ns   |
| R72 | —                                                                                                                                                  | —      | —     | —      | —     | —      | —     | —      | —     | —    |
| R73 | Configuration data to $\overline{\text{HRESET}}$ rising<br>edge set up time<br>(MIN = $15.00 \times B1 + 50.00$ )                                  | 504.50 | —     | 425.00 | —     | 350.00 | —     | 277.30 | —     | ns   |
| R74 | Configuration data to $\overline{\text{RSTCONF}}$ rising<br>edge set up time<br>(MIN = $0.00 \times B1 + 350.00$ )                                 | 350.00 | —     | 350.00 | —     | 350.00 | —     | 350.00 | —     | ns   |
| R75 | Configuration data hold time after<br>$\overline{\text{RSTCONF}}$ negation<br>(MIN = $0.00 \times B1 + 0.00$ )                                     | 0.00   | —     | 0.00   | —     | 0.00   | —     | 0.00   | —     | ns   |
| R76 | Configuration data hold time after<br>$\overline{\text{HRESET}}$ negation<br>(MIN = $0.00 \times B1 + 0.00$ )                                      | 0.00   | —     | 0.00   | —     | 0.00   | —     | 0.00   | —     | ns   |
| R77 | $\overline{\text{HRESET}}$ and $\overline{\text{RSTCONF}}$ asserted to<br>data out drive (MAX = $0.00 \times B1 + 25.00$ )                         | —      | 25.00 | —      | 25.00 | —      | 25.00 | —      | 25.00 | ns   |
| R78 | $\overline{\text{RSTCONF}}$ negated to data out high<br>impedance. (MAX = $0.00 \times B1 + 25.00$ )                                               | —      | 25.00 | —      | 25.00 | —      | 25.00 | —      | 25.00 | ns   |
| R79 | CLKOUT of last rising edge before chip<br>three-states $\overline{\text{HRESET}}$ to data out high<br>impedance. (MAX = $0.00 \times B1 + 25.00$ ) | —      | 25.00 | —      | 25.00 | —      | 25.00 | —      | 25.00 | ns   |
| R80 | DSDI, DSCK set up (MIN = $3.00 \times B1$ )                                                                                                        | 90.90  | —     | 75.00  | —     | 60.00  | —     | 45.50  | —     | ns   |
| R81 | DSDI, DSCK hold time<br>(MIN = $0.00 \times B1 + 0.00$ )                                                                                           | 0.00   | —     | 0.00   | —     | 0.00   | —     | 0.00   | —     | ns   |
| R82 | $\overline{\text{SRESET}}$ negated to CLKOUT rising<br>edge for DSDI and DSCK sample<br>(MIN = $8.00 \times B1$ )                                  | 242.40 | —     | 200.00 | —     | 160.00 | —     | 121.20 | —     | ns   |

Figure 33 shows the reset timing for the data bus configuration.



**Figure 33. Reset Timing—Configuration from Data Bus**

Figure 34 provides the reset timing for the data bus weak drive during configuration.



**Figure 34. Reset Timing—Data Bus Weak Drive during Configuration**

Figure 35 provides the reset timing for the debug port configuration.

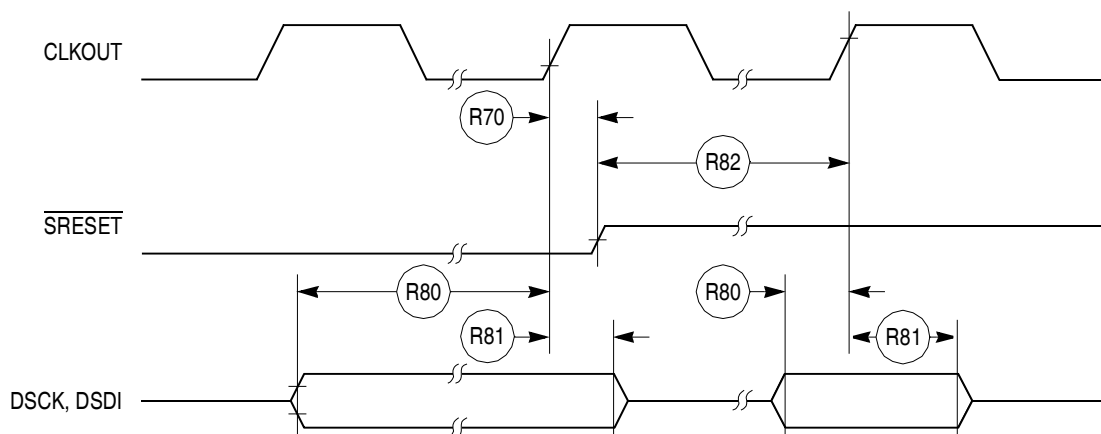


Figure 35. Reset Timing—Debug Port Configuration

## 10 IEEE 1149.1 Electrical Specifications

Table 13 provides the JTAG timings for the MPC862/857T/857DSL shown in Figure 36 through Figure 39.

Table 13. JTAG Timing

| Num | Characteristic                                         | All Frequencies |       | Unit |
|-----|--------------------------------------------------------|-----------------|-------|------|
|     |                                                        | Min             | Max   |      |
| J82 | TCK cycle time                                         | 100.00          | —     | ns   |
| J83 | TCK clock pulse width measured at 1.5 V                | 40.00           | —     | ns   |
| J84 | TCK rise and fall times                                | 0.00            | 10.00 | ns   |
| J85 | TMS, TDI data setup time                               | 5.00            | —     | ns   |
| J86 | TMS, TDI data hold time                                | 25.00           | —     | ns   |
| J87 | TCK low to TDO data valid                              | —               | 27.00 | ns   |
| J88 | TCK low to TDO data invalid                            | 0.00            | —     | ns   |
| J89 | TCK low to TDO high impedance                          | —               | 20.00 | ns   |
| J90 | $\overline{\text{TRST}}$ assert time                   | 100.00          | —     | ns   |
| J91 | $\overline{\text{TRST}}$ setup time to TCK low         | 40.00           | —     | ns   |
| J92 | TCK falling edge to output valid                       | —               | 50.00 | ns   |
| J93 | TCK falling edge to output valid out of high impedance | —               | 50.00 | ns   |
| J94 | TCK falling edge to output high impedance              | —               | 50.00 | ns   |
| J95 | Boundary scan input valid to TCK rising edge           | 50.00           | —     | ns   |
| J96 | TCK rising edge to boundary scan input invalid         | 50.00           | —     | ns   |

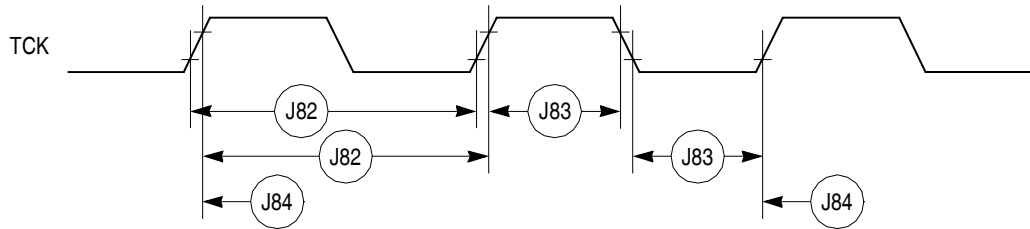


Figure 36. JTAG Test Clock Input Timing

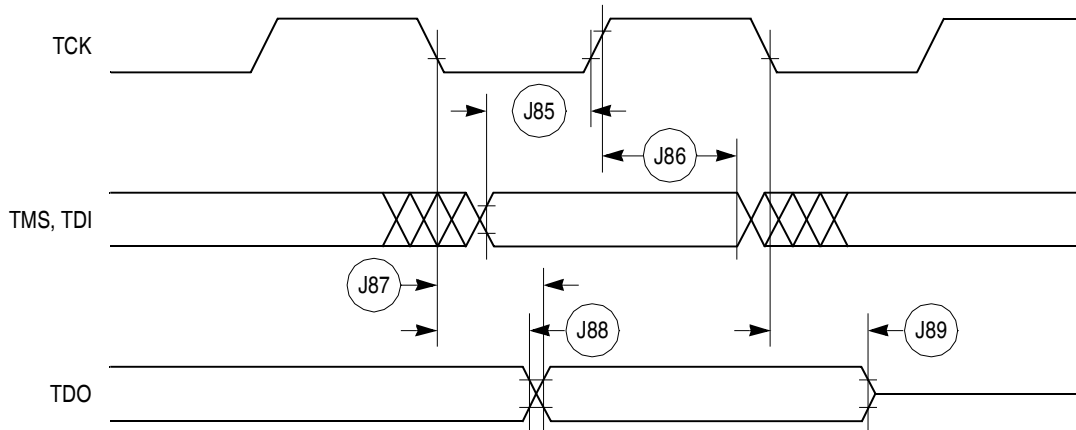


Figure 37. JTAG Test Access Port Timing Diagram

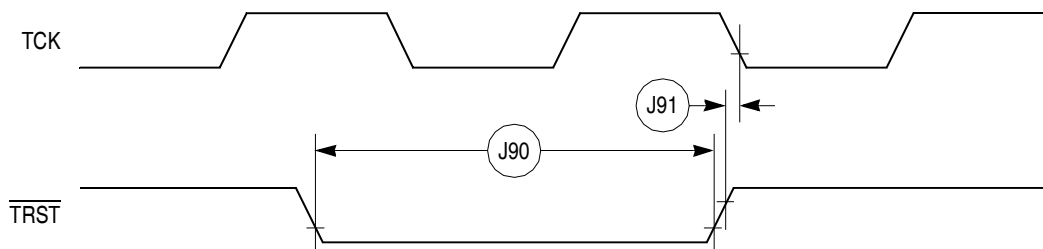
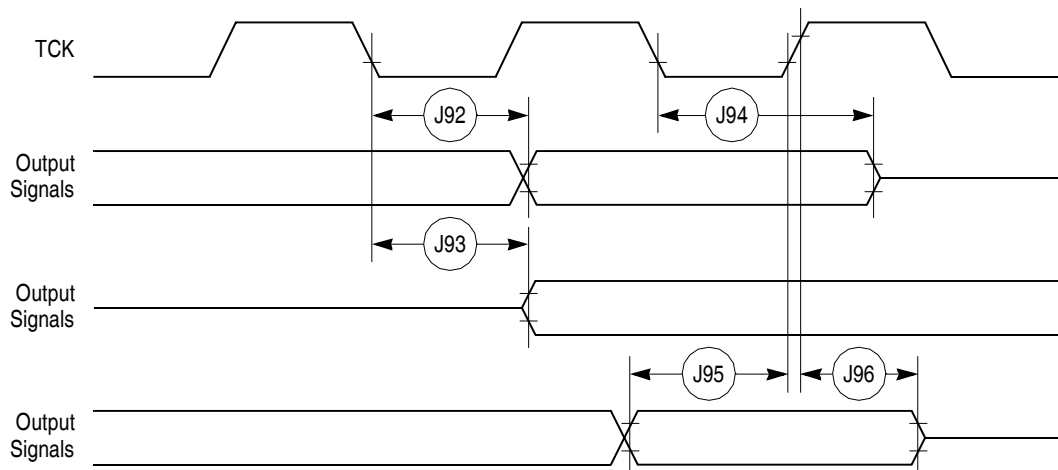
Figure 38. JTAG  $\overline{\text{TRST}}$  Timing Diagram

Figure 39. Boundary Scan (JTAG) Timing Diagram

## 11 CPM Electrical Characteristics

This section provides the AC and DC electrical specifications for the communications processor module (CPM) of the MPC862/857T/857DSL.

### 11.1 PIP/PIO AC Electrical Specifications

Table 14 provides the PIP/PIO AC timings as shown in Figure 40 through Figure 44.

Table 14. PIP/PIO Timing

| Num | Characteristic                                                       | All Frequencies |     | Unit |
|-----|----------------------------------------------------------------------|-----------------|-----|------|
|     |                                                                      | Min             | Max |      |
| 21  | Data-in setup time to STBI low                                       | 0               | —   | ns   |
| 22  | Data-in hold time to STBI high                                       | $2.5 - t_3^1$   | —   | clk  |
| 23  | STBI pulse width                                                     | 1.5             | —   | clk  |
| 24  | STBO pulse width                                                     | 1 clk – 5 ns    | —   | ns   |
| 25  | Data-out setup time to STBO low                                      | 2               | —   | clk  |
| 26  | Data-out hold time from STBO high                                    | 5               | —   | clk  |
| 27  | STBI low to STBO low (Rx interlock)                                  | —               | 2   | clk  |
| 28  | STBI low to STBO high (Tx interlock)                                 | 2               | —   | clk  |
| 29  | Data-in setup time to clock high                                     | 15              | —   | ns   |
| 30  | Data-in hold time from clock high                                    | 7.5             | —   | ns   |
| 31  | Clock low to data-out valid (CPU writes data, control, or direction) | —               | 25  | ns   |

<sup>1</sup>  $t_3$  = Specification 23

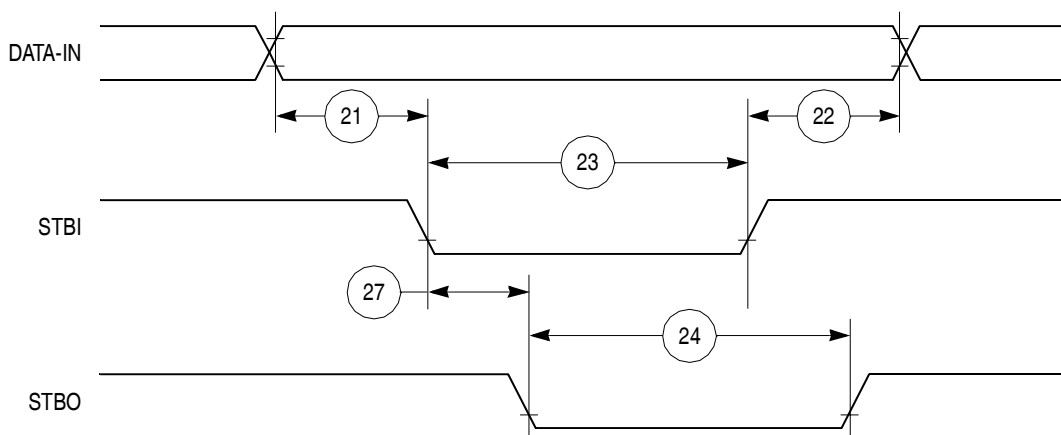


Figure 40. PIP Rx (Interlock Mode) Timing Diagram

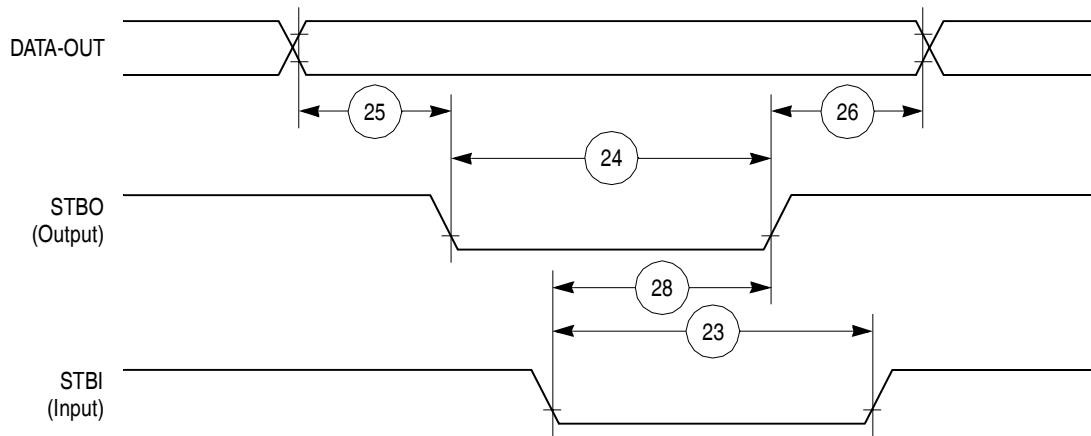


Figure 41. PIP Tx (Interlock Mode) Timing Diagram

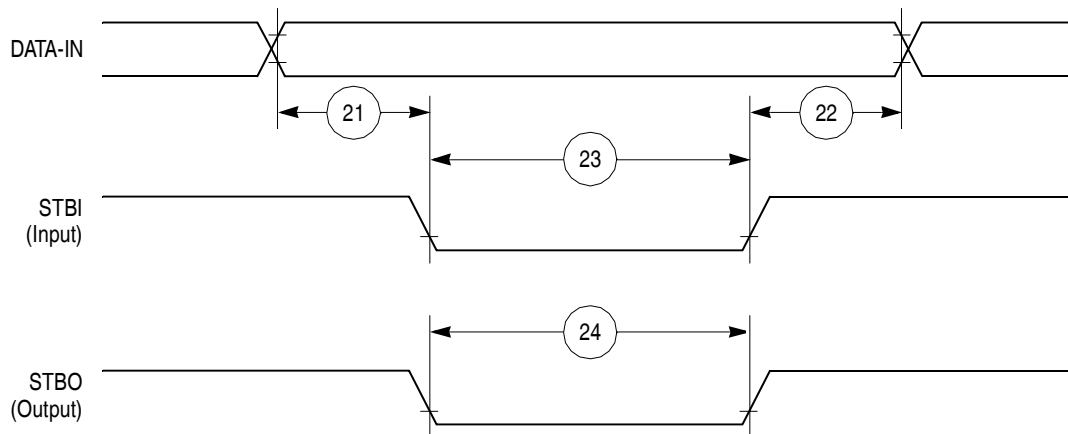


Figure 42. PIP Rx (Pulse Mode) Timing Diagram

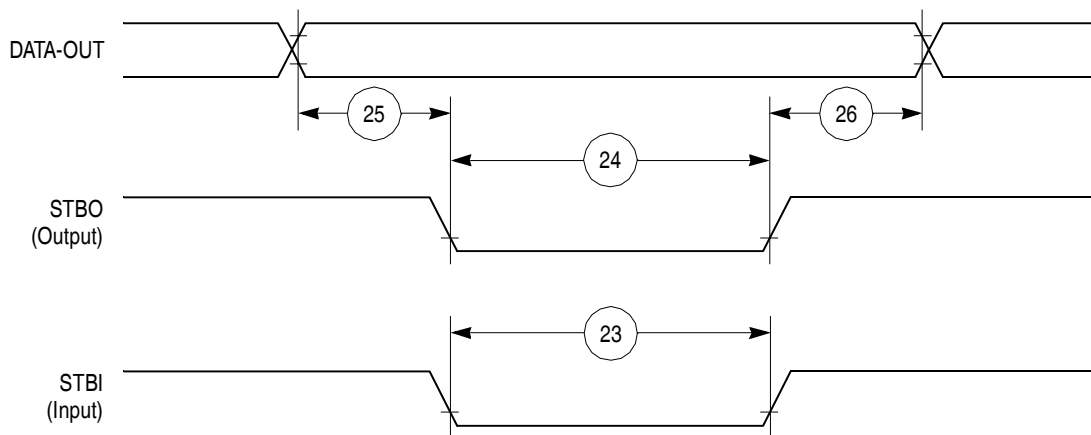


Figure 43. PIP TX (Pulse Mode) Timing Diagram

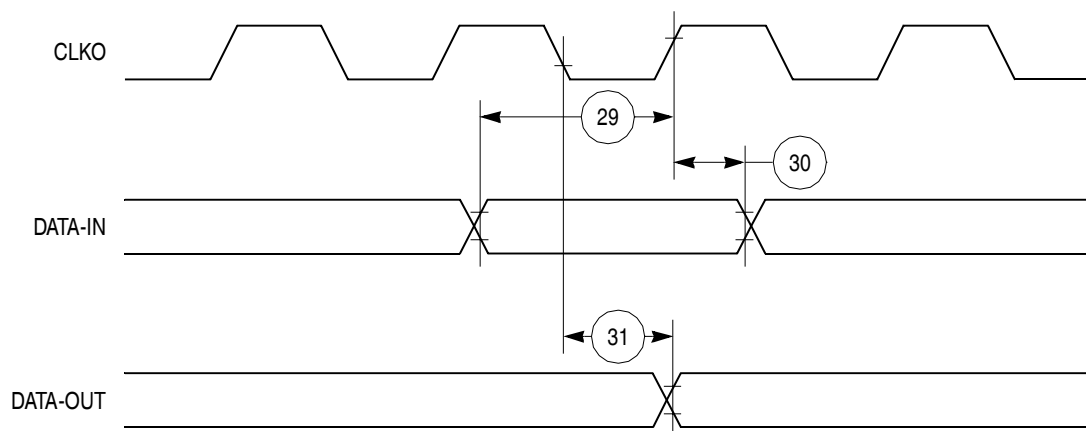


Figure 44. Parallel I/O Data-In/Data-Out Timing Diagram

## 11.2 Port C Interrupt AC Electrical Specifications

Table 15 provides the timings for port C interrupts.

Table 15. Port C Interrupt Timing

| Num | Characteristic                                         | 33.34 MHz |     | Unit |
|-----|--------------------------------------------------------|-----------|-----|------|
|     |                                                        | Min       | Max |      |
| 35  | Port C interrupt pulse width low (edge-triggered mode) | 55        | —   | ns   |
| 36  | Port C interrupt minimum time between active edges     | 55        | —   | ns   |

Figure 45 shows the port C interrupt detection timing.

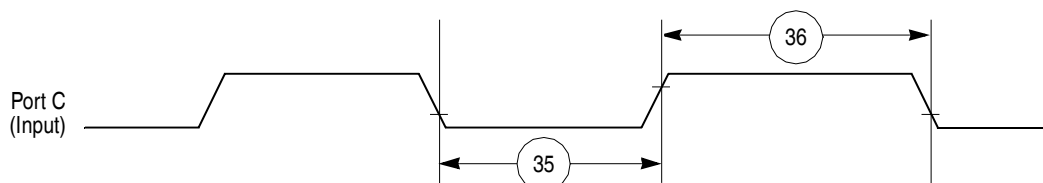


Figure 45. Port C Interrupt Detection Timing

## 11.3 IDMA Controller AC Electrical Specifications

Table 16 provides the IDMA controller timings as shown in Figure 46 though Figure 49.

Table 16. IDMA Controller Timing

| Num | Characteristic                                     | All Frequencies |     | Unit |
|-----|----------------------------------------------------|-----------------|-----|------|
|     |                                                    | Min             | Max |      |
| 40  | $\overline{DREQ}$ setup time to clock high         | 7               | —   | ns   |
| 41  | $\overline{DREQ}$ hold time from clock high        | 3               | —   | ns   |
| 42  | $\overline{SDACK}$ assertion delay from clock high | —               | 12  | ns   |



Table 16. IDMA Controller Timing (continued)

| Num | Characteristic                                                                                                         | All Frequencies |     | Unit |
|-----|------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|
|     |                                                                                                                        | Min             | Max |      |
| 43  | $\overline{\text{SDACK}}$ negation delay from clock low                                                                | —               | 12  | ns   |
| 44  | $\overline{\text{SDACK}}$ negation delay from $\overline{\text{TA}}$ low                                               | —               | 20  | ns   |
| 45  | $\overline{\text{SDACK}}$ negation delay from clock high                                                               | —               | 15  | ns   |
| 46  | $\overline{\text{TA}}$ assertion to falling edge of the clock setup time (applies to external $\overline{\text{TA}}$ ) | 7               | —   | ns   |

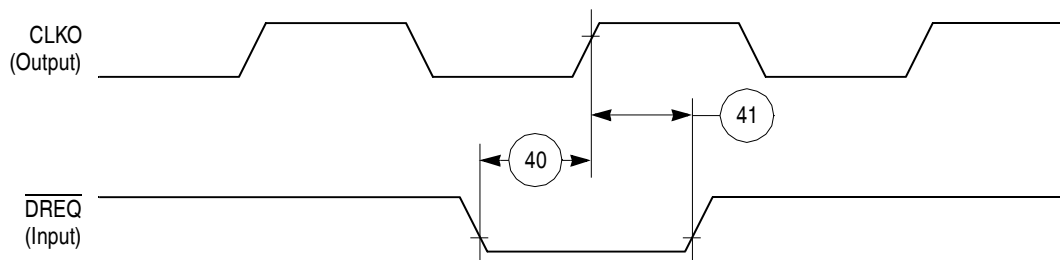
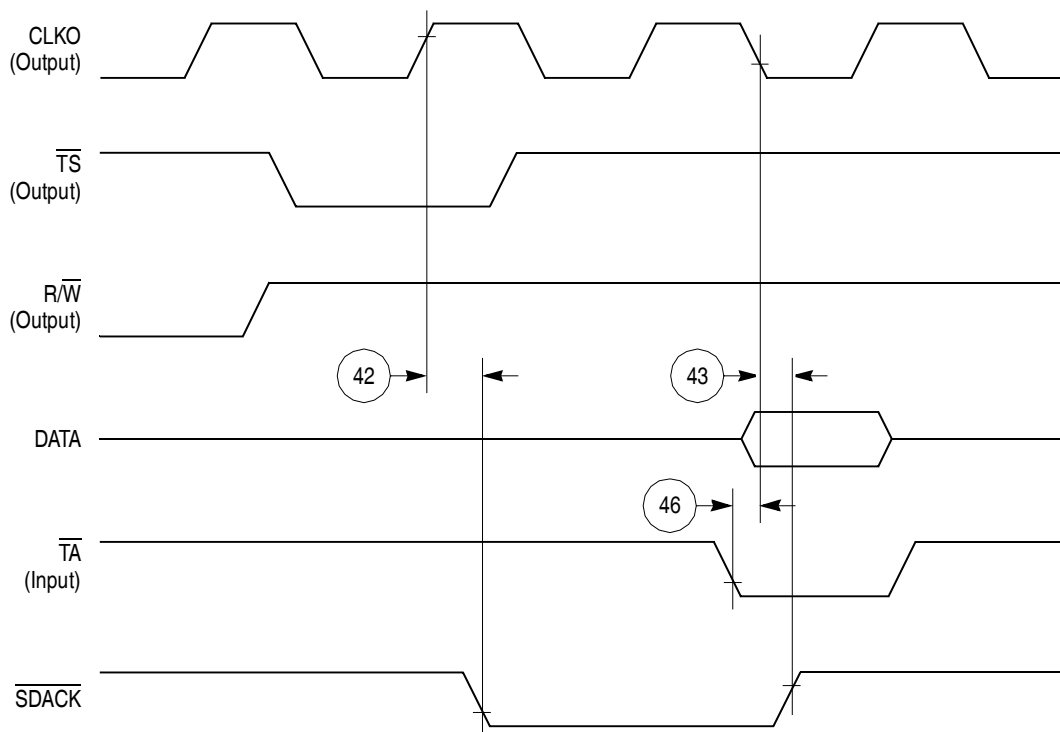
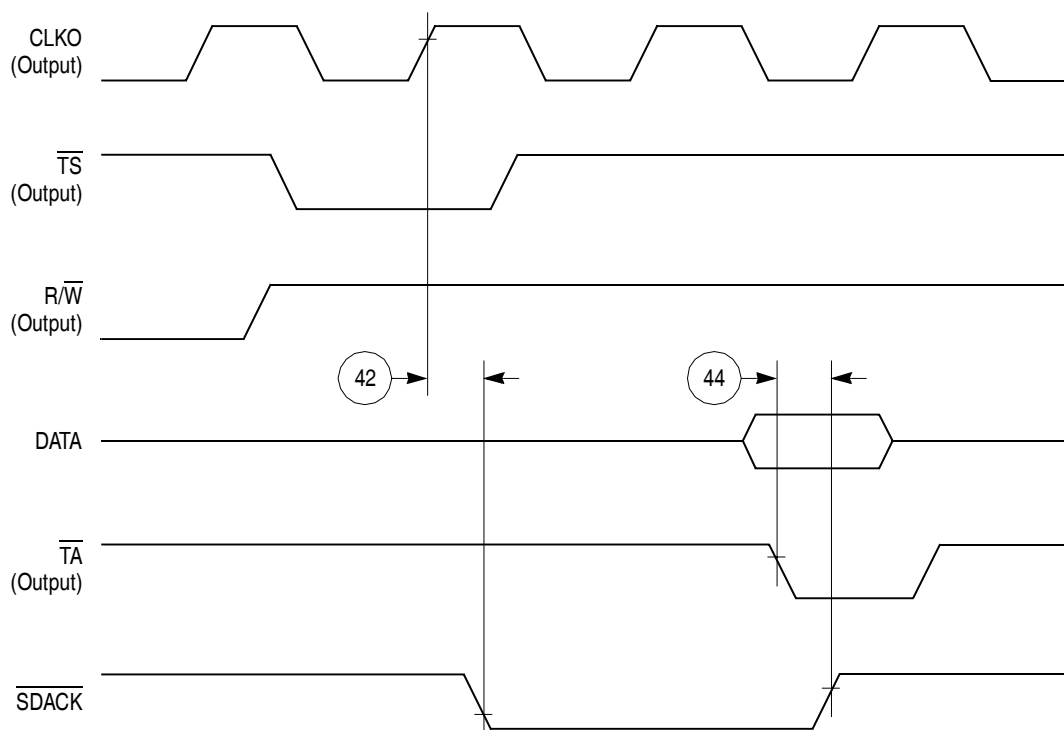
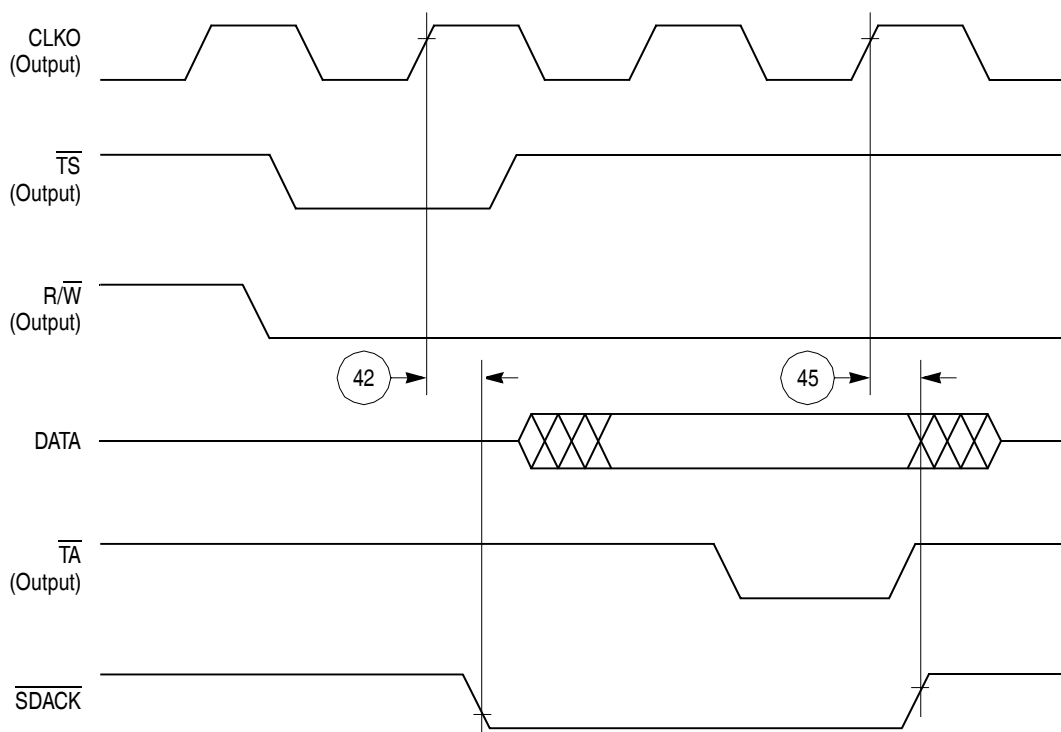


Figure 46. IDMA External Requests Timing Diagram

Figure 47.  $\overline{\text{SDACK}}$  Timing Diagram—Peripheral Write, Externally-Generated  $\overline{\text{TA}}$



**Figure 48.  $\overline{SDACK}$  Timing Diagram—Peripheral Write, Internally-Generated  $\overline{TA}$**



**Figure 49.  $\overline{SDACK}$  Timing Diagram—Peripheral Read, Internally-Generated  $\overline{TA}$**

## 11.4 Baud Rate Generator AC Electrical Specifications

Table 17 provides the baud rate generator timings as shown in Figure 50.

Table 17. Baud Rate Generator Timing

| Num | Characteristic          | All Frequencies |     | Unit |
|-----|-------------------------|-----------------|-----|------|
|     |                         | Min             | Max |      |
| 50  | BRGO rise and fall time | —               | 10  | ns   |
| 51  | BRGO duty cycle         | 40              | 60  | %    |
| 52  | BRGO cycle              | 40              | —   | ns   |

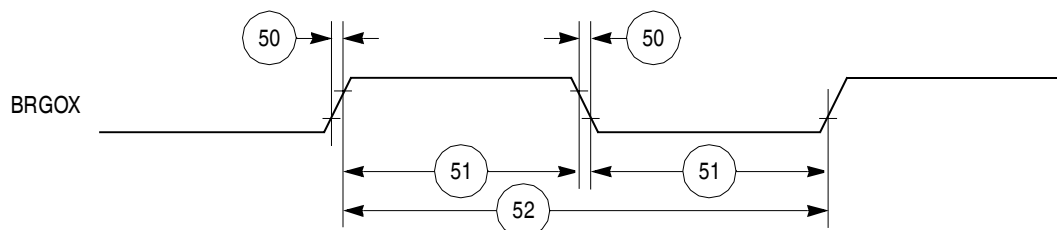


Figure 50. Baud Rate Generator Timing Diagram

## 11.5 Timer AC Electrical Specifications

Table 18 provides the general-purpose timer timings as shown in Figure 51.

Table 18. Timer Timing

| Num | Characteristic                                    | All Frequencies |     | Unit |
|-----|---------------------------------------------------|-----------------|-----|------|
|     |                                                   | Min             | Max |      |
| 61  | TIN/ $\overline{\text{TGATE}}$ rise and fall time | 10              | —   | ns   |
| 62  | TIN/ $\overline{\text{TGATE}}$ low time           | 1               | —   | clk  |
| 63  | TIN/ $\overline{\text{TGATE}}$ high time          | 2               | —   | clk  |
| 64  | TIN/ $\overline{\text{TGATE}}$ cycle time         | 3               | —   | clk  |
| 65  | CLKO low to $\overline{\text{TOUT}}$ valid        | 3               | 25  | ns   |

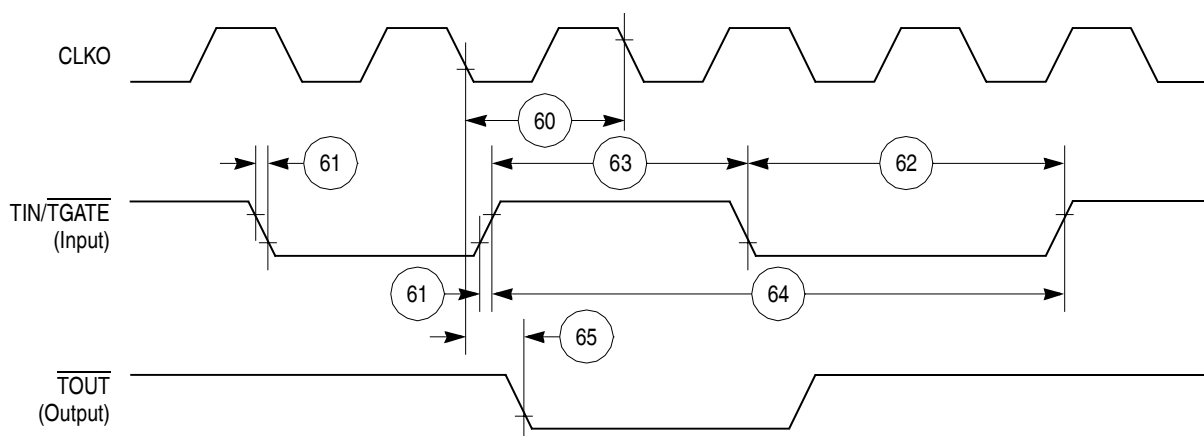


Figure 51. CPM General-Purpose Timers Timing Diagram

## 11.6 Serial Interface AC Electrical Specifications

Table 19 provides the serial interface timings as shown in Figure 52 through Figure 56.

Table 19. SI Timing

| Num | Characteristic                                                     | All Frequencies |                    | Unit |
|-----|--------------------------------------------------------------------|-----------------|--------------------|------|
|     |                                                                    | Min             | Max                |      |
| 70  | L1RCLK, L1TCLK frequency (DSC = 0) <sup>1, 2</sup>                 | —               | SYNCCLK/2.5        | MHz  |
| 71  | L1RCLK, L1TCLK width low (DSC = 0) <sup>2</sup>                    | P + 10          | —                  | ns   |
| 71a | L1RCLK, L1TCLK width high (DSC = 0) <sup>3</sup>                   | P + 10          | —                  | ns   |
| 72  | L1TXD, L1ST(1–4), $\overline{\text{L1RQ}}$ , L1CLKO rise/fall time | —               | 15.00              | ns   |
| 73  | L1RSYNC, L1TSYNC valid to L1CLK edge (SYNC setup time)             | 20.00           | —                  | ns   |
| 74  | L1CLK edge to L1RSYNC, L1TSYNC, invalid (SYNC hold time)           | 35.00           | —                  | ns   |
| 75  | L1RSYNC, L1TSYNC rise/fall time                                    | —               | 15.00              | ns   |
| 76  | L1RXD valid to L1CLK edge (L1RXD setup time)                       | 17.00           | —                  | ns   |
| 77  | L1CLK edge to L1RXD invalid (L1RXD hold time)                      | 13.00           | —                  | ns   |
| 78  | L1CLK edge to L1ST(1–4) valid <sup>4</sup>                         | 10.00           | 45.00              | ns   |
| 78A | L1SYNC valid to L1ST(1–4) valid                                    | 10.00           | 45.00              | ns   |
| 79  | L1CLK edge to L1ST(1–4) invalid                                    | 10.00           | 45.00              | ns   |
| 80  | L1CLK edge to L1TXD valid                                          | 10.00           | 55.00              | ns   |
| 80A | L1TSYNC valid to L1TXD valid <sup>4</sup>                          | 10.00           | 55.00              | ns   |
| 81  | L1CLK edge to L1TXD high impedance                                 | 0.00            | 42.00              | ns   |
| 82  | L1RCLK, L1TCLK frequency (DSC = 1)                                 | —               | 16.00 or SYNCCLK/2 | MHz  |
| 83  | L1RCLK, L1TCLK width low (DSC = 1)                                 | P + 10          | —                  | ns   |

Table 19. SI Timing (continued)

| Num | Characteristic                                                             | All Frequencies |       | Unit   |
|-----|----------------------------------------------------------------------------|-----------------|-------|--------|
|     |                                                                            | Min             | Max   |        |
| 83a | L1RCLK, L1TCLK width high (DSC = 1) <sup>3</sup>                           | P + 10          | —     | ns     |
| 84  | L1CLK edge to L1CLKO valid (DSC = 1)                                       | —               | 30.00 | ns     |
| 85  | $\overline{\text{L1RQ}}$ valid before falling edge of L1TSYNC <sup>4</sup> | 1.00            | —     | L1TCLK |
| 86  | L1GR setup time <sup>2</sup>                                               | 42.00           | —     | ns     |
| 87  | L1GR hold time                                                             | 42.00           | —     | ns     |
| 88  | L1CLK edge to L1SYNC valid (FSD = 00) CNT = 0000, BYT = 0, DSC = 0)        | —               | 0.00  | ns     |

<sup>1</sup> The ratio SyncCLK/L1RCLK must be greater than 2.5/1.

<sup>2</sup> These specs are valid for IDL mode only.

<sup>3</sup> Where P = 1/CLKOUT. Thus for a 25-MHz CLKOUT rate, P = 40 ns.

<sup>4</sup> These strobes and TxD on the first bit of the frame become valid after L1CLK edge or L1SYNC, whichever is later.

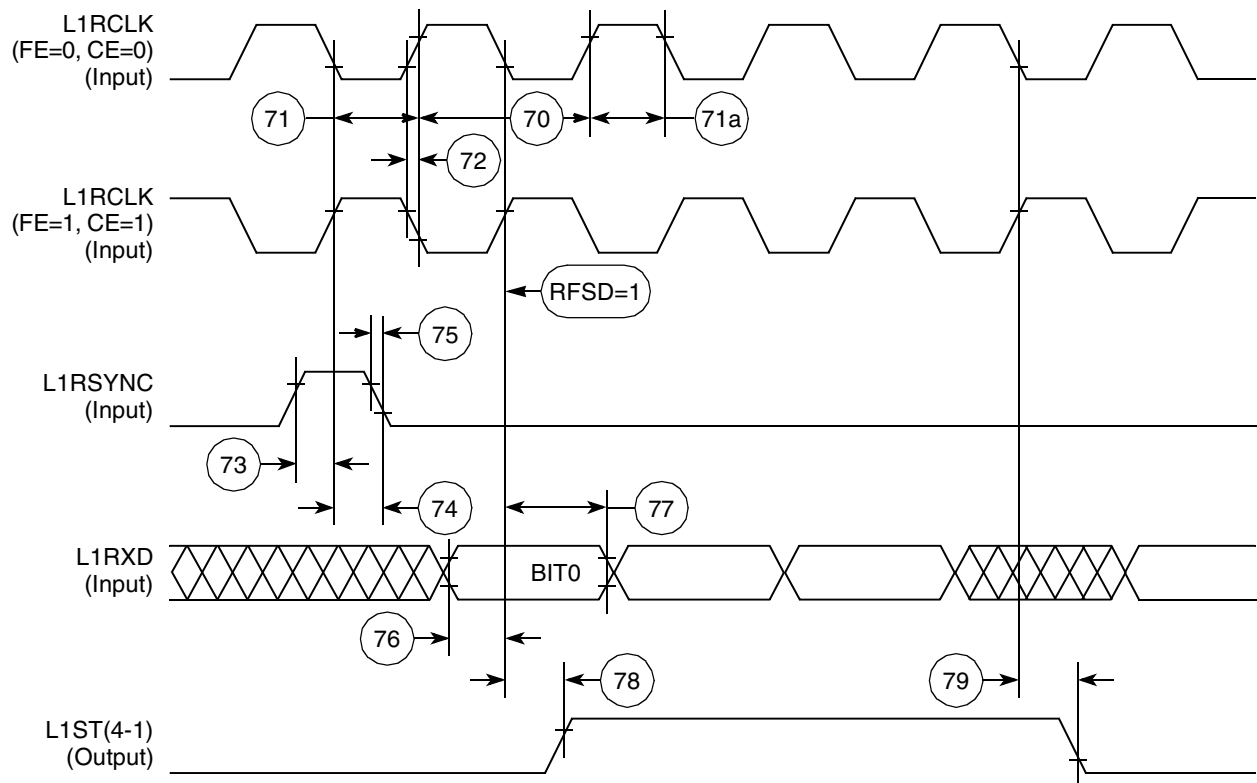
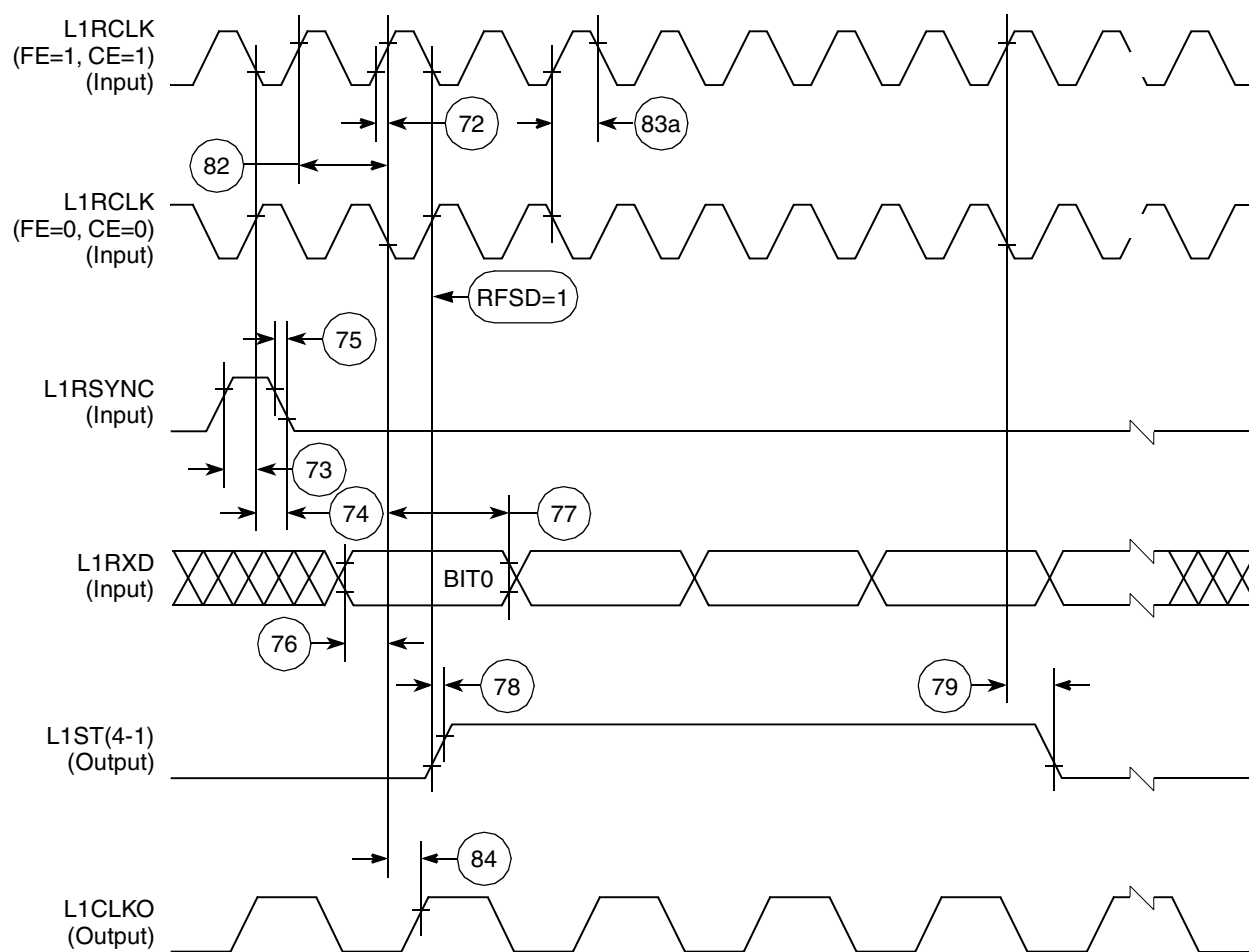


Figure 52. SI Receive Timing Diagram with Normal Clocking (DSC = 0)



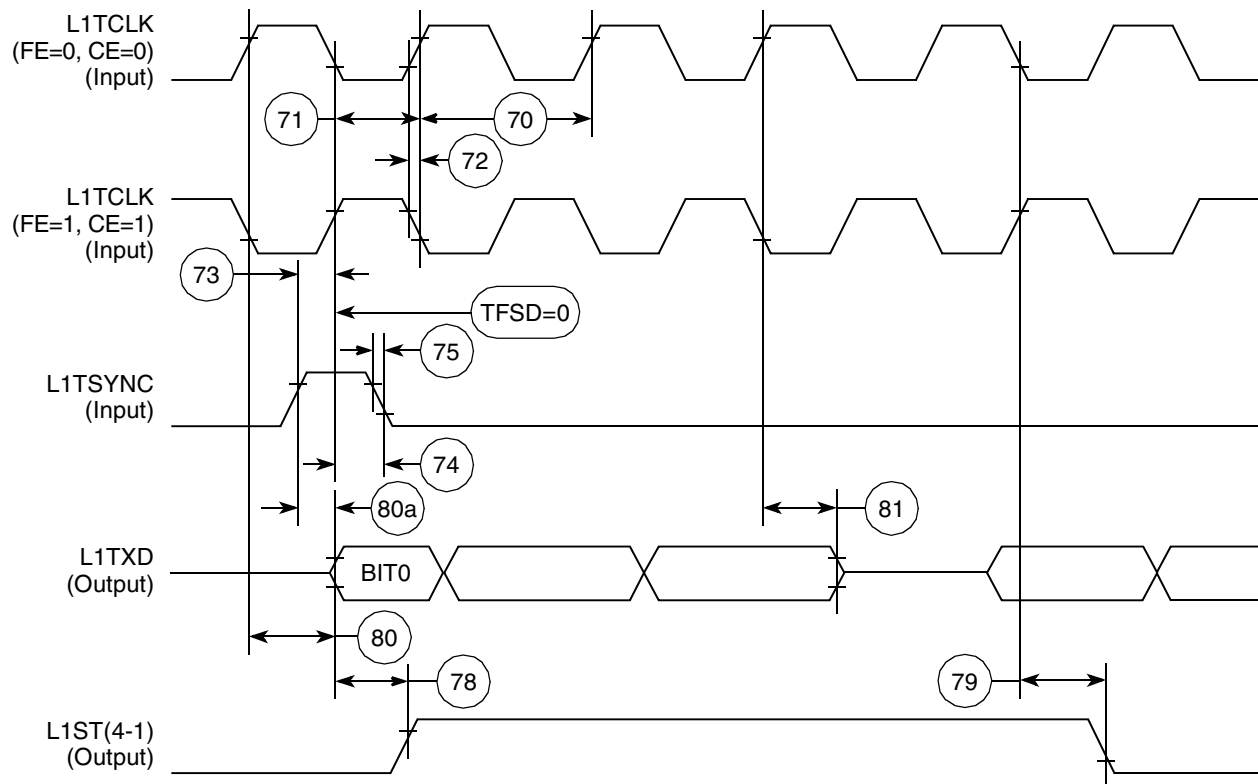


Figure 54. SI Transmit Timing Diagram (DSC = 0)

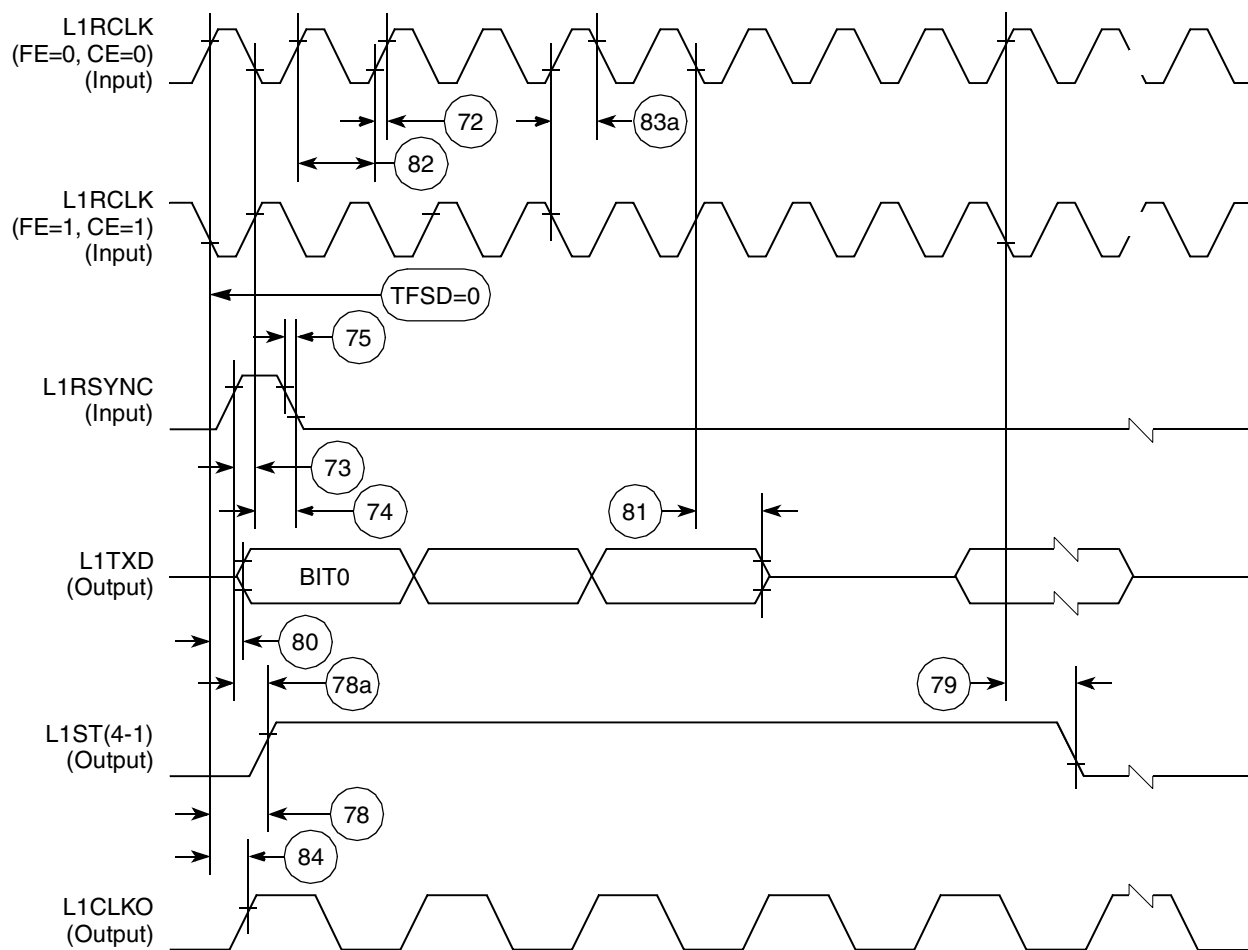


Figure 55. SI Transmit Timing with Double Speed Clocking (DSC = 1)



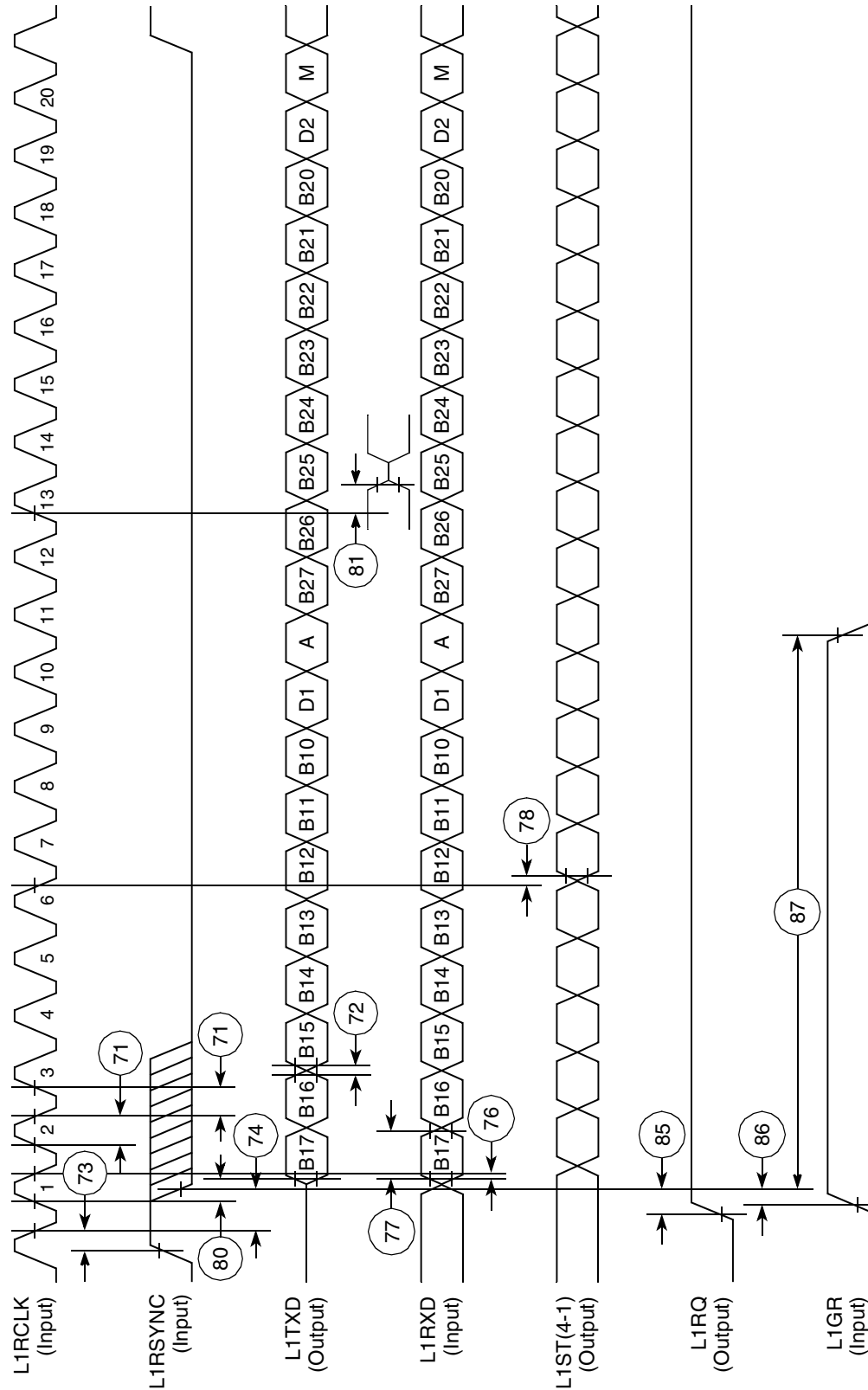


Figure 56. IDL Timing

## 11.7 SCC in NMSI Mode Electrical Specifications

Table 20 provides the NMSI external clock timing.

**Table 20. NMSI External Clock Timing**

| Num | Characteristic                                                           | All Frequencies |       | Unit |
|-----|--------------------------------------------------------------------------|-----------------|-------|------|
|     |                                                                          | Min             | Max   |      |
| 100 | RCLK1 and TCLK1 width high <sup>1</sup>                                  | 1/SYNCCLK       | —     | ns   |
| 101 | RCLK1 and TCLK1 width low                                                | 1/SYNCCLK +5    | —     | ns   |
| 102 | RCLK1 and TCLK1 rise/fall time                                           | —               | 15.00 | ns   |
| 103 | TXD1 active delay (from TCLK1 falling edge)                              | 0.00            | 50.00 | ns   |
| 104 | $\overline{\text{RTS1}}$ active/inactive delay (from TCLK1 falling edge) | 0.00            | 50.00 | ns   |
| 105 | $\overline{\text{CTS1}}$ setup time to TCLK1 rising edge                 | 5.00            | —     | ns   |
| 106 | RXD1 setup time to RCLK1 rising edge                                     | 5.00            | —     | ns   |
| 107 | RXD1 hold time from RCLK1 rising edge <sup>2</sup>                       | 5.00            | —     | ns   |
| 108 | $\overline{\text{CD1}}$ setup Time to RCLK1 rising edge                  | 5.00            | —     | ns   |

<sup>1</sup> The ratios SyncCLK/RCLK1 and SyncCLK/TCLK1 must be greater than or equal to 2.25/1.

<sup>2</sup> Also applies to  $\overline{\text{CD}}$  and  $\overline{\text{CTS}}$  hold time when they are used as an external sync signal.

Table 21 provides the NMSI internal clock timing.

**Table 21. NMSI Internal Clock Timing**

| Num | Characteristic                                                           | All Frequencies |           | Unit |
|-----|--------------------------------------------------------------------------|-----------------|-----------|------|
|     |                                                                          | Min             | Max       |      |
| 100 | RCLK1 and TCLK1 frequency <sup>1</sup>                                   | 0.00            | SYNCCLK/3 | MHz  |
| 102 | RCLK1 and TCLK1 rise/fall time                                           | —               | —         | ns   |
| 103 | TXD1 active delay (from TCLK1 falling edge)                              | 0.00            | 30.00     | ns   |
| 104 | $\overline{\text{RTS1}}$ active/inactive delay (from TCLK1 falling edge) | 0.00            | 30.00     | ns   |
| 105 | $\overline{\text{CTS1}}$ setup time to TCLK1 rising edge                 | 40.00           | —         | ns   |
| 106 | RXD1 setup time to RCLK1 rising edge                                     | 40.00           | —         | ns   |
| 107 | RXD1 hold time from RCLK1 rising edge <sup>2</sup>                       | 0.00            | —         | ns   |
| 108 | $\overline{\text{CD1}}$ setup time to RCLK1 rising edge                  | 40.00           | —         | ns   |

<sup>1</sup> The ratios SyncCLK/RCLK1 and SyncCLK/TCLK1 must be greater or equal to 3/1.

<sup>2</sup> Also applies to  $\overline{\text{CD}}$  and  $\overline{\text{CTS}}$  hold time when they are used as an external sync signals.

Figure 57 through Figure 59 show the NMSI timings.

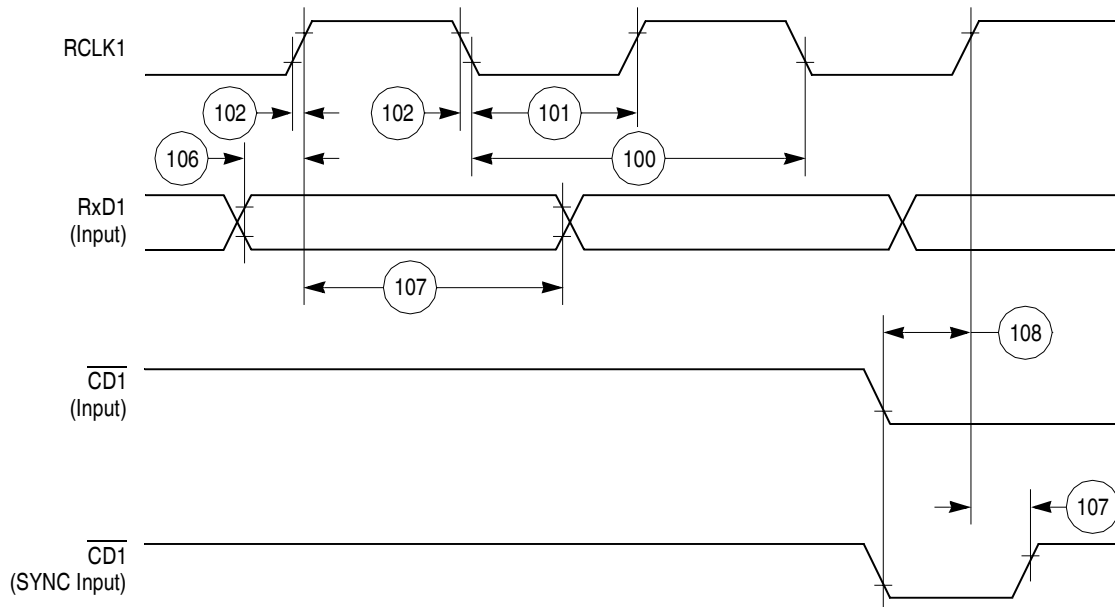


Figure 57. SCC NMSI Receive Timing Diagram

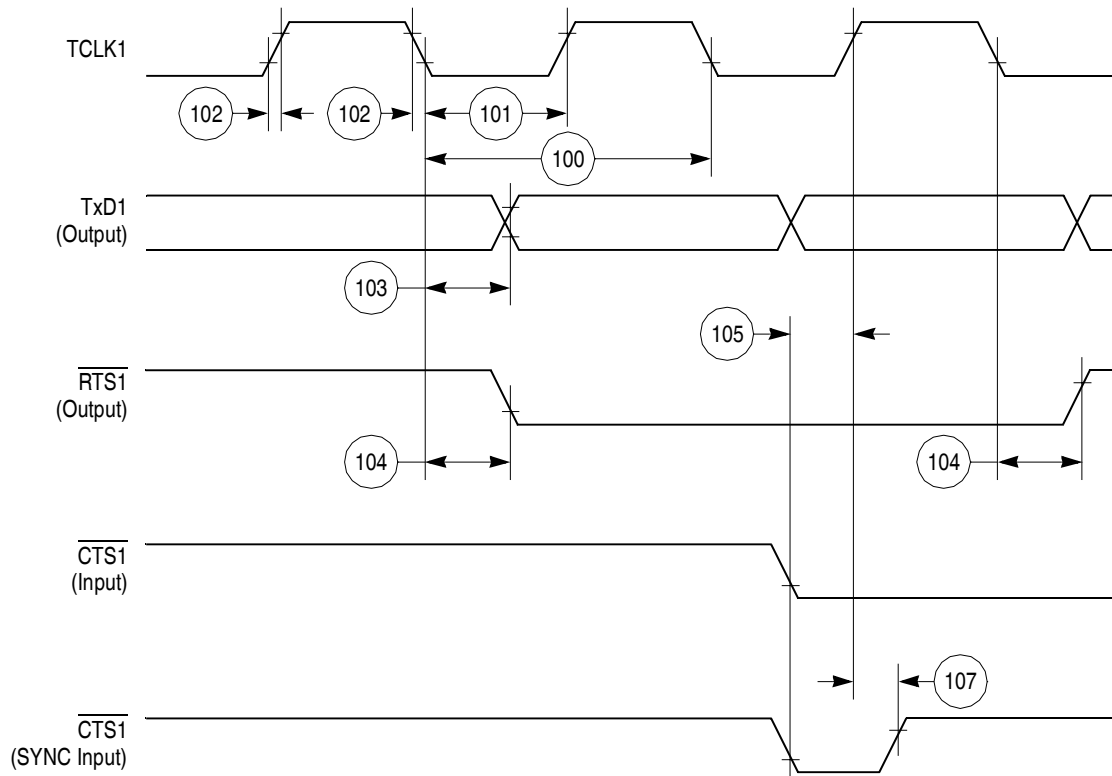


Figure 58. SCC NMSI Transmit Timing Diagram

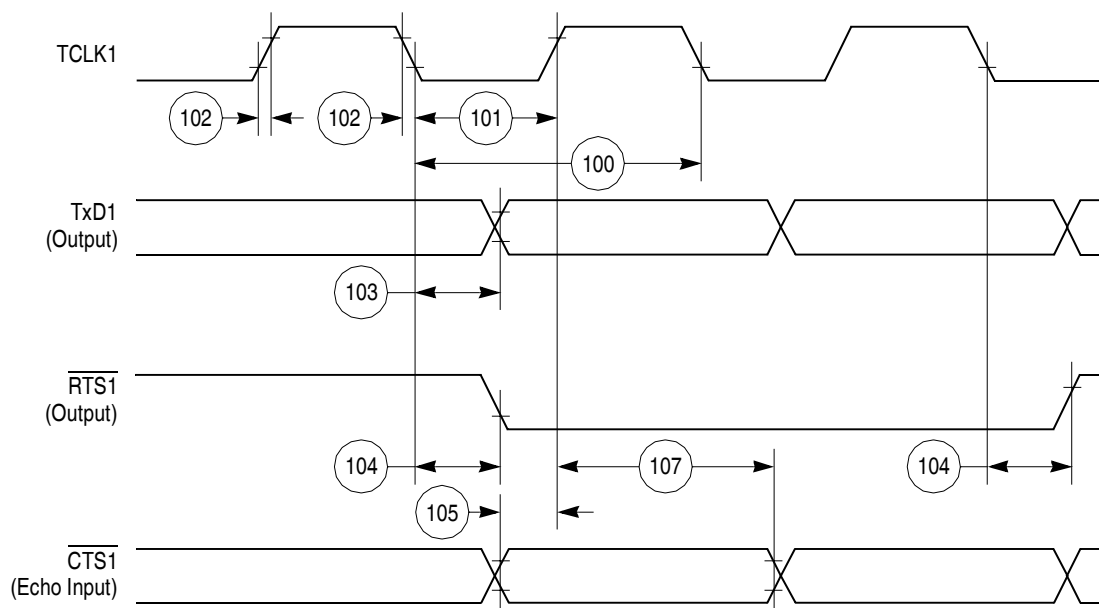


Figure 59. HDLC Bus Timing Diagram

## 11.8 Ethernet Electrical Specifications

Table 22 provides the Ethernet timings as shown in Figure 60 through Figure 64.

Table 22. Ethernet Timing

| Num | Characteristic                                                  | All Frequencies |     | Unit |
|-----|-----------------------------------------------------------------|-----------------|-----|------|
|     |                                                                 | Min             | Max |      |
| 120 | CLSN width high                                                 | 40              | —   | ns   |
| 121 | RCLK1 rise/fall time                                            | —               | 15  | ns   |
| 122 | RCLK1 width low                                                 | 40              | —   | ns   |
| 123 | RCLK1 clock period <sup>1</sup>                                 | 80              | 120 | ns   |
| 124 | RXD1 setup time                                                 | 20              | —   | ns   |
| 125 | RXD1 hold time                                                  | 5               | —   | ns   |
| 126 | RENA active delay (from RCLK1 rising edge of the last data bit) | 10              | —   | ns   |
| 127 | RENA width low                                                  | 100             | —   | ns   |
| 128 | TCLK1 rise/fall time                                            | —               | 15  | ns   |
| 129 | TCLK1 width low                                                 | 40              | —   | ns   |
| 130 | TCLK1 clock period <sup>1</sup>                                 | 99              | 101 | ns   |
| 131 | TXD1 active delay (from TCLK1 rising edge)                      | 10              | 50  | ns   |
| 132 | TXD1 inactive delay (from TCLK1 rising edge)                    | 10              | 50  | ns   |
| 133 | TENA active delay (from TCLK1 rising edge)                      | 10              | 50  | ns   |

Table 22. Ethernet Timing (continued)

| Num | Characteristic                                                     | All Frequencies |     | Unit |
|-----|--------------------------------------------------------------------|-----------------|-----|------|
|     |                                                                    | Min             | Max |      |
| 134 | TENA inactive delay (from TCLK1 rising edge)                       | 10              | 50  | ns   |
| 135 | $\overline{\text{RSTRT}}$ active delay (from TCLK1 falling edge)   | 10              | 50  | ns   |
| 136 | $\overline{\text{RSTRT}}$ inactive delay (from TCLK1 falling edge) | 10              | 50  | ns   |
| 137 | $\overline{\text{REJECT}}$ width low                               | 1               | —   | CLK  |
| 138 | CLKO1 low to $\overline{\text{SDACK}}$ asserted <sup>2</sup>       | —               | 20  | ns   |
| 139 | CLKO1 low to $\overline{\text{SDACK}}$ negated <sup>2</sup>        | —               | 20  | ns   |

<sup>1</sup> The ratios SyncCLK/RCLK1 and SyncCLK/TCLK1 must be greater or equal to 2/1.

<sup>2</sup>  $\overline{\text{SDACK}}$  is asserted whenever the SDMA writes the incoming frame DA into memory.

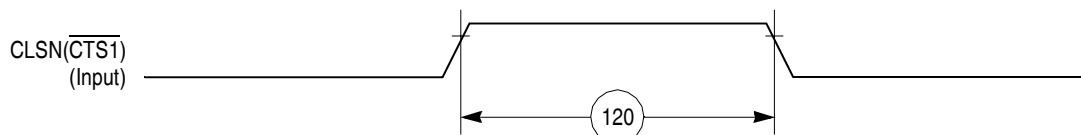


Figure 60. Ethernet Collision Timing Diagram

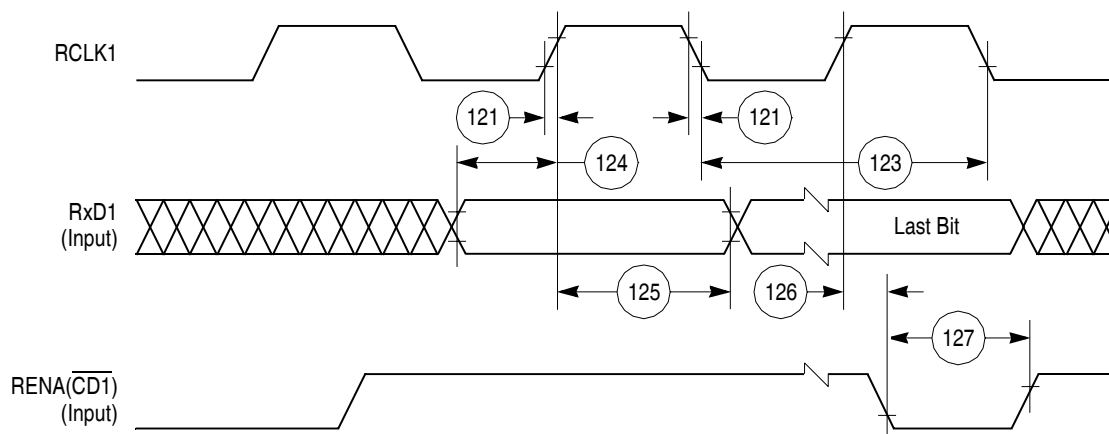
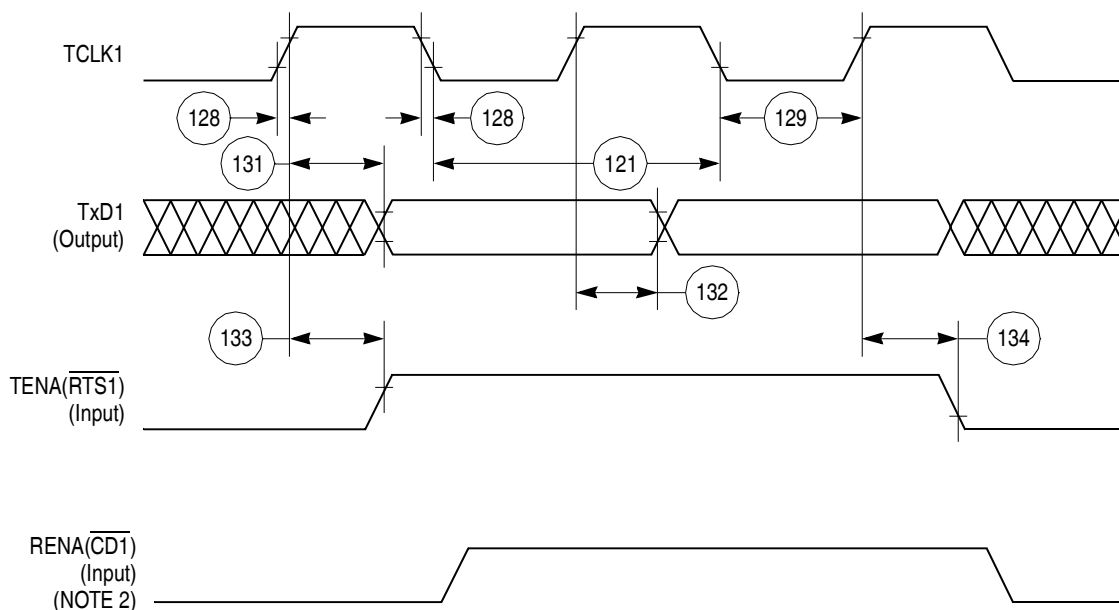


Figure 61. Ethernet Receive Timing Diagram



## NOTES:

1. Transmit clock invert (TCI) bit in GSMR is set.
2. If RENA is deasserted before TENA, or RENA is not asserted at all during transmit, then the CSL bit is set in the buffer descriptor at the end of the frame transmission.

Figure 62. Ethernet Transmit Timing Diagram

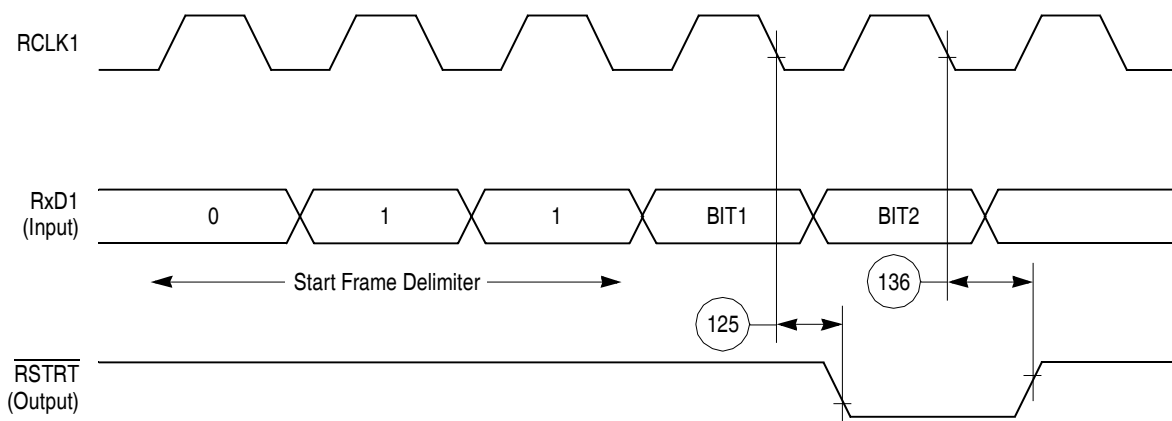


Figure 63. CAM Interface Receive Start Timing Diagram

Figure 64. CAM Interface  $\overline{\text{REJECT}}$  Timing Diagram

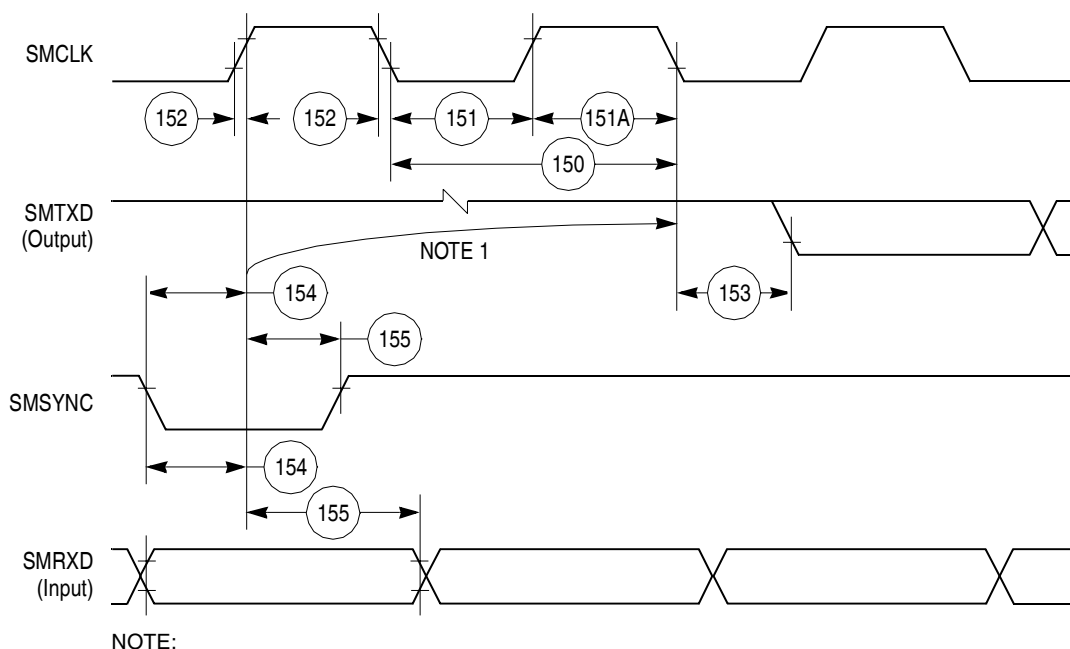
## 11.9 SMC Transparent AC Electrical Specifications

Table 23 provides the SMC transparent timings as shown in Figure 65.

**Table 23. SMC Transparent Timing**

| Num  | Characteristic                               | All Frequencies |     | Unit |
|------|----------------------------------------------|-----------------|-----|------|
|      |                                              | Min             | Max |      |
| 150  | SMCLK clock period <sup>1</sup>              | 100             | —   | ns   |
| 151  | SMCLK width low                              | 50              | —   | ns   |
| 151A | SMCLK width high                             | 50              | —   | ns   |
| 152  | SMCLK rise/fall time                         | —               | 15  | ns   |
| 153  | SMTXD active delay (from SMCLK falling edge) | 10              | 50  | ns   |
| 154  | SMRXD/SMSYNC setup time                      | 20              | —   | ns   |
| 155  | RXD1/SMSYNC hold time                        | 5               | —   | ns   |

<sup>1</sup> SyncCLK must be at least twice as fast as SMCLK.



**Figure 65. SMC Transparent Timing Diagram**

## 11.10 SPI Master AC Electrical Specifications

Table 24 provides the SPI master timings as shown in Figure 66 though Figure 67.

Table 24. SPI Master Timing

| Num | Characteristic                      | All Frequencies |      | Unit      |
|-----|-------------------------------------|-----------------|------|-----------|
|     |                                     | Min             | Max  |           |
| 160 | MASTER cycle time                   | 4               | 1024 | $t_{cyc}$ |
| 161 | MASTER clock (SCK) high or low time | 2               | 512  | $t_{cyc}$ |
| 162 | MASTER data setup time (inputs)     | 15              | —    | ns        |
| 163 | Master data hold time (inputs)      | 0               | —    | ns        |
| 164 | Master data valid (after SCK edge)  | —               | 10   | ns        |
| 165 | Master data hold time (outputs)     | 0               | —    | ns        |
| 166 | Rise time output                    | —               | 15   | ns        |
| 167 | Fall time output                    | —               | 15   | ns        |

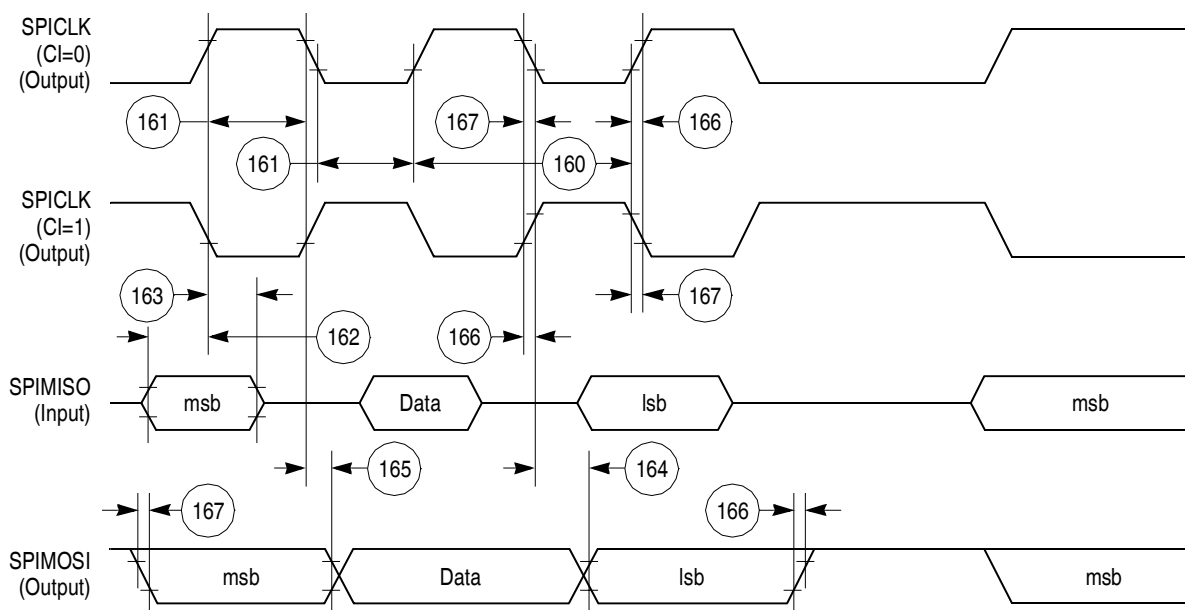


Figure 66. SPI Master (CP = 0) Timing Diagram



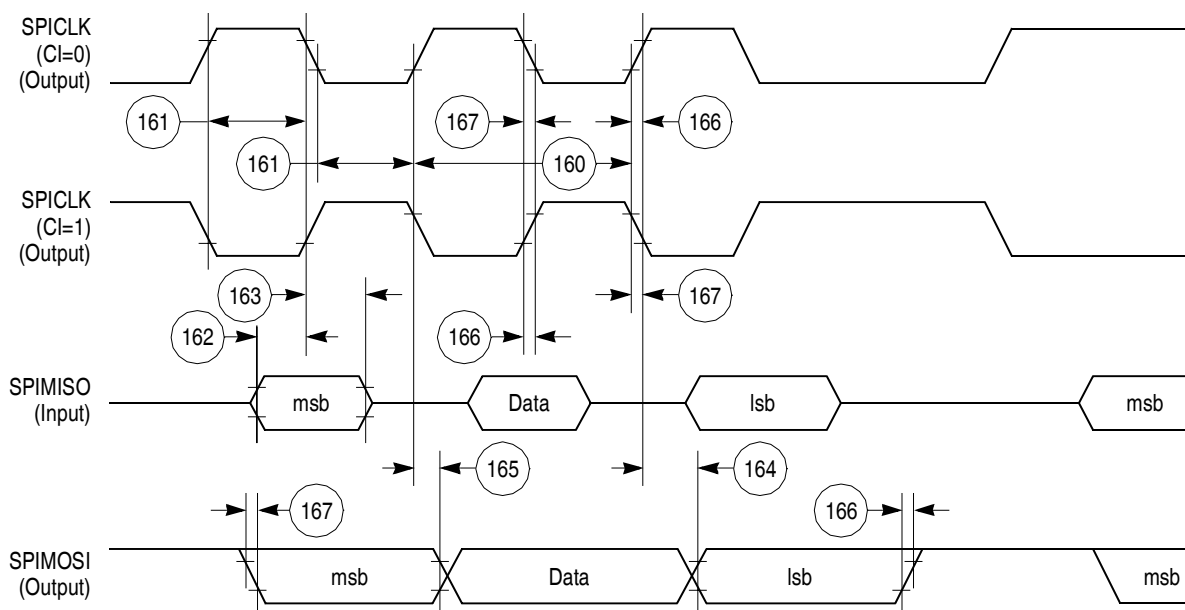


Figure 67. SPI Master (CP = 1) Timing Diagram

## 11.11 SPI Slave AC Electrical Specifications

Table 25 provides the SPI slave timings as shown in Figure 68 through Figure 69.

Table 25. SPI Slave Timing

| Num | Characteristic                                              | All Frequencies |     | Unit      |
|-----|-------------------------------------------------------------|-----------------|-----|-----------|
|     |                                                             | Min             | Max |           |
| 170 | Slave cycle time                                            | 2               | —   | $t_{cyc}$ |
| 171 | Slave enable lead time                                      | 15              | —   | ns        |
| 172 | Slave enable lag time                                       | 15              | —   | ns        |
| 173 | Slave clock (SPICLK) high or low time                       | 1               | —   | $t_{cyc}$ |
| 174 | Slave sequential transfer delay (does not require deselect) | 1               | —   | $t_{cyc}$ |
| 175 | Slave data setup time (inputs)                              | 20              | —   | ns        |
| 176 | Slave data hold time (inputs)                               | 20              | —   | ns        |
| 177 | Slave access time                                           | —               | 50  | ns        |

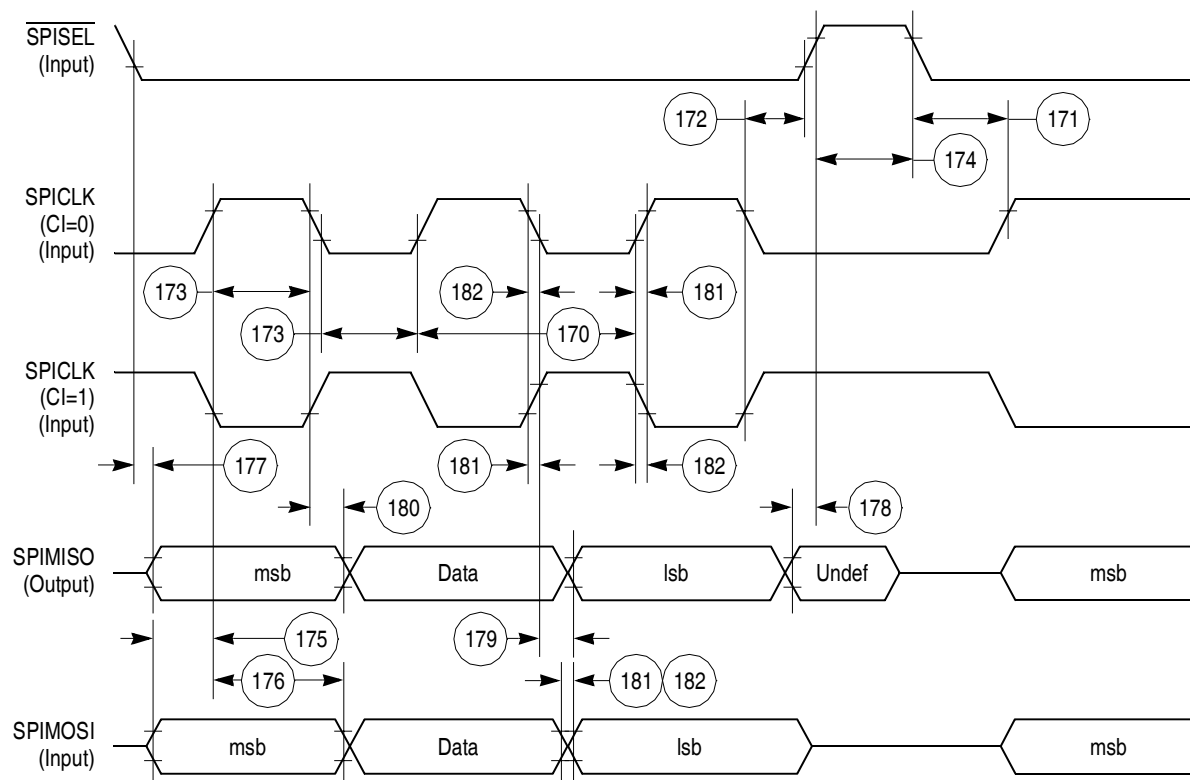


Figure 68. SPI Slave (CP = 0) Timing Diagram

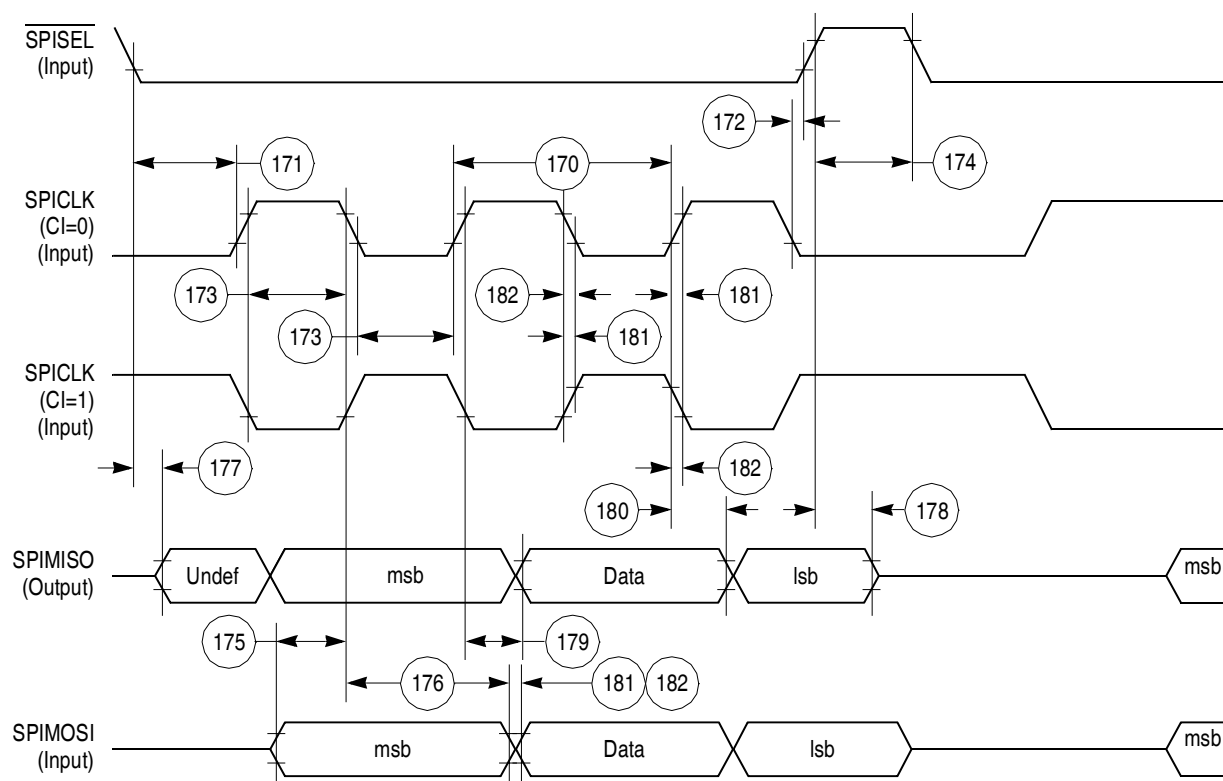


Figure 69. SPI Slave (CP = 1) Timing Diagram

## 11.12 I<sup>2</sup>C AC Electrical Specifications

Table 26 provides the I<sup>2</sup>C (SCL < 100 KHz) timings.

Table 26. I<sup>2</sup>C Timing (SCL < 100 KHz)

| Num | Characteristic                            | All Frequencies |     | Unit |
|-----|-------------------------------------------|-----------------|-----|------|
|     |                                           | Min             | Max |      |
| 200 | SCL clock frequency (slave)               | 0               | 100 | kHz  |
| 200 | SCL clock frequency (master) <sup>1</sup> | 1.5             | 100 | kHz  |
| 202 | Bus free time between transmissions       | 4.7             | —   | μs   |
| 203 | Low period of SCL                         | 4.7             | —   | μs   |
| 204 | High period of SCL                        | 4.0             | —   | μs   |
| 205 | Start condition setup time                | 4.7             | —   | μs   |
| 206 | Start condition hold time                 | 4.0             | —   | μs   |
| 207 | Data hold time                            | 0               | —   | μs   |
| 208 | Data setup time                           | 250             | —   | ns   |
| 209 | SDL/SCL rise time                         | —               | 1   | μs   |
| 210 | SDL/SCL fall time                         | —               | 300 | ns   |
| 211 | Stop condition setup time                 | 4.7             | —   | μs   |

<sup>1</sup> SCL frequency is given by  $SCL = BRGCLK\_frequency / ((BRG\ register + 3) * pre\_scaler * 2)$ .  
The ratio  $SyncClk/(BRGCLK/pre\_scaler)$  must be greater or equal to 4/1.

Table 27 provides the I<sup>2</sup>C (SCL > 100 kHz) timings.

Table 27. I<sup>2</sup>C Timing (SCL > 100 kHz)

| Num | Characteristic                            | Expression | All Frequencies   |                 | Unit |
|-----|-------------------------------------------|------------|-------------------|-----------------|------|
|     |                                           |            | Min               | Max             |      |
| 200 | SCL clock frequency (slave)               | fSCL       | 0                 | BRGCLK/48       | Hz   |
| 200 | SCL clock frequency (master) <sup>1</sup> | fSCL       | BRGCLK/16512      | BRGCLK/48       | Hz   |
| 202 | Bus free time between transmissions       | —          | $1/(2.2 * fSCL)$  | —               | s    |
| 203 | Low period of SCL                         | —          | $1/(2.2 * fSCL)$  | —               | s    |
| 204 | High period of SCL                        | —          | $1/(2.2 * fSCL)$  | —               | s    |
| 205 | Start condition setup time                | —          | $1/(2.2 * fSCL)$  | —               | s    |
| 206 | Start condition hold time                 | —          | $1/(2.2 * fSCL)$  | —               | s    |
| 207 | Data hold time                            | —          | 0                 | —               | s    |
| 208 | Data setup time                           | —          | $1/(40 * fSCL)$   | —               | s    |
| 209 | SDL/SCL rise time                         | —          | —                 | $1/(10 * fSCL)$ | s    |
| 210 | SDL/SCL fall time                         | —          | —                 | $1/(33 * fSCL)$ | s    |
| 211 | Stop condition setup time                 | —          | $1/2(2.2 * fSCL)$ | —               | s    |

<sup>1</sup> SCL frequency is given by  $SCL = BrgClk\_frequency / ((BRG\ register + 3) * pre\_scaler * 2)$ .  
The ratio  $SyncClk/(Brg\_Clk/pre\_scaler)$  must be greater or equal to 4/1.

Figure 70 shows the I<sup>2</sup>C bus timing.

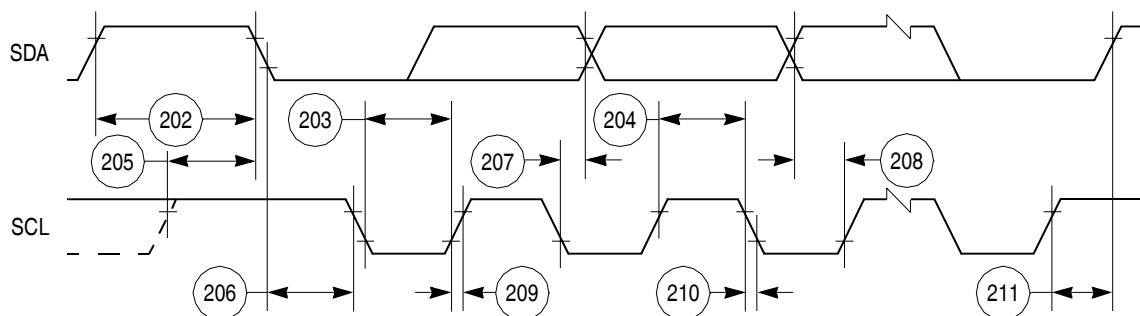


Figure 70. I<sup>2</sup>C Bus Timing Diagram

## 12 UTOPIA AC Electrical Specifications

Table 28 shows the AC electrical specifications for the UTOPIA interface.

Table 28. UTOPIA AC Electrical Specifications

| Num | Signal Characteristic                                                  | Direction | Min  | Max   | Unit |
|-----|------------------------------------------------------------------------|-----------|------|-------|------|
| U1  | UtpClk rise/fall time (Internal clock option)                          | Output    |      | 4 ns  | ns   |
|     | Duty cycle                                                             |           | 50   | 50    | %    |
|     | Frequency                                                              |           |      | 33    | MHz  |
| U1a | UtpClk rise/fall time (external clock option)                          | Input     |      | 4ns   | ns   |
|     | Duty cycle                                                             |           | 40   | 60    | %    |
|     | Frequency                                                              |           |      | 33    | MHz  |
| U2  | $\overline{\text{RxEnb}}$ and $\overline{\text{TxEnb}}$ active delay   | Output    | 2 ns | 16 ns | ns   |
| U3  | UTPB, SOC, Rxclav and Txclav setup time                                | Input     | 4 ns |       | ns   |
| U4  | UTPB, SOC, Rxclav and Txclav hold time                                 | Input     | 1 ns |       | ns   |
| U5  | UTPB, SOC active delay (and PHREQ and PHSEL active delay in MPHY mode) | Output    | 2 ns | 16 ns | ns   |

Figure 71 shows signal timings during UTOPIA receive operations.

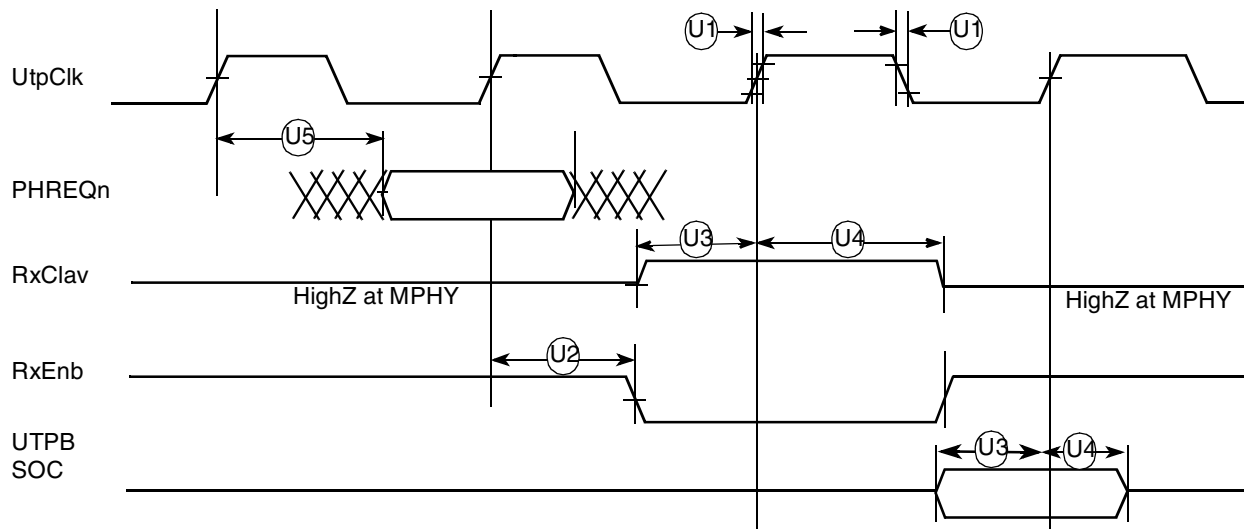


Figure 71. UTOPIA Receive Timing

Figure 72 shows signal timings during UTOPIA transmit operations.

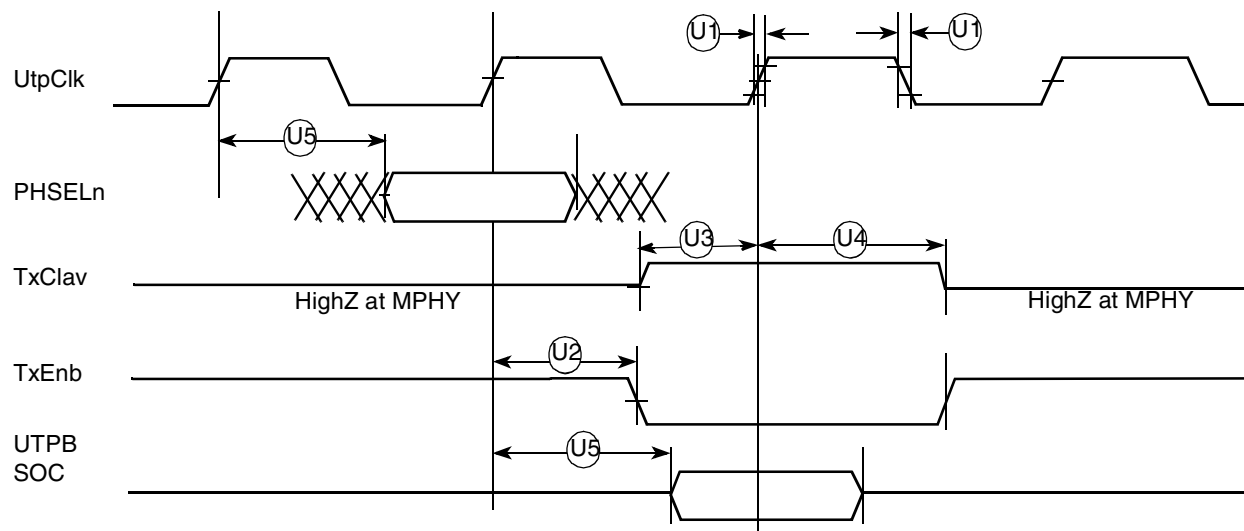


Figure 72. UTOPIA Transmit Timing

## 13 FEC Electrical Characteristics

This section provides the AC electrical specifications for the Fast Ethernet controller (FEC). Note that the timing specifications for the MII signals are independent of system clock frequency (part speed designation). Furthermore, MII signals use TTL signal levels compatible with devices operating at either 5.0 or 3.3 V.

### 13.1 MII Receive Signal Timing (MII\_RXD[3:0], MII\_RX\_DV, MII\_RX\_ER, MII\_RX\_CLK)

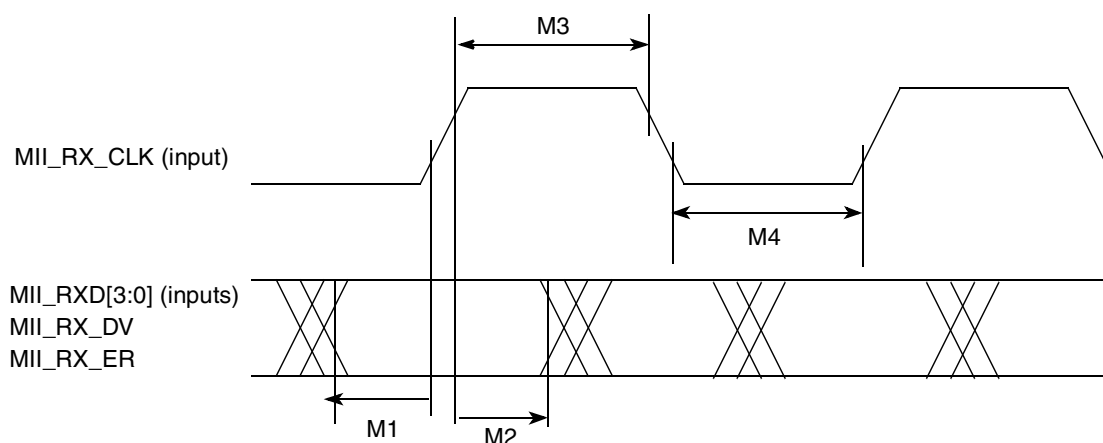
The receiver functions correctly up to a MII\_RX\_CLK maximum frequency of 25MHz +1%. There is no minimum frequency requirement. In addition, the processor clock frequency must exceed the MII\_RX\_CLK frequency - 1%.

Table 29 provides information on the MII receive signal timing.

**Table 29. MII Receive Signal Timing**

| Num | Characteristic                                         | Min | Max | Unit              |
|-----|--------------------------------------------------------|-----|-----|-------------------|
| M1  | MII_RXD[3:0], MII_RX_DV, MII_RX_ER to MII_RX_CLK setup | 5   | —   | ns                |
| M2  | MII_RX_CLK to MII_RXD[3:0], MII_RX_DV, MII_RX_ER hold  | 5   | —   | ns                |
| M3  | MII_RX_CLK pulse width high                            | 35% | 65% | MII_RX_CLK period |
| M4  | MII_RX_CLK pulse width low                             | 35% | 65% | MII_RX_CLK period |

Figure 73 shows MII receive signal timing.



**Figure 73. MII Receive Signal Timing Diagram**

### 13.2 MII Transmit Signal Timing (MII\_TXD[3:0], MII\_TX\_EN, MII\_TX\_ER, MII\_TX\_CLK)

The transmitter functions correctly up to a MII\_TX\_CLK maximum frequency of 25 MHz +1%. There is no minimum frequency requirement. In addition, the processor clock frequency must exceed the MII\_TX\_CLK frequency - 1%.

Table 30 provides information on the MII transmit signal timing.

**Table 30. MII Transmit Signal Timing**

| Num | Characteristic                                           | Min | Max | Unit |
|-----|----------------------------------------------------------|-----|-----|------|
| M5  | MII_TX_CLK to MII_TXD[3:0], MII_TX_EN, MII_TX_ER invalid | 5   | —   | ns   |
| M6  | MII_TX_CLK to MII_TXD[3:0], MII_TX_EN, MII_TX_ER valid   | —   | 25  |      |

Table 30. MII Transmit Signal Timing (continued)

| Num | Characteristic              | Min | Max | Unit              |
|-----|-----------------------------|-----|-----|-------------------|
| M7  | MII_TX_CLK pulse width high | 35% | 65% | MII_TX_CLK period |
| M8  | MII_TX_CLK pulse width low  | 35% | 65% | MII_TX_CLK period |

Figure 74 shows the MII transmit signal timing diagram.

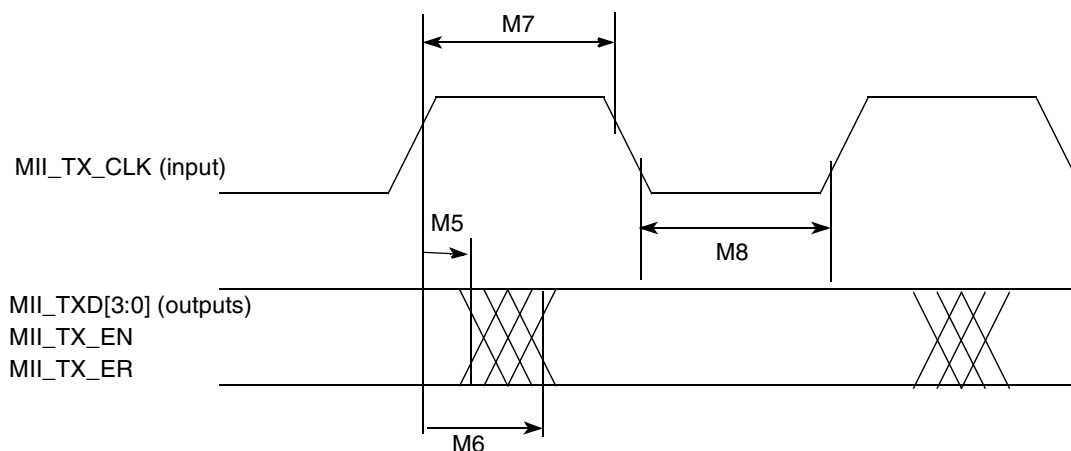


Figure 74. MII Transmit Signal Timing Diagram

### 13.3 MII Async Inputs Signal Timing (MII\_CRCS, MII\_COL)

Table 31 provides information on the MII async inputs signal timing.

Table 31. MII Async Inputs Signal Timing

| Num | Characteristic                        | Min | Max | Unit              |
|-----|---------------------------------------|-----|-----|-------------------|
| M9  | MII_CRCS, MII_COL minimum pulse width | 1.5 | —   | MII_TX_CLK period |

Figure 75 shows the MII asynchronous inputs signal timing diagram.

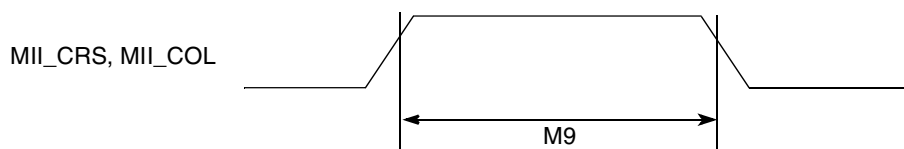


Figure 75. MII Async Inputs Timing Diagram

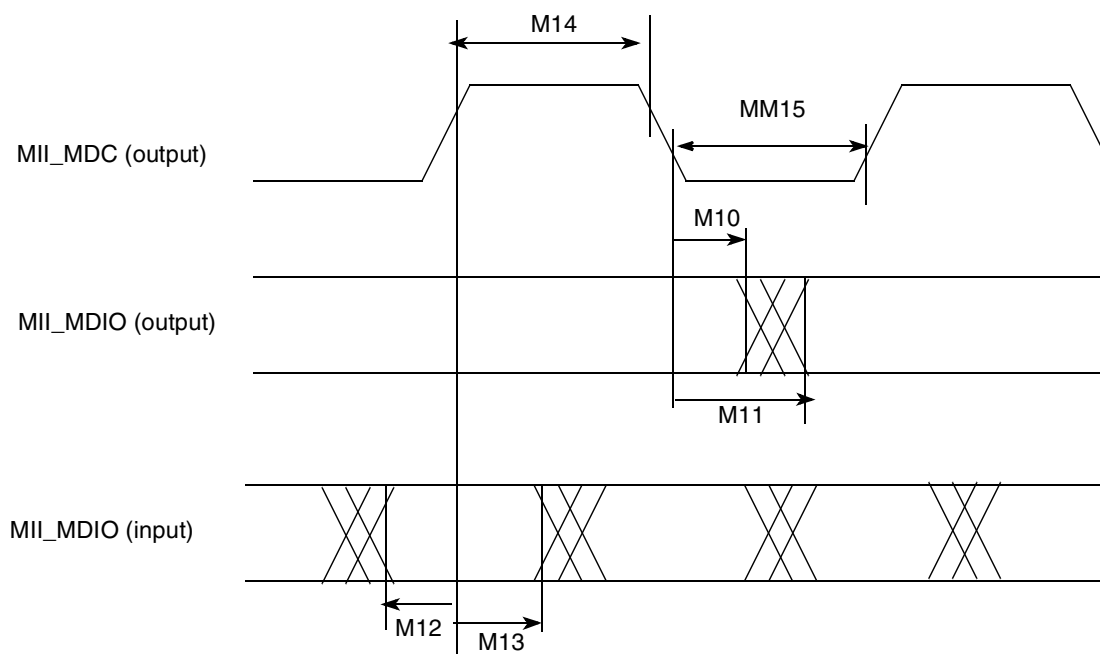
### 13.4 MII Serial Management Channel Timing (MII\_MDIO, MII\_MDC)

Table 32 provides information on the MII serial management channel signal timing. The FEC functions correctly with a maximum MDC frequency in excess of 2.5 MHz. The exact upper bound is under investigation.

**Table 32. MII Serial Management Channel Timing**

| Num | Characteristic                                                              | Min | Max | Unit           |
|-----|-----------------------------------------------------------------------------|-----|-----|----------------|
| M10 | MII_MDC falling edge to MII_MDIO output invalid (minimum propagation delay) | 0   | —   | ns             |
| M11 | MII_MDC falling edge to MII_MDIO output valid (max prop delay)              | —   | 25  | ns             |
| M12 | MII_MDIO (input) to MII_MDC rising edge setup                               | 10  | —   | ns             |
| M13 | MII_MDIO (input) to MII_MDC rising edge hold                                | 0   | —   | ns             |
| M14 | MII_MDC pulse width high                                                    | 40% | 60% | MII_MDC period |
| M15 | MII_MDC pulse width low                                                     | 40% | 60% | MII_MDC period |

Figure 76 shows the MII serial management channel timing diagram.

**Figure 76. MII Serial Management Channel Timing Diagram**

## 14 Mechanical Data and Ordering Information

Table 33 provides information on the MPC862/857T/857DSL derivative devices.

**Table 33. MPC862/857T/857DSL Derivatives**

| Device  | Number of SCCs <sup>1</sup> | Ethernet Support | Multi-Channel HDLC Support | ATM Support | Cache Size  |          |
|---------|-----------------------------|------------------|----------------------------|-------------|-------------|----------|
|         |                             |                  |                            |             | Instruction | Data     |
| MPC862T | Four                        | 10/100 Mbps      | Yes                        | Yes         | 4 Kbytes    | 4 Kbytes |
| MPC862P | Four                        | 10/100 Mbps      | Yes                        | Yes         | 16 Kbytes   | 8 Kbytes |



**Table 33. MPC862/857T/857DSL Derivatives (continued)**

| Device    | Number of SCCs <sup>1</sup> | Ethernet Support | Multi-Channel HDLC Support | ATM Support       | Cache Size  |          |
|-----------|-----------------------------|------------------|----------------------------|-------------------|-------------|----------|
|           |                             |                  |                            |                   | Instruction | Data     |
| MPC857T   | One (SCC1)                  | 10/100 Mbps      | Yes                        | Yes               | 4 Kbytes    | 4 Kbytes |
| MPC857DSL | One (SCC1)                  | 10/100 Mbps      | No                         | Up to 4 addresses | 4 Kbytes    | 4 Kbytes |

<sup>1</sup> Serial communications controller (SCC)

Table 34 identifies the packages and operating frequencies orderable for the MPC862/857T/857DSL derivative devices.

**Table 34. MPC862/857T/857DSL Package/Frequency Orderable**

| Package Type                         | Temperature (Tj) | Frequency (MHz) | Order Number                                                   |
|--------------------------------------|------------------|-----------------|----------------------------------------------------------------|
| Plastic ball grid array (ZP suffix)  | 0°C to 105°C     | 50              | XPC862PZP50B<br>XPC862TZP50B<br>XPC857TZP50B<br>XPC857DSLZP50B |
|                                      |                  | 66              | XPC862PZP66B<br>XPC862TZP66B<br>XPC857TZP66B<br>XPC857DSLZP66B |
|                                      |                  | 80              | XPC862PZP80B<br>XPC862TZP80B<br>XPC857TZP80B                   |
|                                      |                  | 100             | XPC862PZP100B<br>XPC862TZP100B<br>XPC857TZP100B                |
| Plastic ball grid array (CZP suffix) | -40°C to 115°C   | 66 <sup>1</sup> | XPC862PCZP66B<br>XPC857TCZP66B                                 |

<sup>1</sup> Additional extended temperature devices can be made available at 50MHz, 66MHz, and 80MHz

## 14.1 Pin Assignments

Figure 77 shows the top view pinout of the PBGA package. For additional information, see the *MPC862 PowerQUICC Family User's Manual*.

**NOTE: This is the top view of the device.**

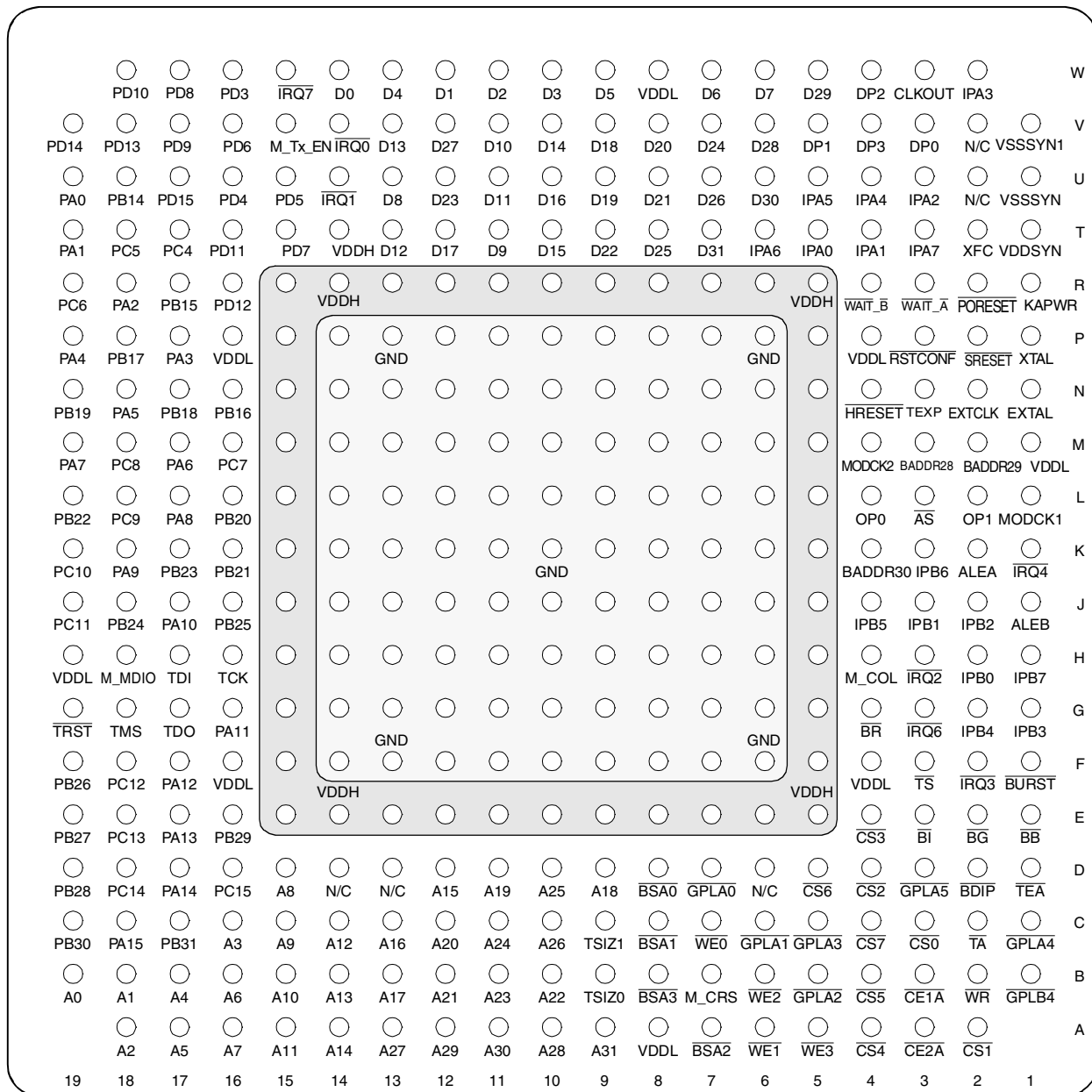


Table 35 contains a list of the MPC862 input and output signals and shows multiplexing and pin assignments.

**Table 35. Pin Assignments**

| Name                                                                                       | Pin Number                                                                                                                                                   | Type                            |
|--------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|
| A[0:31]                                                                                    | B19, B18, A18, C16, B17, A17, B16, A16, D15, C15, B15, A15, C14, B14, A14, D12, C13, B13, D9, D11, C12, B12, B10, B11, C11, D10, C10, A13, A10, A12, A11, A9 | Bidirectional<br>Three-state    |
| TSIZ0<br>REG                                                                               | B9                                                                                                                                                           | Bidirectional<br>Three-state    |
| TSIZ1                                                                                      | C9                                                                                                                                                           | Bidirectional<br>Three-state    |
| RD/ $\overline{\text{WR}}$                                                                 | B2                                                                                                                                                           | Bidirectional<br>Three-state    |
| $\overline{\text{BURST}}$                                                                  | F1                                                                                                                                                           | Bidirectional<br>Three-state    |
| $\overline{\text{BDIP}}$<br>$\overline{\text{GPL\_B5}}$                                    | D2                                                                                                                                                           | Output                          |
| $\overline{\text{TS}}$                                                                     | F3                                                                                                                                                           | Bidirectional<br>Active Pull-up |
| $\overline{\text{TA}}$                                                                     | C2                                                                                                                                                           | Bidirectional<br>Active Pull-up |
| $\overline{\text{TEA}}$                                                                    | D1                                                                                                                                                           | Open-drain                      |
| $\overline{\text{BI}}$                                                                     | E3                                                                                                                                                           | Bidirectional<br>Active Pull-up |
| $\overline{\text{IRQ2}}$<br>RSV                                                            | H3                                                                                                                                                           | Bidirectional<br>Three-state    |
| $\overline{\text{IRQ4}}$<br>$\overline{\text{KR}}$<br>$\overline{\text{RETRY}}$<br>SPKROUT | K1                                                                                                                                                           | Bidirectional<br>Three-state    |
| $\overline{\text{CR}}$<br>$\overline{\text{IRQ3}}$                                         | F2                                                                                                                                                           | Input                           |
| D[0:31]                                                                                    | W14, W12, W11, W10, W13, W9, W7, W6, U13, T11, V11, U11, T13, V13, V10, T10, U10, T12, V9, U9, V8, U8, T9, U12, V7, T8, U7, V12, V6, W5, U6, T7              | Bidirectional<br>Three-state    |
| DP0<br>$\overline{\text{IRQ3}}$                                                            | V3                                                                                                                                                           | Bidirectional<br>Three-state    |
| DP1<br>$\overline{\text{IRQ4}}$                                                            | V5                                                                                                                                                           | Bidirectional<br>Three-state    |
| DP2<br>$\overline{\text{IRQ5}}$                                                            | W4                                                                                                                                                           | Bidirectional<br>Three-state    |
| DP3<br>$\overline{\text{IRQ6}}$                                                            | V4                                                                                                                                                           | Bidirectional<br>Three-state    |

Table 35. Pin Assignments (continued)

| Name                                                                                              | Pin Number             | Type                            |
|---------------------------------------------------------------------------------------------------|------------------------|---------------------------------|
| $\overline{\text{BR}}$                                                                            | G4                     | Bidirectional                   |
| $\overline{\text{BG}}$                                                                            | E2                     | Bidirectional                   |
| $\overline{\text{BB}}$                                                                            | E1                     | Bidirectional<br>Active Pull-up |
| $\overline{\text{FRZ}}$<br>$\overline{\text{IRQ6}}$                                               | G3                     | Bidirectional                   |
| $\overline{\text{IRQ0}}$                                                                          | V14                    | Input                           |
| $\overline{\text{IRQ1}}$                                                                          | U14                    | Input                           |
| $\text{M\_TX\_CLK}$<br>$\overline{\text{IRQ7}}$                                                   | W15                    | Input                           |
| $\overline{\text{CS}}[0:5]$                                                                       | C3, A2, D4, E4, A4, B4 | Output                          |
| $\overline{\text{CS6}}$<br>$\overline{\text{CE1\_B}}$                                             | D5                     | Output                          |
| $\overline{\text{CS7}}$<br>$\overline{\text{CE2\_B}}$                                             | C4                     | Output                          |
| $\overline{\text{WE0}}$<br>$\overline{\text{BS\_B0}}$<br>$\overline{\text{IORD}}$                 | C7                     | Output                          |
| $\overline{\text{WE1}}$<br>$\overline{\text{BS\_B1}}$<br>$\overline{\text{IOWR}}$                 | A6                     | Output                          |
| $\overline{\text{WE2}}$<br>$\overline{\text{BS\_B2}}$<br>$\overline{\text{PCOE}}$                 | B6                     | Output                          |
| $\overline{\text{WE3}}$<br>$\overline{\text{BS\_B3}}$<br>$\overline{\text{PCWE}}$                 | A5                     | Output                          |
| $\overline{\text{BS\_A}}[0:3]$                                                                    | D8, C8, A7, B8         | Output                          |
| $\overline{\text{GPL\_A0}}$<br>$\overline{\text{GPL\_B0}}$                                        | D7                     | Output                          |
| $\overline{\text{OE}}$<br>$\overline{\text{GPL\_A1}}$<br>$\overline{\text{GPL\_B1}}$              | C6                     | Output                          |
| $\overline{\text{GPL\_A}}[2:3]$<br>$\overline{\text{GPL\_B}}[2:3]$<br>$\overline{\text{CS}}[2-3]$ | B5, C5                 | Output                          |
| $\overline{\text{UPWAITA}}$<br>$\overline{\text{GPL\_A4}}$                                        | C1                     | Bidirectional                   |
| $\overline{\text{UPWAITB}}$<br>$\overline{\text{GPL\_B4}}$                                        | B1                     | Bidirectional                   |

Table 35. Pin Assignments (continued)

| Name                                                                           | Pin Number | Type                      |
|--------------------------------------------------------------------------------|------------|---------------------------|
| $\overline{\text{GPL\_A5}}$                                                    | D3         | Output                    |
| $\overline{\text{PORESET}}$                                                    | R2         | Input                     |
| $\overline{\text{RSTCONF}}$                                                    | P3         | Input                     |
| $\overline{\text{HRESET}}$                                                     | N4         | Open-drain                |
| $\overline{\text{SRESET}}$                                                     | P2         | Open-drain                |
| XTAL                                                                           | P1         | Analog Output             |
| EXTAL                                                                          | N1         | Analog Input (3.3 V only) |
| XFC                                                                            | T2         | Analog Input              |
| CLKOUT                                                                         | W3         | Output                    |
| EXTCLK                                                                         | N2         | Input (3.3 V only)        |
| TEXP                                                                           | N3         | Output                    |
| ALE_A<br>MII-TXD1                                                              | K2         | Output                    |
| $\overline{\text{CE1\_A}}$<br>MII-TXD2                                         | B3         | Output                    |
| $\overline{\text{CE2\_A}}$<br>MII-TXD3                                         | A3         | Output                    |
| $\overline{\text{WAIT\_A}}$<br>SOC_Split <sup>2</sup>                          | R3         | Input                     |
| $\overline{\text{WAIT\_B}}$                                                    | R4         | Input                     |
| IP_A0<br>UTPB_Split0 <sup>2</sup><br>MII-RXD3                                  | T5         | Input                     |
| IP_A1<br>UTPB_Split1 <sup>2</sup><br>MII-RXD2                                  | T4         | Input                     |
| IP_A2<br>$\overline{\text{IOIS16\_A}}$<br>UTPB_Split2 <sup>2</sup><br>MII-RXD1 | U3         | Input                     |
| IP_A3<br>UTPB_Split3 <sup>2</sup><br>MII-RXD0                                  | W2         | Input                     |
| IP_A4<br>UTPB_Split4 <sup>2</sup><br>MII-RXCLK                                 | U4         | Input                     |
| IP_A5<br>UTPB_Split5 <sup>2</sup><br>MII-RXERR                                 | U5         | Input                     |

Table 35. Pin Assignments (continued)

| Name                                           | Pin Number | Type                         |
|------------------------------------------------|------------|------------------------------|
| IP_A6<br>UTPB_Split6 <sup>2</sup><br>MII-TXERR | T6         | Input                        |
| IP_A7<br>UTPB_Split7 <sup>2</sup><br>MII-RXDV  | T3         | Input                        |
| ALE_B<br>DSCK/AT1                              | J1         | Bidirectional<br>Three-state |
| IP_B[0:1]<br>IWP[0:1]<br>VFLS[0:1]             | H2, J3     | Bidirectional                |
| IP_B2<br>$\overline{\text{IOIS16\_B}}$<br>AT2  | J2         | Bidirectional<br>Three-state |
| IP_B3<br>IWP2<br>VF2                           | G1         | Bidirectional                |
| IP_B4<br>LWP0<br>VF0                           | G2         | Bidirectional                |
| IP_B5<br>LWP1<br>VF1                           | J4         | Bidirectional                |
| IP_B6<br>DSDI<br>AT0                           | K3         | Bidirectional<br>Three-state |
| IP_B7<br>$\overline{\text{PTR}}$<br>AT3        | H1         | Bidirectional<br>Three-state |
| OP0<br>MII-TXD0<br>UtpClk_Split <sup>2</sup>   | L4         | Bidirectional                |
| OP1                                            | L2         | Output                       |
| OP2<br>MODCK1<br>$\overline{\text{STS}}$       | L1         | Bidirectional                |
| OP3<br>MODCK2<br>DSDO                          | M4         | Bidirectional                |
| BADDR30<br>$\overline{\text{REG}}$             | K4         | Output                       |
| BADDR[28:29]                                   | M3, M2     | Output                       |
| $\overline{\text{AS}}$                         | L3         | Input                        |

Table 35. Pin Assignments (continued)

| Name                                    | Pin Number | Type                                    |
|-----------------------------------------|------------|-----------------------------------------|
| PA15<br>RXD1<br>RXD4                    | C18        | Bidirectional                           |
| PA14<br>TXD1<br>TXD4                    | D17        | Bidirectional<br>(Optional: Open-drain) |
| PA13<br>RXD2                            | E17        | Bidirectional                           |
| PA12<br>TXD2                            | F17        | Bidirectional<br>(Optional: Open-drain) |
| PA11<br>L1TXDB<br>RXD3                  | G16        | Bidirectional<br>(Optional: Open-drain) |
| PA10<br>L1RXDB<br>TXD3                  | J17        | Bidirectional<br>(Optional: Open-drain) |
| PA9<br>L1TXDA<br><br>RXD4               | K18        | Bidirectional<br>(Optional: Open-drain) |
| PA8<br>L1RXDA<br>TXD4                   | L17        | Bidirectional<br>(Optional: Open-drain) |
| PA7<br>CLK1<br>L1RCLKA<br>BRGO1<br>TIN1 | M19        | Bidirectional                           |
| PA6<br>CLK2<br><u>TOUT1</u>             | M17        | Bidirectional                           |
| PA5<br>CLK3<br>L1TCLKA<br>BRGO2<br>TIN2 | N18        | Bidirectional                           |
| PA4<br>CLK4<br><u>TOUT2</u>             | P19        | Bidirectional                           |
| PA3<br>CLK5<br>BRGO3<br>TIN3            | P17        | Bidirectional                           |

Table 35. Pin Assignments (continued)

| Name                                                           | Pin Number | Type                                    |
|----------------------------------------------------------------|------------|-----------------------------------------|
| PA2<br>CLK6<br><u>TOUT3</u><br>L1RCLKB                         | R18        | Bidirectional                           |
| PA1<br>CLK7<br>BRGO4<br>TIN4                                   | T19        | Bidirectional                           |
| PA0<br>CLK8<br><u>TOUT4</u><br>L1TCLKB                         | U19        | Bidirectional                           |
| PB31<br><u>SPISEL</u><br><u>REJECT1</u>                        | C17        | Bidirectional<br>(Optional: Open-drain) |
| PB30<br>SPICLK<br>RSTR2                                        | C19        | Bidirectional<br>(Optional: Open-drain) |
| PB29<br>SPIMOSI                                                | E16        | Bidirectional<br>(Optional: Open-drain) |
| PB28<br>SPIMISO<br>BRGO4                                       | D19        | Bidirectional<br>(Optional: Open-drain) |
| PB27<br>I2CSDA<br>BRGO1                                        | E19        | Bidirectional<br>(Optional: Open-drain) |
| PB26<br>I2CSCL<br>BRGO2                                        | F19        | Bidirectional<br>(Optional: Open-drain) |
| PB25<br>RXADDR3 <sup>2</sup><br>SMTXD1                         | J16        | Bidirectional<br>(Optional: Open-drain) |
| PB24<br>TXADDR3 <sup>2</sup><br>SMRXD1                         | J18        | Bidirectional<br>(Optional: Open-drain) |
| PB23<br>TXADDR2 <sup>2</sup><br><u>SDACK1</u><br><u>SMSYN1</u> | K17        | Bidirectional<br>(Optional: Open-drain) |
| PB22<br>TXADDR4 <sup>2</sup><br><u>SDACK2</u><br><u>SMSYN2</u> | L19        | Bidirectional<br>(Optional: Open-drain) |



Table 35. Pin Assignments (continued)

| Name                                                                                        | Pin Number | Type                                    |
|---------------------------------------------------------------------------------------------|------------|-----------------------------------------|
| PB21<br>SMTXD2<br>L1CLKOB<br>PHSEL1 <sup>1</sup><br>TXADDR1 <sup>2</sup>                    | K16        | Bidirectional<br>(Optional: Open-drain) |
| PB20<br>SMRXD2<br>L1CLKOA<br>PHSEL0 <sup>1</sup><br>TXADDR0 <sup>2</sup>                    | L16        | Bidirectional<br>(Optional: Open-drain) |
| PB19<br><u>RTS1</u><br>L1ST1                                                                | N19        | Bidirectional<br>(Optional: Open-drain) |
| PB18<br>RXADDR4 <sup>2</sup><br><u>RTS2</u><br>L1ST2                                        | N17        | Bidirectional<br>(Optional: Open-drain) |
| PB17<br><u>L1RQb</u><br>L1ST3<br><u>RTS3</u><br>PHREQ1 <sup>1</sup><br>RXADDR1 <sup>2</sup> | P18        | Bidirectional<br>(Optional: Open-drain) |
| PB16<br><u>L1RQa</u><br>L1ST4<br><u>RTS4</u><br>PHREQ0 <sup>1</sup><br>RXADDR0 <sup>2</sup> | N16        | Bidirectional<br>(Optional: Open-drain) |
| PB15<br>BRGO3<br>TxClav                                                                     | R17        | Bidirectional                           |
| PB14<br>RXADDR2 <sup>2</sup><br><u>RSTR1</u>                                                | U18        | Bidirectional                           |
| PC15<br><u>DREQ0</u><br><u>RTS1</u><br>L1ST1<br>RxClav                                      | D16        | Bidirectional                           |
| PC14<br><u>DREQ1</u><br><u>RTS2</u><br>L1ST2                                                | D18        | Bidirectional                           |

Table 35. Pin Assignments (continued)

| Name                                            | Pin Number | Type          |
|-------------------------------------------------|------------|---------------|
| PC13<br><u>L1RQb</u><br>L1ST3<br>RTS3           | E18        | Bidirectional |
| PC12<br><u>L1RQa</u><br>L1ST4<br>RTS4           | F18        | Bidirectional |
| PC11<br><u>CTS1</u>                             | J19        | Bidirectional |
| PC10<br><u>CD1</u><br><u>TGATE1</u>             | K19        | Bidirectional |
| PC9<br><u>CTS2</u>                              | L18        | Bidirectional |
| PC8<br><u>CD2</u><br><u>TGATE2</u>              | M18        | Bidirectional |
| PC7<br><u>CTS3</u><br>L1TSYNCB<br><u>SDACK2</u> | M16        | Bidirectional |
| PC6<br><u>CD3</u><br>L1RSYNCB                   | R19        | Bidirectional |
| PC5<br><u>CTS4</u><br>L1TSYNCA<br>SDACK1        | T18        | Bidirectional |
| PC4<br><u>CD4</u><br>L1RSYNCA                   | T17        | Bidirectional |
| PD15<br>L1TSYNCA<br>MII-RXD3<br>UTPB0           | U17        | Bidirectional |
| PD14<br>L1RSYNCA<br>MII-RXD2<br>UTPB1           | V19        | Bidirectional |
| PD13<br>L1TSYNCB<br>MII-RXD1<br>UTPB2           | V18        | Bidirectional |

Table 35. Pin Assignments (continued)

| Name                                 | Pin Number | Type          |
|--------------------------------------|------------|---------------|
| PD12<br>L1RSYNCB<br>MII-MDC<br>UTPB3 | R16        | Bidirectional |
| PD11<br>RXD3<br>MII-TXERR<br>RXENB   | T16        | Bidirectional |
| PD10<br>TXD3<br>MII-RXD0<br>TXENB    | W18        | Bidirectional |
| PD9<br>RXD4<br>MII-TXD0<br>UTPCLK    | V17        | Bidirectional |
| PD8<br>TXD4<br>MII-MDC<br>MII-RXCLK  | W17        | Bidirectional |
| PD7<br>RTS3<br>MII-RXERR<br>UTPB4    | T15        | Bidirectional |
| PD6<br>RTS4<br>MII-RXDV<br>UTPB5     | V16        | Bidirectional |
| PD5<br>REJECT2<br>MII-TXD3<br>UTPB6  | U15        | Bidirectional |
| PD4<br>REJECT3<br>MII-TXD2<br>UTPB7  | U16        | Bidirectional |
| PD3<br>REJECT4<br>MII-TXD1<br>SOC    | W16        | Bidirectional |
| TMS                                  | G18        | Input         |
| TDI<br>DSDI                          | H17        | Input         |
| TCK<br>DSCK                          | H16        | Input         |

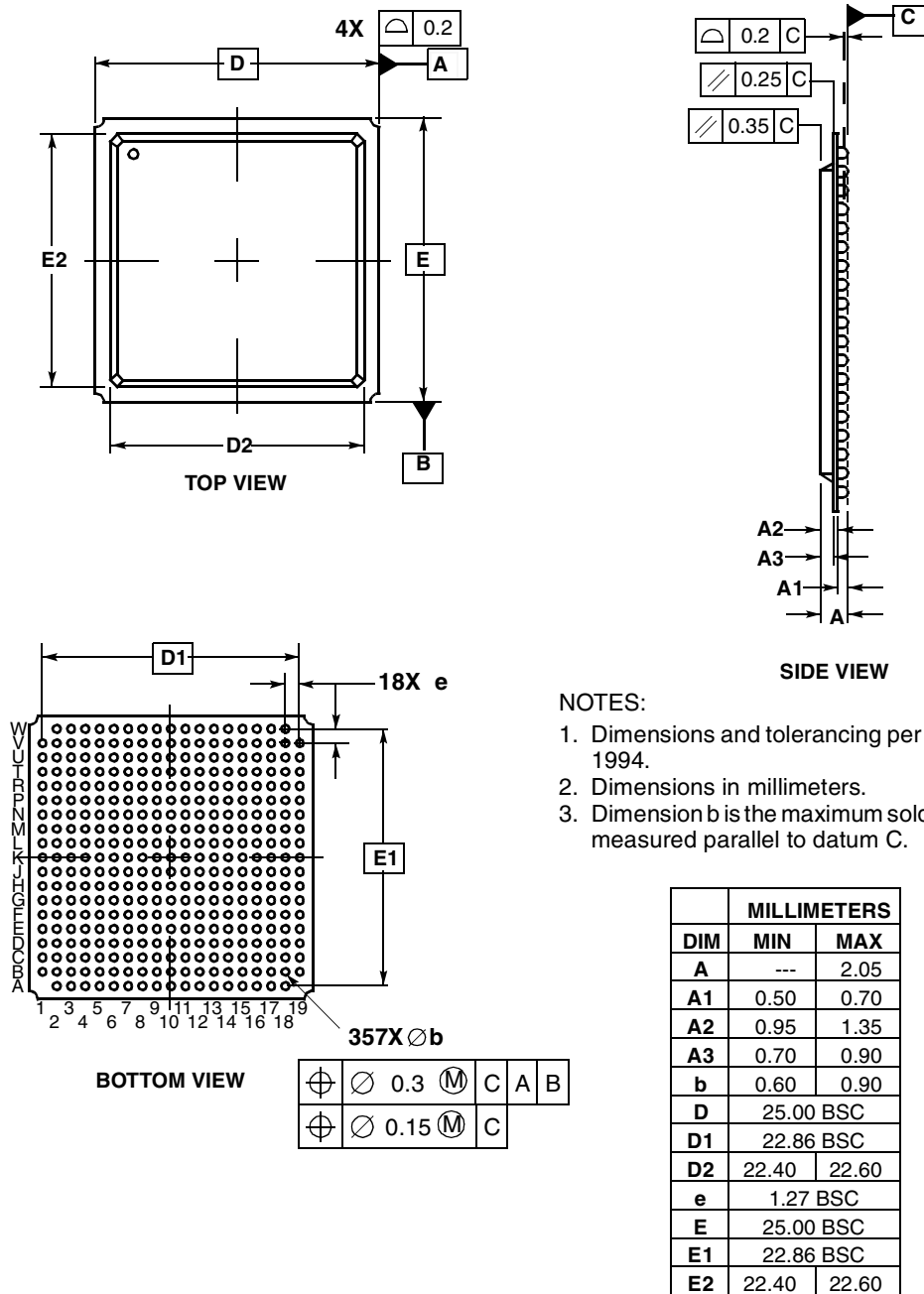
Table 35. Pin Assignments (continued)

| Name        | Pin Number                                                                                                                                                                                                                                                                                                                                                                      | Type          |
|-------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|
| TRST        | G19                                                                                                                                                                                                                                                                                                                                                                             | Input         |
| TDO<br>DSDO | G17                                                                                                                                                                                                                                                                                                                                                                             | Output        |
| M_CRS       | B7                                                                                                                                                                                                                                                                                                                                                                              | Input         |
| M_MDIO      | H18                                                                                                                                                                                                                                                                                                                                                                             | Bidirectional |
| M_TXEN      | V15                                                                                                                                                                                                                                                                                                                                                                             | Output        |
| M_COL       | H4                                                                                                                                                                                                                                                                                                                                                                              | Input         |
| KAPWR       | R1                                                                                                                                                                                                                                                                                                                                                                              | Power         |
| GND         | F6, F7, F8, F9, F10, F11, F12, F13, F14, G6, G7, G8, G9, G10, G11, G12, G13, G14, H6, H7, H8, H9, H10, H11, H12, H13, H14, J6, J7, J8, J9, J10, J11, J12, J13, J14, K6, K7, K8, K9, K10, K11, K12, K13, K14, L6, L7, L8, L9, L10, L11, L12, L13, L14, M6, M7, M8, M9, M10, M11, M12, M13, M14, N6, N7, N8, N9, N10, N11, N12, N13, N14, P6, P7, P8, P9, P10, P11, P12, P13, P14 | Power         |
| VDDL        | A8, M1, W8, H19, F4, F16, P4, P16                                                                                                                                                                                                                                                                                                                                               | Power         |
| VDDH        | E5, E6, E7, E8, E9, E10, E11, E12, E13, E14, E15, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P5, P15, R5, R6, R7, R8, R9, R10, R11, R12, R13, R14, R15, T14                                                                                                                                                                                        | Power         |
| N/C         | D6, D13, D14, U2, V2                                                                                                                                                                                                                                                                                                                                                            | No-connect    |

<sup>1</sup> Classic SAR mode only<sup>2</sup> ESAR mode only

## 14.2 Mechanical Dimensions of the PBGA Package

For more information on the printed circuit board layout of the PBGA package, including thermal via design and suggested pad layout, please refer to *Plastic Ball Grid Array Application Note* (order number: AN1231/D) available from your local Freescale sales office. [Figure 78](#) shows the mechanical dimensions of the PBGA package.



Case No. 1103-01

**Figure 78. Mechanical Dimensions and Bottom Surface Nomenclature of the PBGA Package**

## 15 Document Revision History

Table 36 lists significant changes between revisions of this document.

**Table 36. Document Revision History**

| Rev. No. | Date    | Substantive Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|----------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0        | 2001    | Initial revision                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| 0.1      | 9/2001  | Change extended temperature from 95 to 105                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 0.2      | 11/2001 | Revised for new template, changed Table 7 B23 max value @ 66 MHz from 2 ns to 8 ns.                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 0.3      | 4/2002  | <ul style="list-style-type: none"> <li>Timing modified and equations added, for Rev. A and B devices.</li> <li>Modified power numbers and temperature ranges. Added ESAR UTOPIA timing.</li> </ul>                                                                                                                                                                                                                                                                                                                   |
| 1.0      | 9/2002  | <ul style="list-style-type: none"> <li>Specification changed to include the MPC857T and MPC857DSL.</li> <li>Changed maximum operating frequency from 80 MHz to 100 MHz.</li> <li>Removed MPC862DP, DT, and SR derivatives and part numbers.</li> <li>Corrected power dissipation numbers.</li> <li>Changed UTOPIA maximum frequency from 50 MHz to 33 MHz.</li> <li>Changed part number ordering information to Rev. B devices only.</li> <li>To maximum ratings for temperature, added frequency ranges.</li> </ul> |
| 1.1      | 5/2003  | Changed SPI Master Timing Specs. 162 and 164                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 1.2      | 8/2003  | <ul style="list-style-type: none"> <li>Changed B28a through B28d and B29b to show that TRLX can be 0 or 1.</li> <li>Non-technical reformatting</li> </ul>                                                                                                                                                                                                                                                                                                                                                            |
| 2.0      | 11/2004 | <ul style="list-style-type: none"> <li>Added a table footnote to Table 5 DC Electrical Specifications about meeting the VIL Max of the I2C Standard.</li> <li>Updated document template.</li> </ul>                                                                                                                                                                                                                                                                                                                  |
| 3.0      | 2/2006  | <ul style="list-style-type: none"> <li>Changed Tj from 95C to 105C in table 34</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                            |

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